

# **Second Generation Intel® Xeon® Scalable Processors**

**Datasheet, Volume One: Electrical** 

**April 2019** 

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## **Revision History**

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338845	001	Initial Release	April 2019





## 1 Introduction

The Datasheet Volume 1 provides configuration space registers (CSRs).

This document is distributed as a part of the complete datasheets consisting of two volumes.

#### Note:

Unless specified otherwise, "processor" will represent the following processors throughout the rest of the document.

- Intel® Xeon® Bronze 3XXX processor
- Intel® Xeon® Gold 6XXF processor
- Intel® Xeon® Platinum 6XXF processor
- Intel® Xeon® Platinum 8XXF processor
- Intel® Xeon® Silver 4XXX processor
- Intel® Xeon® Gold 5XXX processor
- Intel® Xeon® Platinum 6XXX processor
- Intel® Xeon® Platinum 8XXX processor

The Second Generation Intel® Xeon® Scalable Processors is the next generation of 64-bit, multi-core server processor built on 14-nm process technology. The processor supports up to 46 bits of physical address space and 48 bits of virtual address space. The processor is designed for a platform consisting of at least one Second Generation Intel® Xeon® Scalable Processors and the Platform Controller Hub (PCH). Included in this family of processors are integrated memory controller (IMC) and an Integrated I/O (IIO) on a single silicon die.

#### Note:

Features within this document may not be available on all platform segments, processor types, and processor SKUs.

For supported processor configurations refer to:

 Second Generation Intel® Xeon® Scalable Processors Datasheet: Volume 2 -Registers, 338846

## 1.1 Electrical Specification Introduction

This is volume provides DC electrical specifications, signal integrity, differential signaling specifications, and land and signal definitions of the processor.

This document may be used by system test engineers, board designers, and BIOS developers.



## 1.2 Related Publications

See the following documents for additional information.

#### **Table 1-1. Related Publications**

Document	Document Number / Location
Second Generation Intel® Xeon® Scalable Processors Datasheet: Volume 2 - Registers	338846
Second Generation Intel® Xeon® Scalable Processors Specification Update	338848
Second Generation Intel® Xeon® Scalable Processors Thermal Mechanical Design Guidelines	338847
Intel® C620 Series Chipset Datasheet	336067
Intel® C620 Series Chipset Thermal Mechanical Design Guidelines	336068
Intel®64and IA-32Architectures Software Developer's Manuals Volume 1: Basic Architecture Volume 2A: Instruction Set Reference, A-M Volume 2B: Instruction Set Reference, N-Z Volume 3A: System Programming Guide Volume 3B: System Programming Guide Intel® 64 and IA-32Architectures Optimization Reference Manual	325462 http://www.intel.com/ products/processor/ manuals/index.htm
Intel® Virtualization Technology Specification for Directed I/O Architecture Specification	http://www.intel.com/ content/www/us/en/ intelligent-systems/intel- technology/vt-directed- io-spec.html
Intel®Trusted Execution Technology Software Development Guide	http://www.intel.com/ technology/security/

## 1.3 Terminology

Term	Description	
ASPM	Active State Power Management	
ВМС	Baseboard Management Controller	
CA	Coherency Agent. In some cases this is referred to as a Caching Agent though a CA is not actually required to have a cache. It is a term used for the internal logic providing mesh interface to LLC and Core.	
СНА	The functional module that includes the CA (Coherency Agent) and HA (Home Agent).	
DDR4	Fourth generation Double Data Rate SDRAM memory technology.	
DDR-T	DDR-T (transactional) protocol which enables Apache Pass.Communication to far memory protocol running on the DDR4physical layer.	
DMA	Direct Memory Access	
DMI3	Direct Media Interface Gen3 operating at PCI Express 3.0 speed.	
DTLB	Data Translation Look-aside Buffer; part of the processor core architecture.	



Term	Description
DTS	Digital Thermal Sensor
ECC	Error Correction Code
Enhanced Intel SpeedStep®Technology	Allows the operating system to reduce power consumption when performance is not needed.
Execute Disable Bit	The Execute Disable bit allows memory to be marked as executable or non-executable, when combined with a supporting operating system. If code attempts to run in non-executable memory the processor raises an error to the operating system. This feature can prevent some classes of viruses or worms that exploit buffer overrun vulnerabilities and can thus help improve the overall security of the system. See the Intel®64and IA-32ArchitecturesSoftware Developer's Manuals for more detailed information.
FLIT	Flow Control Unit. The Intel® Ultra Path Interconnect (Intel® UPI) Link layer's unit of transfer. A FLIT is made of multiple PHITS. A Flit is always a fixed amount of information (192 bits).
Functional Operation	Refers to the normal operating conditions in which all processor specifications, including DC, system bus, signal quality, mechanical, and thermal, are satisfied.
GSSE	Extension of the SSE/SSE2 (Streaming SIMD Extensions) floating point instruction set to 256b operands.
НА	A Home Agent (HA) orders read and write requests to a piece of coherent memory. The HA is implemented in the CHA logic.
ICU	Instruction Cache Unit. Part of the processor core architecture.
IFU	Instruction Fetch Unit. Part of the processor core.
IIO	Integrated I/O Controller. An I/O controller that is integrated in the processor die. The IIO consists of the DMI3 module, PCIe modules, and MCP modules (Intel Xeon processor-F SKUs only).
IMC	Integrated Memory Controller. A Memory Controller that is integrated in the processor die.
IQ	Instruction Queue. Part of the core architecture.
Intel® ME	Intel® Management Engine
Intel® QuickData Technology	Intel® QuickData Technology is a platform solution designed to maximize the throughput of server data traffic across a broader range of configurations and server environments to achieve faster, scalable, and more reliable I/O.
Intel® Ultra Path Interconnect (Intel® UPI)	A cache-coherent, link-based Interconnect specification for Intel processors. Also known as Intel® UPI.
Intel® 64Technology	64-bit memory extensions to the IA-32 architecture. Further details on Intel 64 architecture and programming model can be found at http://developer.intel.com/technology/intel64/.
Intel® Turbo Boost Technology	A feature that opportunistically enables the processor to run a faster frequency. This results in increased performance of both single and multi-threaded applications.
Intel® TXT	Intel® Trusted Execution Technology
Intel® Virtualization Technology (Intel® VT)	Processor Virtualization which when used in conjunction with Virtual Machine Monitor software enables multiple, robust independent software environments inside a single platform.
Intel® VT-d	Intel® Virtualization Technology (Intel® VT) for Directed I/O. Intel VT-d is a hardware assist, under system software (Virtual Machine Manager or OS) control, for enabling I/O device Virtualization. Intel VT-d also brings robust security by providing protection from errant DMAs by using DMA remapping, a key feature of Intel VT-d.



Term	Description	
Integrated Heat Spreader (IHS)	A component of the processor package used to enhance the thermal performance of the package. Component thermal solutions interface with the processor at the IHS surface.	
IOV	I/O Virtualization	
IVR	Integrated Voltage Regulation (IVR): The processor supports several integrated voltage regulators.	
Intel UPI	Intel® Ultra Path Interconnect (Intel® UPI) Agent. An internal logic block providing interface between internal mesh and external Intel® UPI.	
LLC	Last Level Cache	
LRDIMM	Load Reduced Dual In-line Memory Module	
LRU	Least Recently Used. A term used in conjunction with cache allocation policy.	
M2M	Mesh to Memory. Logic in the IMC which interfaces the IMC to the mesh.	
M2PCIe	The logic in the IIO modules which interface the modules to the mesh.	
MESH	The on die interconnect which connects modules in the processor.	
MESI	Modified/Exclusive/Shared/Invalid. States used in conjunction with cache coherency	
MLC	Mid Level Cache	
NCTF	Non-Critical to Function: NCTF locations are typically redundant ground or non-critical reserved, so the loss of the solder joint continuity at end of life conditions will not affect the overall product functionality.	
NID \ NodeID	Node ID (NID) or NodeID (NID). The processor implements up to 4-bits of NodeID (NID).	
Pcode	Pcode is microcode which is run on the dedicated microcontroller within the PCU.	
PCH	Platform Controller Hub. The next generation chipset with centralized platform capabilities including the main I/O interfaces along with display connectivity, audio features, power management, manageability, security and storage features.	
PCU	Power Control Unit.	
PCI Express 3.0	The third generation PCI Express specification that operates at twice the speed of PCI Express 2.0 (8 Gb/s); PCI Express 3.0 is completely backward compatible with PCI Express 1.0 and 2.0.	
PCI Express 2.0	PCI Express* Generation 2.0	
PECI	Platform Environment Control Interface	
Phit	The data transfer unit on Intel® UPI at the Physical layer is called a phit (physical unit). A Phit will be either 20 bits, or 8 bits depending on the number of active lanes.	
Processor	Includes the 64-bit cores, uncore, I/Os and package	
Processor Core	The term "processor core" refers to Si die itself which can contain multiple execution cores. Each execution core has an instruction cache and data cache and MLC cache. All execution cores share the L3 cache.	
Rank	A unit of DRAM corresponding four to eight devices in parallel, ignoring ECC. These devices are usually, but not always, mounted on a single side of a DDR4 DIMM.	



Term	Description	
RDIMM \ LRDIMM	Registered Dual In-line Memory Module \ Load Reduced DIMM	
RTID	Request Transaction IDs are credits issued by the CHA to track outstanding transaction, and the RTIDs allocated to a CHA are topology dependent.	
SCI	System Control Interrupt. Used in ACPI protocol.	
SKU	Stock Keeping Unit (SKU) is a subset of a processor type with specific features, electrical, power and thermal specifications. Not all features are supported on all SKUs. A SKU is based on specific use condition assumption.	
SSE	Intel® Streaming SIMD Extensions (Intel®SSE)	
SMBus	System Management Bus. A two-wire interface through which simple system and power management related devices can communicate with the rest of the system.	
Storage Conditions	A non-operational state. The processor may be installed in a platform, in a tray, or loose. Processors may be sealed in packaging or exposed to free air. Under these conditions, processor landings should not be connected to any supply voltages, have any I/Os biased or receive any clocks. Upon exposure to "free air" (that is, unsealed packaging or a device removed from packaging material) the processor must be handled in accordance with moisture sensitivity labeling (MSL) as indicated on the packaging material.	
TAC	Thermal Averaging Constant	
TDP	Thermal Design Power	
TSOD	Temperature Sensor On DIMM	
UDIMM	Unbuffered Dual In-line Memory Module	
Uncore	The portion of the processor comprising the shared LLC cache, CHA, IMC, PCU, Ubox, IIO and Intel® UPI modules.	
Unit Interval	Signaling convention that is binary and unidirectional. In this binary signaling, one bit is sent for every edge of the forwarded clock, whether it be a rising edge or a falling edge. If a number of edges are collected at instances t1, t 2, t n,,txthen the UI at instance "n" is defined as: UI n=tn-t n-1	
Volume Management Device (VMD)	Volume Management Device (VMD) is a new technology used to improve PCIe management. VMD maps the PCIe configuration space for child devices/adapters for a particular PCIe x16 module into its own address space, controlled by a VMD driver.	
Vccin	Primary voltage input to the voltage regulators integrated into the processor.	
Vss	Processor ground	
Vssa	System agent supply for Intel UPI and PCIe	
Vccio	IO voltage supply input	
	DDD nower rail	
Vccd	DDR power rail	

## 1.4 Statement of Volatility (SOV)

Second Generation Intel® Xeon® Scalable Processors do not retain any end-user data when powered down and/or the processor is physically removed from the socket.







## **2** Electrical Specifications

This chapter describes processor signaling, DC and DC specifications, and signal quality. References to various interfaces (memory, PCIe\*, Intel® Ultra Path Interconnect [Intel® UPI], PECI, and so forth) are also described.

## 2.1 Integrated Voltage Regulation

The platform voltage regulator is integrated into the processor. Due to this integration, the processor has one main voltage rail (VCCIN) and a voltage rail for the memory interface (VCCD012, VCCD345 - one for each memory channel pair). The VCCIN voltage rail will supply the integrated voltage regulators which in turn will regulate to the appropriate voltages for the cores, cache, and system agents. This integration allows the processor to better control on-die voltages to optimize for both performance and power savings. The processor VCCIN rail will remain a VID -based voltage with a loadline similar to the core voltage rail (called Vcc) in previous processors. In addition to the above, the processor has voltage rails VCCIO for IO, VCCSA for the System Agent, and VCC33 for PIROM.

## 2.2 Processor Signaling

The Second Generation Intel® Xeon® Scalable Processors includes 3647 lands, which use various signaling technologies. Signals are grouped by electrical characteristics and buffer type into various signal groups. These include DDR4 (Reference Clock, Command, Control, and Data), PCI Express\*, DMI3, Intel® Ultra Path Interconnect (Intel® UPI), Platform Environmental Control Interface (PECI), System Reference Clock, SMBus, JTAG and Test Access Port (TAP), SVID Interface, Processor Asynchronous Sideband, Miscellaneous, and Power/ Other signals. See Table 2-7, "Signal Groups" for details.

Intel strongly recommends performing analog simulations of all interfaces. Please refer to Section 1.2 for signal integrity model availability.

## 2.2.1 System Memory Interface Signal Groups

The system memory interface utilizes DDR4 technology, which consists of numerous signal groups. These include: Reference Clocks, Command Signals, Control Signals, and Data Signals. Each group consists of numerous signals, which may utilize various signaling technologies. See Table 2-7, "Signal Groups" for further details.

Throughout this chapter the system memory interface may be referred to as DDR4.

## 2.2.2 PCI Express\* Signals

The PCI Express Signal Group consists of PCI Express\* ports 1, 2, and 3, and PCI Express miscellaneous signals. See Table 2-7, "Signal Groups" for further details.



### 2.2.3 DMI3/PCI Express Signals

The Direct Media Interface Gen 3(DMI3) sends and receives packets and/or commands to the PCH. The DMI3 is an extension of the standard PCI Express Specification. The DMI3/PCI Express Signals consist of DMI3 receive and transmit input/output signals and a control signal to select DMI3 or PCIe\* 3.0 operation for port 0. See Table 2-7, "Signal Groups" for further details.

### 2.2.4 Intel® Ultra Path Interconnect (Intel® UPI)

Second Generation Intel® Xeon® Scalable Processors two socket provides two Intel® Ultra Path Interconnect (Intel® UPI) ports for high-speed serial transfer between other processors, whereas the Second Generation Intel® Xeon® Scalable Processors four socket and above provides three Intel® UPI links. Each port consists of two unidirectional links (for transmit and receive). A differential signaling scheme is utilized, which consists of opposite-polarity (DP, DN) signal pairs. See Table 2-7, "Signal Groups" for further details.

#### 2.2.5 Platform Environmental Control Interface (PECI)

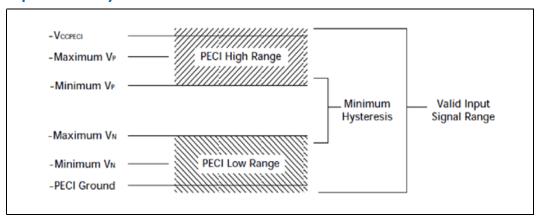
PECI is an Intel proprietary interface that provides a communication channel between Intel processors and chipset components to external system management logic and thermal monitoring devices. The processor contains a Digital Thermal Sensor (DTS) that reports a relative die temperature as an offset from Thermal Control Circuit (TCC) activation temperature. Temperature sensors located throughout the die are implemented as analog-to-digital converters calibrated at the factory. PECI provides an interface for external devices to read processor temperature, perform processor manageability functions, and manage processor interface tuning and diagnostics.

The PECI interface operates at a nominal voltage. The set of DC electrical specifications shown in Section 2.8.3.2, "PECI DC Specifications" is used with devices normally operating from a PECI interface supply.

#### 2.2.5.1 Input Device Hysteresis

The PECI client and host input buffers must use a Schmitt-triggered input design for improved noise immunity. Please refer to the following image and Section 2.8.3.2, "PECI DC Specifications."

Figure 2-1. Input Device Hysteresis





## 2.2.6 System Reference Clocks (BCLK{0/1/2}\_DP, BCLK{0/1/2}\_DN)

The processor Core, processor Uncore, Intel® UPI, PCI Express\* and DDR4 memory interface frequencies are generated from BCLK $\{0/1/2\}$ \_DP and BCLK $\{0/1/2\}$ \_DN signals. There is no direct link between core frequency and Intel UPI link frequency (e.g., no core frequency to Intel® UPI multiplier). The processor maximum core frequency, Intel® UPI link frequency and DDR memory frequency are set during manufacturing. It is possible to override the processor core frequency setting using software. This permits operation at lower core frequencies than the factory set maximum core frequency.

The processor core frequency is configured during reset by using values stored within the device during manufacturing. The stored value sets the lowest core multiplier at which the particular processor can operate. If higher speeds are desired, the appropriate ratio can be configured via the IA32\_PERF\_CTL MSR (MSR 199h); Bits [14:0]. For details of operation at core frequencies lower than the maximum rated processor speed.

Clock multiplying within the processor is provided by the internal phase locked loop (PLL), which requires a constant frequency BCLK $\{0/1/2\}$ \_DP, BCLK $\{0/1/2\}$ \_DN input, with exceptions for spread spectrum clocking. DC specifications for the BCLK $\{0/1/2\}$ \_DP, BCLK $\{0/1/2\}$ \_DN inputs are provided in Section 2.8.3.7, "Processor Asynchronous Sideband DC Specifications."

These specifications must be met while also meeting the associated signal quality specifications outlined in Section 2.10, "Signal Quality."

Details regarding BCLK $\{0/1/2\}$ \_DP, BCLK $\{0/1/2\}$ \_DN driver specifications are provided in the CK420BQ Clock Synthesizer/Driver Specification.

### 2.2.7 JTAG and Test Access Port (TAP) Signals

Due to the voltage levels supported by other components in the JTAG and Test Access Port (TAP) logic, Intel recommends the processor be first in the TAP chain, followed by any other components within the system. Please refer to the Second Generation Intel® Xeon® Scalable Processors Boundary Scan Description Language (BSDL) file more details. A translation buffer should be used to connect to the rest of the chain unless one of the other components is capable of accepting an input of the appropriate voltage. Two copies of each signal may be required with each driving a different voltage level.

## 2.2.8 Processor Sideband Signals

Second Generation Intel® Xeon® Scalable Processors includes asynchronous sideband signals that provide asynchronous input, output or I/O signals between the processor and the platform or Platform Controller Hub. Details can be found in Table 2-7.

All Processor Asynchronous Sideband input signals are required to be asserted/ deasserted for a defined number of BCLKs in order for the processor to recognize the proper signal state, these are outlined in Section 2.8.3.7, "Processor Asynchronous Sideband DC Specifications". Refer to Section 2.10, "Signal Quality" for applicable signal integrity specifications.



### 2.2.9 Power, Ground and Sense Signals

Processors also include various other signals including power/ground and sense points. Details can be found in Table 2-7, "Signal Groups."

#### 2.2.9.1 Power and Ground Lands

All Vccd, VccIN, and VccSA, and VccS3 lands must be connected to their respective processor power planes, while all Vss lands must be connected to the system ground plane. Refer to the PDG for decoupling, voltage plane and routing guidelines for each power supply voltage.

For clean on-chip power distribution, processors include lands for all required voltage supplies. These are listed in the following table.

#### Table 2-1. Power and Ground Lands

Power and Ground Lands	Comments	
CD_VCC_CORE,CD_VPP CD_VCC_IN, CD_VCCP,	Power supplies for Second Generation Intel® Xeon® Scalable Processors-F SKU	
Vccin	Each VCCIN land must be supplied with the voltage determined by the SVID Bus signals. VR 13.0 defines the voltage level associated with each core SVID pattern.	
VCCD012 VCCD345	Each Vccd land is connected to a switchable 1.20 V supply, provide power to the processor DDR4 interface.  Vccd is also controlled by the SVID Bus. Vccd is the generic term for Vccdo12 and Vccd345	
VCCSA	IO voltage supply input	
V <sub>CC33</sub>	Power supply for PIROM.	
Vss	Ground	
Vccio	IO voltage supply input	

#### 2.2.9.2 Decoupling Guidelines

Due to its large number of transistors and high internal clock speeds, the processor is capable of generating large current swings between low and full power states. This may cause voltages on power planes to sag below their minimum values if bulk decoupling is not adequate. Large electrolytic bulk capacitors (CBULK), help maintain the output voltage during current transients, for example coming out of an idle condition. Care must be taken in the baseboard design to ensure that the voltages provided to the processor remain within the specifications listed in Table 2-13, "Voltage Specification." Failure to do so can result in timing violations or reduced lifetime of the processor.

#### 2.2.9.3 Voltage Identification (VID)

The Voltage Identification (VID) specification for the  $V_{CCIN}$ , VSA, CD\_VCC\_CORE voltage is defined by the VR13.0 PWM: Server VR Vendor PWM Enabling Specification. The reference voltage or the VID setting is set via the SVID communication bus between the processor and the voltage regulator controller chip. The VID settings are the nominal voltages to be delivered to the processor's lands. The VR 13.0 Reference Code Voltage Identification Table specifies the reference voltage level corresponding to the VID value transmitted over serial VID. The VID codes will change due to temperature and/or current load changes in order to minimize the power and to maximize the performance of the part. The specifications are set so that a voltage regulator can operate with all supported frequencies.



Individual processor VID values may be calibrated during manufacturing such that two processor units with the same core frequency may have different default VID settings.

The processor uses voltage identification signals to support automatic selection of a power supply voltage. If the processor socket is empty (SKTOCC\_N high), or a "not supported" response is received from the SVID bus, then the voltage regulation circuit cannot supply the voltage that is requested, the voltage regulator must disable itself or not power on. Vout MAX register (30h) is programmed by the processor to set the maximum supported VID code and if the programmed VID code is higher than the VID supported by the VR, then VR will respond with a "not supported" acknowledgment. See the VR13.0 PWM: Server VR Vendor PWM Enabling Specification for further details.

#### 2.2.9.4 SVID Commands

The processor provides the ability to operate while transitioning to a new VID setting and its associated processor voltage rail. This is represented by a DC shift. It should be noted that a low-to-high or high-to-low voltage state change may result in as many VID transitions as necessary to reach the target voltage. Transitions above the maximum specified VID are not supported. The processor supports the following VR commands:

- SetVID\_Fast (25 mV/μs for Vccin, 10mV for VSA,Vccio and CD\_VCC\_CORE)
- SetVID Slow is 1/4 of SetVID Fast
- SetVID\_Decay (downward voltage only and it's a function of the output capacitance's time constant) commands. The VR 13.0 Reference Code Voltage Identification Table includes SVID step sizes and DC shift ranges. Minimum and maximum voltages must be maintained as shown in Table 2-13, "Voltage Specification." This is a CSR configuration option.

The VRM or EVRD utilized must be capable of regulating its output to the value defined by the new VID. The VR13.0 PWM: Server VR Vendor PWM Enabling Specification contains further details.

Power source characteristics must be guaranteed to be stable whenever the supply to the voltage regulator is stable.

#### 2.2.9.5 SetWP Working Point Command

The SetWP is a command that invokes a look up table for VID set points. During the initial power on phase the CPU will program the WPx registers (WP0=3Ah..WP7=41h) on a per rail address basis. When use with the AllCall address, SetWP acts as a group command that moves all voltage rails on the bus to new voltages in the look up table index. The SetWP command can also be used with an individual VR rail address and that rail moves to the voltage in the loop up table index. Each VR domain address has registers WP0-WPx (3Ah..41h) which stores the VID code for that domain's work points.

The Work Point command is encoded to support up to 8 VID targets, slew rate for the command, and alert function. The PWM should use its auto power state or auto-phase shedding functions to select appropriate # phases, CCM/DCM operation, and so forth. based on output load current after the SetWP command target has been reached.

Typical SetWP usage will be:

1. Processor writes VID codes to WP registers WP0 (3Ah) -WP4 (3Dh) in each VR domain. Normally done during SVID enumeration phase of system boot.



- 2. If a WPO-7 register is not programmed by the CPU, the VR stays at its present VID setting when it receives a SetWP (WPn) command.
- 3. Processor sends SetWP (WPn) command to one of the AllCall addresses 0Eh or 0Fh. See PWM guideline for more information on AllCall address mapping.
- 4. Voltage rails change VID to their corresponding VID code stored in their WPx register
- 5. CPU polls each VR addresses reading stutus1 to clear the alerts from the VRs
- 6. SVID error handling

WP0 = State 0, programed by master

WP1 = State 1, programmed by master

WP2 = State 2, programmed by master

WP3 = State 3, programmed by master

WP4 = State 4, programmed by master

...

WP7 = State 7

#### 2.2.9.6 SetVID Fast Command

The SetVID\_Fast command contains the target VID in the payload byte. The range of voltage is defined in the VID table. The VR should ramp to the new VID setting with a fast slew rate as defined in the slew rate data register. It is minimum of  $25 \text{ mV/\mu s}$  for VCCIN and  $10 \text{ mV/\mu s}$  for other rails, depending on the amount of decoupling capacitance.

The SetVID\_Fast command is preemptive. The VR interrupts its current processes and moves to the new VID. The SetVID\_Fast command operates on 1 VR address at a time. This command is used in the processor for package C6 fast exit.

#### **2.2.9.7 SetVID Slow**

The SetVID\_Slow command contains the target VID in the payload byte. The range of voltage is defined in the VID table. The VR should ramp to the new VID setting with a "slow" slew rate as defined in the slow slew rate data register. The SetVID\_Slow is nominally 4x slower than the SetVID Fast slew rate.

The SetVID\_Slow command is preemptive, the VR interrupts its current processes and moves to the new VID. This is the instruction used for normal P-state voltage change. This command is used in the processor for the Intel Enhanced SpeedStep® Technology transitions.

#### 2.2.9.8 SetVID Decay

The SetVID\_Decay command is the slowest of the DVID transitions. It is only used for VID down transitions. The VR does not control the slew rate, the output voltage declines with the output load current only.

The SetVID\_Decay command is preemptive, the VR interrupts its current processes and moves to the new VID. This command is used in the processor for package C6 entry, allowing capacitor discharge by the leakage, thus saving energy. This command is only used in VID down direction in the processor package C6 entry.



#### **SVID Voltage Rail Addressing** 2.2.9.9

The processor addresses 4 different voltage rail control segments within VR13.0 (VccIN, VCCD, VCCSA, VCCIO and CD VCC CORE). The SVID data packet contains a 4-bit addressing code:

#### **SVID Address Usage Bus 1 Table 2-2.**

PWM Address (HEX)	Protocol ID	Second Generation Intel® Xeon® Scalable
00	04H(10 mV VID)	Vccin
01	07H(5 mV VID)	Vccsa
02	07H(5 mV VID)	Vccio
03	07H(5 mV VID)	CD_VCC_CORE
04		Reserved for optional rail
05		Reserved for optional rail

#### Notes:

- Check with VR vendors for determining the physical address assignment method for their controllers. VR addressing is assigned on a per voltage rail basis.

  Dual VR controllers will have two addresses with the lowest order address, always being the higher phase count.
- For future platform flexibility, the VR controller should include an address offset, as shown with +1not used.

#### **Table 2-3. SVID Address Usage Bus 2**

PWM Address (HEX)	Protocol ID	Second Generation Intel® Xeon® Scalable
00	04H(10mV VID) or 07H(5mV VID)	VCCD012
01		NA
02	04H(10mV VID) or 07H(5mV VID)	VCCD345
03		NA

#### Notes:

- Check with VR vendors for determining the physical address assignment method for their controllers.
- VR addressing is assigned on a per voltage rail basis.
- Dual VR controllers will have two addresses with the lowest order address, always being the higher

VR13.0 Reference Code VCCIN Voltage Identification (VID) (Sheet 1 of 2) **Table 2-4.** 

HEX	VCCIN														
00	0.00	20	0.81	40	1.13	60	1.45	80	1.77	Α0	2.09	C0	2.41	E0	2.73
01	0.50	21	0.82	41	1.14	61	1.46	81	1.78	A1	2.10	C1	2.42	E1	2.74
02	0.51	22	0.83	42	1.15	62	1.47	82	1.79	A2	2.11	C2	2.43	E2	2.75
03	0.52	23	0.84	43	1.16	63	1.48	83	1.80	А3	2.12	C3	2.44	E3	2.76
04	0.53	24	0.85	44	1.17	64	1.49	84	1.81	A4	2.13	C4	2.45	E4	2.77
05	0.54	25	0.86	45	1.18	65	1.50	85	1.82	A5	2.14	C5	2.46	E5	2.78
06	0.55	26	0.87	46	1.19	66	1.51	86	1.83	A6	2.15	C6	2.47	E6	2.79
07	0.56	27	0.88	47	1.20	67	1.52	87	1.84	A7	2.16	C7	2.48	E7	2.80
08	0.57	28	0.89	48	1.21	68	1.53	88	1.85	A8	2.17	C8	2.49	E8	2.81
09	0.58	29	0.90	49	1.22	69	1.54	89	1.86	A9	2.18	C9	2.50	E9	2.82
0A	0.59	2A	0.91	4A	1.23	6A	1.55	8A	1.87	AA	2.19	CA	2.51	EA	2.83



Table 2-4. VR13.0 Reference Code VCCIN Voltage Identification (VID) (Sheet 2 of 2)

					_			_	_		_		_		_
HEX	VCCIN														
0B	0.60	2B	0.92	4B	1.24	6B	1.56	8B	1.88	AB	2.20	СВ	2.52	EB	2.84
0C	0.61	2C	0.93	4C	1.25	6C	1.57	8C	1.89	AC	2.21	CC	2.53	EC	2.85
0D	0.62	2D	0.94	4D	1.26	6D	1.58	8D	1.90	AD	2.22	CD	2.54	ED	2.86
0E	0.63	2E	0.95	4E	1.27	6E	1.59	8E	1.91	AE	2.23	CE	2.55	EE	2.87
0F	0.64	2F	0.96	4F	1.28	6F	1.60	8F	1.92	AF	2.24	CF	2.56	EF	2.88
10	0.65	30	0.97	50	1.29	70	1.61	90	1.93	В0	2.25	D0	2.57	F0	2.89
11	0.66	31	0.98	51	1.30	71	1.62	91	1.94	B1	2.26	D1	2.58	F1	2.90
12	0.67	32	0.98	52	1.31	72	1.63	92	1.95	B2	2.27	D2	2.59	F2	2.91
13	0.68	33	1.00	53	1.32	73	1.64	93	1.96	В3	2.28	D3	2.60	F3	2.92
14	0.69	34	1.01	54	1.33	74	1.65	94	1.97	В4	2.29	D4	2.61	F4	2.93
15	0.70	35	1.02	55	1.34	75	1.66	95	1.98	В5	2.30	D5	2.62	F5	2.94
16	0.71	36	1.03	56	1.35	76	1.67	96	1.99	В6	2.31	D6	2.63	F6	2.95
17	0.72	37	1.04	57	1.36	77	1.68	97	2.00	В7	2.32	D7	2.64	F7	2.96
18	0.73	38	1.05	58	1.37	78	1.69	98	2.01	В8	2.33	D8	2.65	F8	2.97
19	0.74	39	1.06	59	1.38	79	1.70	99	2.02	В9	2.34	D9	2.66	F9	2.98
1A	0.75	3A	1.07	5A	1.39	7A	1.71	9A	2.03	BA	2.35	DA	2.67	FA	2.99
1B	0.76	3B	1.08	5B	1.40	7B	1.72	9B	2.04	ВВ	2.36	DB	2.68	FB	3.00
1C	0.77	3C	1.09	5C	1.41	7C	1.73	9C	2.05	ВС	2.37	DC	2.69	FC	3.01
1D	0.78	3D	1.10	5D	1.42	7D	1.74	9D	2.06	BD	2.38	DD	2.70	FD	3.02
1E	0.79	3E	1.11	5E	1.43	7E	1.75	9E	2.07	BE	2.39	DE	2.71	FE	3.03
1F	0.80	3F	1.12	5F	1.44	7F	1.76	9F	2.08	BF	2.40	DF	2.72	FF	3.04

#### Notes:

- 00h = Off State

- VID Range HEX 65-97 are used by the Intel® Xeon® processor E5-1600 and E5-2600 v5 product families VCCD can use Protocol ID of 10 mV or 5 mV,.

  VCCD can use Table 2-4, "VR13.0 Reference Code VCCIN Voltage Identification (VID)" or VID Table 2-5, "VSA, VCCIO, CD\_VCC\_CORE or VCCD VID Table."

Table 2-5. VSA, VCCIO, CD\_VCC\_CORE or VCCD VID Table (Sheet 1 of 8)

н	EX	5 mV step mode voltage	5 mV step recommended accuracy	10 mV step mode voltage	10 mV step mode recommended accuracy	10 mV mode market segment
0	0	0	NA	0	NA	All
0	1	0.25	±8 mV	0.5	±10 mV	All
0	2	0.255	±8 mV	0.51	±10 mV	All
0	3	0.26	±8 mV	0.52	±10 mV	All
0	4	0.265	±8 mV	0.53	±10 mV	All
0	5	0.27	±8 mV	0.54	±10 mV	All
0	6	0.275	±8 mV	0.55	±10 mV	All
0	7	0.28	±8 mV	0.56	±10 mV	All
0	8	0.285	±8 mV	0.57	±10 mV	All
0	9	0.29	±8 mV	0.58	±10 mV	All
0	Α	0.295	±8 mV	0.59	±10 mV	All
0	В	0.3	±8 mV	0.6	±10 mV	All
0	С	0.305	±8 mV	0.61	±10 mV	All



Table 2-5. VSA, VCCIO, CD\_VCC\_CORE or VCCD VID Table (Sheet 2 of 8)

н	EX	5 mV step mode voltage	5 mV step recommended accuracy	10 mV step mode voltage	10 mV step mode recommended accuracy	10 mV mode market segment
0	D	0.31	±8 mV	0.62	±10 mV	All
0	Е	0.315	±8 mV	0.63	±10 mV	All
0	F	0.32	±8 mV	0.64	±10 mV	All
1	0	0.325	±8 mV	0.65	±10 mV	All
1	1	0.33	±8 mV	0.66	±10 mV	All
1	2	0.335	±8 mV	0.67	±10 mV	All
1	3	0.34	±8 mV	0.68	±10 mV	All
1	4	0.345	±8 mV	0.69	±10 mV	All
1	5	0.35	±8 mV	0.7	±10 mV	All
1	6	0.355	±8 mV	0.71	±10 mV	All
1	7	0.36	±8 mV	0.72	±10 mV	All
1	8	0.365	±8 mV	0.73	±10 mV	All
1	9	0.37	±8 mV	0.74	±10 mV	All
1	A	0.375	±8 mV	0.75	±10 mV	All
1	С	0.38	±8 mV ±8 mV	0.76 0.77	±10 mV ±10 mV	All All
1	D	0.39	±8 mV	0.78	±10 mV	All
1	Е	0.395	±8 mV	0.79	±10 mV	All
1	F	0.4	±8 mV	0.8	±10 mV	All
2	0	0.405	±8 mV	0.81	±10 mV	All
2	1	0.41	±8 mV	0.82	±10 mV	All
2	2	0.415	±8 mV	0.83	±10 mV	All
2	3	0.42	±8 mV	0.84	±10 mV	All
2	4	0.425	±8 mV	0.85	±10 mV	All
2	5	0.43	±8 mV	0.86	±10 mV	All
2	6	0.435	±8 mV	0.87	±10 mV	All
2	7	0.44	±8 mV	0.88	±10 mV	All
2	8	0.445	±8 mV	0.89	±10 mV	All
2	9	0.45	±8 mV	0.9	±10 mV	All
2	Α	0.455	±8 mV	0.91	±10 mV	All
2	В	0.46	±8 mV	0.92	±10 mV	All
2	С	0.465	±8 mV	0.93	±10 mV	All
2	D	0.47	±8 mV	0.94	±10 mV	All
2	E	0.475	±8 mV	0.95	±10 mV	All
	F		±8 mV	0.95		
2		0.48			±10 mV	All
3	0	0.485	±8 mV	0.97	±10 mV	All
3	1	0.49	±8 mV	0.98	±10 mV	All
3	2	0.495	±8 mV	0.99	±10 mV	All



Table 2-5. VSA, VCCIO, CD\_VCC\_CORE or VCCD VID Table (Sheet 3 of 8)

н	ĒΧ	5 mV step mode voltage	5 mV step recommended accuracy	10 mV step mode voltage	10 mV step mode recommended accuracy	10 mV mode market segment
3	3	0.5	±8 mV	1	±8 mV	All
3	4	0.505	±8 mV	1.01	±8 mV	All
3	5	0.51	±8 mV	1.02	±8 mV	All
3	6	0.515	±8 mV	1.03	±8 mV	All
3	7	0.52	±8 mV	1.04	±8 mV	All
3	8	0.525	±8 mV	1.05	±8 mV	All
3	9	0.53	±8 mV	1.06	±8 mV	All
3	Α	0.535	±8 mV	1.07	±8 mV	All
3	В	0.54	±8 mV	1.08	±8 mV	All
3	С	0.545	±8 mV	1.09	±8 mV	All
3	D	0.55	±8 mV	1.1	±8 mV	All
3	Е	0.555	±8 mV	1.11	±8 mV	All
3	F	0.56	±8 mV	1.12	±8 mV	All
4	0	0.565	±8 mV	1.13	±8 mV	All
4	1	0.57	±8 mV	1.14	±8 mV	All
4	2	0.575	±8 mV	1.15	±8 mV	All
4	3	0.58	±8 mV	1.16	±8 mV	All
4	4	0.585	±8 mV	1.17	±8 mV	All
4	5	0.59	±8 mV	1.18	±8 mV	All
4	6	0.595	±8 mV	1.19	±8 mV	All
4	7	0.6	±8 mV	1.2	±8 mV	All
4	8	0.605	±8 mV	1.21	±8 mV	All
4	9	0.61	±8 mV	1.22	±8 mV	All
4	Α	0.615	±8 mV	1.23	±8 mV	All
4	В	0.62	±8 mV	1.24	±8 mV	All
4	С	0.625	±8 mV	1.25	±8 mV	All
4	D	0.63	±8 mV	1.26	±8 mV	All
4	Е	0.635	±8 mV	1.27	±8 mV	All
4	F	0.64	±8 mV	1.28	±8 mV	All
5	0	0.645	±8 mV	1.29	±8 mV	All
5	1	0.65	±8 mV	1.3	±8 mV	All
5	2	0.655	±8 mV	1.31	±8 mV	All
5	3	0.66	±8 mV	1.32	±8 mV	All
5	4	0.665	±8 mV	1.33	±8 mV	All
5	5	0.67	±8 mV	1.34	±8 mV	All
5	6	0.675	±8 mV	1.35	±8 mV	All



Table 2-5. VSA, VCCIO, CD\_VCC\_CORE or VCCD VID Table (Sheet 4 of 8)

НЕ	ΕX	5 mV step mode voltage	5 mV step recommended accuracy	10 mV step mode voltage	10 mV step mode recommended accuracy	10 mV mode market segment
5	7	0.68	±8 mV	1.36	±8 mV	All
5	8	0.685	±8 mV	1.37	±8 mV	All
5	9	0.69	±8 mV	1.38	±8 mV	All
5	Α	0.695	±8 mV	1.39	±8 mV	All
5	В	0.7	±8 mV	1.4	±8 mV	All
5	С	0.705	±8 mV	1.41	±8 mV	All
5	D	0.71	±8 mV	1.42	±8 mV	All
5	Е	0.715	±8 mV	1.43	±8 mV	All
5	F	0.72	±8 mV	1.44	±8 mV	All
6	0	0.725	±8 mV	1.45	±8 mV	All
6	1	0.73	±8 mV	1.46	±8 mV	All
6	2	0.735	±8 mV	1.47	±8 mV	All
6	3	0.74	±8 mV	1.48	±8 mV	All
6	4	0.745	±8 mV	1.49	±8 mV	All
6	5	0.75	±8 mV	1.5	±0.5% of VID	All
6	6	0.755	±8 mV	1.51	±0.5% of VID	All
6	7	0.76	±8 mV	1.52	±0.5% of VID	All
6	8	0.765	±8 mV	1.53	±0.5% of VID	All
6	9	0.77	±8 mV	1.54	±0.5% of VID	All
6	Α	0.775	±8 mV	1.55	±0.5% of VID	All
6	В	0.78	±8 mV	1.56	±0.5% of VID	All
6	С	0.785	±8 mV	1.57	±0.5% of VID	All
6	D	0.79	±8 mV	1.58	±0.5% of VID	All
6	Е	0.795	±8 mV	1.59	±0.5% of VID	All
6	F	0.8	±5 mV	1.6	±0.5% of VID	All
7	0	0.805	±5 mV	1.61	±0.5% of VID	All
7	1	0.81	±5 mV	1.62	±0.5% of VID	All
7	2	0.815	±5 mV	1.63	±0.5% of VID	All
7	3	0.82	±5 mV	1.64	±0.5% of VID	All
7	4	0.825	±5 mV	1.65	±0.5% of VID	All
7	5	0.83	±5 mV	1.66	±0.5% of VID	All
7	6	0.835	±5 mV	1.67	±0.5% of VID	All
7	7	0.84	±5 mV	1.68	±0.5% of VID	All
7	8	0.845	±5 mV	1.69	±0.5% of VID	All
7	9	0.85	±5 mV	1.7	±0.5% of VID	All
7	Α	0.855	±5 mV	1.71	±0.5% of VID	All



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Table 2-5. VSA, VCCIO, CD\_VCC\_CORE or VCCD VID Table (Sheet 5 of 8)

Н	EX	5 mV step mode voltage	5 mV step recommended accuracy	10 mV step mode voltage	10 mV step mode recommended accuracy	10 mV mode market segment
7	В	0.86	±5 mV	1.72	±0.5% of VID	All
7	С	0.865	±5 mV	1.73	±0.5% of VID	All
7	D	0.87	±5 mV	1.74	±0.5% of VID	All
7	Е	0.875	±5 mV	1.75	±0.5% of VID	All
7	F	0.88	±5 mV	1.76	±0.5% of VID	All
8	0	0.885	±5 mV	1.77	±0.5% of VID	All
8	1	0.89	±5 mV	1.78	±0.5% of VID	All
8	2	0.895	±5 mV	1.79	±0.5% of VID	All
8	3	0.9	±5 mV	1.8	±0.5% of VID	All
8	4	0.905	±5 mV	1.81	±0.5% of VID	All
8	5	0.91	±5 mV	1.82	±0.5% of VID	All
8	6	0.915	±5 mV	1.83	±0.5% of VID	All
8	7	0.92	±5 mV	1.84	±0.5% of VID	All
8	8	0.925	±5 mV	1.85	±0.5% of VID	All
8	9	0.93	±5 mV	1.86	±0.5% of VID	All
8	Α	0.935	±5 mV	1.87	±0.5% of VID	All
8	В	0.94	±5 mV	1.88	±0.5% of VID	All
8	С	0.945	±5 mV	1.89	±0.5% of VID	All
8	D	0.95	±5 mV	1.9	±0.5% of VID	All
8	Е	0.955	±5 mV	1.91	±0.5% of VID	All
8	F	0.96	±5 mV	1.92	±0.5% of VID	All
9	0	0.965	±5 mV	1.93	±0.5% of VID	All
9	1	0.97	±5 mV	1.94	±0.5% of VID	All
9	2	0.975	±5 mV	1.95	±0.5% of VID	All
9	3	0.98	±5 mV	1.96	±0.5% of VID	All
9	4	0.985	±5 mV	1.97	±0.5% of VID	All
9	5	0.99	±5 mV	1.98	±0.5% of VID	All
9	6	0.995	±5 mV	1.99	±0.5% of VID	All
9	7	1	±0.5% of VID	2	±0.5% of VID	All
9	8	1.005	±0.5% of VID	2.01	±0.5% of VID	Optional
9	9	1.01	±0.5% of VID	2.02	±0.5% of VID	Optional
9	Α	1.015	±0.5% of VID	2.03	±0.5% of VID	Optional
9	В	1.02	±0.5% of VID	2.04	±0.5% of VID	Optional
9	С	1.025	±0.5% of VID	2.05	±0.5% of VID	Optional
9	D	1.03	±0.5% of VID	2.06	±0.5% of VID	Optional
9	Е	1.035	±0.5% of VID	2.07	±0.5% of VID	Optional



Table 2-5. VSA, VCCIO, CD\_VCC\_CORE or VCCD VID Table (Sheet 6 of 8)

н	ΕX	5 mV step mode voltage	5 mV step recommended accuracy	10 mV step mode voltage	10 mV step mode recommended accuracy	10 mV mode market segment
9	F	1.04	±0.5% of VID	2.08	±0.5% of VID	Optional
Α	0	1.045	±0.5% of VID	2.09	±0.5% of VID	Optional
Α	1	1.05	±0.5% of VID	2.1	±0.5% of VID	Optional
Α	2	1.055	±0.5% of VID	2.11	±0.5% of VID	Optional
Α	3	1.06	±0.5% of VID	2.12	±0.5% of VID	Optional
Α	4	1.065	±0.5% of VID	2.13	±0.5% of VID	Optional
Α	5	1.07	±0.5% of VID	2.14	±0.5% of VID	Optional
Α	6	1.075	±0.5% of VID	2.15	±0.5% of VID	Optional
Α	7	1.08	±0.5% of VID	2.16	±0.5% of VID	Optional
Α	8	1.085	±0.5% of VID	2.17	±0.5% of VID	Optional
Α	9	1.09	±0.5% of VID	2.18	±0.5% of VID	Optional
Α	Α	1.095	±0.5% of VID	2.19	±0.5% of VID	Optional
Α	В	1.1	±0.5% of VID	2.2	±0.5% of VID	Optional
Α	С	1.105	±0.5% of VID	2.21	±0.5% of VID	Optional
Α	D	1.11	±0.5% of VID	2.22	±0.5% of VID	Optional
Α	Е	1.115	±0.5% of VID	2.23	±0.5% of VID	Optional
Α	F	1.12	±0.5% of VID	2.24	±0.5% of VID	Optional
В	0	1.125	±0.5% of VID	2.25	±0.5% of VID	Optional
В	1	1.13	±0.5% of VID	2.26	±0.5% of VID	Optional
В	2	1.135	±0.5% of VID	2.27	±0.5% of VID	Optional
В	3	1.14	±0.5% of VID	2.28	±0.5% of VID	Optional
В	4	1.145	±0.5% of VID	2.29	±0.5% of VID	Optional
В	5	1.15	±0.5% of VID	2.3	±0.5% of VID	>2.3 not required in any segment
В	6	1.155	±0.5% of VID	2.31	±0.5% of VID	>2.3 not required in any segment
В	7	1.16	±0.5% of VID	2.32	±0.5% of VID	>2.3 not required in any segment
В	8	1.165	±0.5% of VID	2.33	±0.5% of VID	>2.3 not required in any segment
В	9	1.17	±0.5% of VID	2.34	±0.5% of VID	>2.3 not required in any segment
В	Α	1.175	±0.5% of VID	2.35	±0.5% of VID	>2.3 not required in any segment
В	В	1.18	±0.5% of VID	2.36	±0.5% of VID	>2.3 not required in any segment
В	С	1.185	±0.5% of VID	2.37	±0.5% of VID	>2.3 not required in any segment
В	D	1.19	±0.5% of VID	2.38	±0.5% of VID	>2.3 not required in any segment
В	Е	1.195	±0.5% of VID	2.39	±0.5% of VID	>2.3 not required in any segment
В	F	1.2	±0.5% of VID	2.4	±0.5% of VID	>2.3 not required in any segment
С	0	1.205	±0.5% of VID	2.41	±0.5% of VID	>2.3 not required in any segment
С	1	1.21	±0.5% of VID	2.42	±0.5% of VID	>2.3 not required in any segment
С	2	1.215	±0.5% of VID	2.43	±0.5% of VID	>2.3 not required in any segment



Table 2-5. VSA, VCCIO, CD\_VCC\_CORE or VCCD VID Table (Sheet 7 of 8)

н	€X	5 mV step mode voltage	5 mV step recommended accuracy	10 mV step mode voltage	10 mV step mode recommended accuracy	10 mV mode market segment
С	3	1.22	±0.5% of VID	2.44	±0.5% of VID	>2.3 not required in any segment
С	4	1.225	±0.5% of VID	2.45	±0.5% of VID	>2.3 not required in any segment
С	5	1.23	±0.5% of VID	2.46	±0.5% of VID	>2.3 not required in any segment
С	6	1.235	±0.5% of VID	2.47	±0.5% of VID	>2.3 not required in any segment
С	7	1.24	±0.5% of VID	2.48	±0.5% of VID	>2.3 not required in any segment
С	8	1.245	±0.5% of VID	2.49	±0.5% of VID	>2.3 not required in any segment
С	9	1.25	±0.5% of VID	2.5	±0.5% of VID	>2.3 not required in any segment
С	Α	1.255	±0.5% of VID	2.51	±0.5% of VID	>2.3 not required in any segment
С	В	1.26	±0.5% of VID	2.52	±0.5% of VID	>2.3 not required in any segment
С	С	1.265	±0.5% of VID	2.53	±0.5% of VID	>2.3 not required in any segment
С	D	1.27	±0.5% of VID	2.54	±0.5% of VID	>2.3 not required in any segment
С	Е	1.275	±0.5% of VID	2.55	±0.5% of VID	>2.3 not required in any segment
С	F	1.28	±0.5% of VID	2.56	±0.5% of VID	>2.3 not required in any segment
D	0	1.285	±0.5% of VID	2.57	±0.5% of VID	>2.3 not required in any segment
D	1	1.29	±0.5% of VID	2.58	±0.5% of VID	>2.3 not required in any segment
D	2	1.295	±0.5% of VID	2.59	±0.5% of VID	>2.3 not required in any segment
D	3	1.3	±0.5% of VID	2.6	±0.5% of VID	>2.3 not required in any segment
D	4	1.305	±0.5% of VID	2.61	±0.5% of VID	>2.3 not required in any segment
D	5	1.31	±0.5% of VID	2.62	±0.5% of VID	>2.3 not required in any segment
D	6	1.315	±0.5% of VID	2.63	±0.5% of VID	>2.3 not required in any segment
D	7	1.32	±0.5% of VID	2.64	±0.5% of VID	>2.3 not required in any segment
D	8	1.325	±0.5% of VID	2.65	±0.5% of VID	>2.3 not required in any segment
D	9	1.33	±0.5% of VID	2.66	±0.5% of VID	>2.3 not required in any segment
D	Α	1.335	±0.5% of VID	2.67	±0.5% of VID	>2.3 not required in any segment
D	В	1.34	±0.5% of VID	2.68	±0.5% of VID	>2.3 not required in any segment
D	С	1.345	±0.5% of VID	2.69	±0.5% of VID	>2.3 not required in any segment
D	D	1.35	±0.5% of VID	2.7	±0.5% of VID	>2.3 not required in any segment
D	Е	1.355	±0.5% of VID	2.71	±0.5% of VID	>2.3 not required in any segment
D	F	1.36	±0.5% of VID	2.72	±0.5% of VID	>2.3 not required in any segment
Е	0	1.365	±0.5% of VID	2.73	±0.5% of VID	>2.3 not required in any segment
Е	1	1.37	±0.5% of VID	2.74	±0.5% of VID	>2.3 not required in any segment
Е	2	1.375	±0.5% of VID	2.75	±0.5% of VID	>2.3 not required in any segment
Е	3	1.38	±0.5% of VID	2.76	±0.5% of VID	>2.3 not required in any segment
Е	4	1.385	±0.5% of VID	2.77	±0.5% of VID	>2.3 not required in any segment
Е	5	1.39	±0.5% of VID	2.78	±0.5% of VID	>2.3 not required in any segment
Е	6	1.395	±0.5% of VID	2.79	±0.5% of VID	>2.3 not required in any segment



Table 2-5. VSA, VCCIO, CD\_VCC\_CORE or VCCD VID Table (Sheet 8 of 8)

н	ΕX	5 mV step mode voltage	5 mV step recommended accuracy	10 mV step mode voltage	10 mV step mode recommended accuracy	10 mV mode market segment
Е	7	1.4	±0.5% of VID	2.8	±0.5% of VID	>2.3 not required in any segment
Е	8	1.405	±0.5% of VID	2.81	±0.5% of VID	>2.3 not required in any segment
Е	9	1.41	±0.5% of VID	2.82	±0.5% of VID	>2.3 not required in any segment
Е	Α	1.415	±0.5% of VID	2.83	±0.5% of VID	>2.3 not required in any segment
Е	В	1.42	±0.5% of VID	2.84	±0.5% of VID	>2.3 not required in any segment
Е	С	1.425	±0.5% of VID	2.85	±0.5% of VID	>2.3 not required in any segment
Е	D	1.43	±0.5% of VID	2.86	±0.5% of VID	>2.3 not required in any segment
Е	Е	1.435	±0.5% of VID	2.87	±0.5% of VID	>2.3 not required in any segment
Е	F	1.44	±0.5% of VID	2.88	±0.5% of VID	>2.3 not required in any segment
F	0	1.445	±0.5% of VID	2.89	±0.5% of VID	>2.3 not required in any segment
F	1	1.45	±0.5% of VID	2.9	±0.5% of VID	>2.3 not required in any segment
F	2	1.455	±0.5% of VID	2.91	±0.5% of VID	>2.3 not required in any segment
F	3	1.46	±0.5% of VID	2.92	±0.5% of VID	>2.3 not required in any segment
F	4	1.465	±0.5% of VID	2.93	±0.5% of VID	>2.3 not required in any segment
F	5	1.47	±0.5% of VID	2.94	±0.5% of VID	>2.3 not required in any segment
F	6	1.475	±0.5% of VID	2.95	±0.5% of VID	>2.3 not required in any segment
F	7	1.48	±0.5% of VID	2.96	±0.5% of VID	>2.3 not required in any segment
F	8	1.485	±0.5% of VID	2.97	±0.5% of VID	>2.3 not required in any segment
F	9	1.49	±0.5% of VID	2.98	±0.5% of VID	>2.3 not required in any segment
F	Α	1.495	±0.5% of VID	2.99	±0.5% of VID	>2.3 not required in any segment
F	В	1.5	±0.5% of VID	3	±0.5% of VID	>2.3 not required in any segment
F	С	1.505	±0.5% of VID	3.01	±0.5% of VID	>2.3 not required in any segment
F	D	1.51	±0.5% of VID	3.02	±0.5% of VID	>2.3 not required in any segment
F	Е	1.515	±0.5% of VID	3.03	±0.5% of VID	>2.3 not required in any segment
F	F	1.52	±0.5% of VID	3.04	±0.5% of VID	>2.3 not required in any segment

#### Note:

#### 2.2.10 Reserved or Unused Signals

All Reserved (RSVD) signals must not be connected. Connection of these signals to VCCIN, VCCD, VSS, or to any other signal (including each other) can result in component malfunction or incompatibility with future processors.

For reliable operation, always connect unused inputs or bi-directional signals to an appropriate signal level. Unused active high inputs should be connected through a resistor to ground (Vss). Unused outputs maybe left unconnected; however, this may interfere with some Test Access Port (TAP) functions, complicate debug probing, and

DAC accuracy is a recommendation only. Total tolerance band must be met, that is, DAC set point + current sense AVP droop
accuracy. VCCD may use 5 mV or 10 mV VID tables, this is set by selecting the protocol ID bit in the PWM controller, which is
read by BIOS at boot.

VCCD can use VID Table 2-4, "VR13.0 Reference Code VCCIN Voltage Identification (VID)" or VID Table 2-5, "VSA, VCCIO, CD VCC CORE or VCCD VID Table."



prevent boundary scan testing. A resistor must be used when tying bi-directional signals to power or ground. When tying any signal to power or ground, a resistor will also allow for system testability. Resistor values should be within  $\pm$  20% of the impedance of the baseboard trace, unless otherwise noted in the appropriate platform design guidelines.

## 2.3 Signal Group Summary

Signals are grouped by buffer type and similar characteristics as listed in the following table. The buffer type indicates which signaling technology and specifications apply to the signals.

#### **Table 2-6.** Signal Description Buffer Types

Signal	Description
Analog	Analog reference or output. May be used as a threshold voltage or for buffer compensation
Asynchronous	Signal has no timing relationship with any system reference clock.
CMOS	CMOS Output buffers: 1.05 V tolerant / CMOS Input buffers
DDR4	CMOS Output buffers 1.2 V tolerant
DMI3	Direct Media Interface Gen 3 signals. These signals are compatible with PCI Express* 3.0 Signaling Environment AC Specifications.
Intel® UPI	Current-mode 9.6 GT/s or 10.4 GT/s. Nominal voltage is 1.0 V.
Open Drain	Open Drain buffers: 1.05 V tolerant
PCI Express*	PCI Express interface signals. These signals are compatible with PCI Express 3.0 Signaling Environment AC Specifications and are AC coupled. The buffers are not 3.3-V tolerant. Refer to the PCIe specification.
Reference	Voltage reference signal.
SSTL	Source Series Terminated Logic (JEDEC SSTL_15)

**Note:** Qualifier for a buffer type.

#### Table 2-7. Signal Groups (Sheet 1 of 4)

Differential/Single Ended	Buffer Type	Signal						
DDR4 Reference Clocks								
Differential	SSTL Output	DDR{0/1/2/3/4/5}_CLK_D[N/P] [3:0]						
<b>DDR4 Command Signals</b>								
Single-ended	SSTL Output	DDR{0/1/2/3/4/5}_ACT_N DDR{0/1/2/ 3/4/5}_BA[1:0] DDR{0/1/2/3/4/ 5}_BG[1:0] DDR{0/1/2/3/4/ 5}_MA[17:0] DDR{0/1/2/3/4/5}_PAR						
<b>DDR4 Control Signals</b>								
Single-ended	SSTL Output	DDR{0/1/2/3/4/5}_CS_N[7:0] DDR{0/ 1/2/3/4/5}_CID[2] DDR{0/1/2/3/4/ 5}_ODT[3:0] DDR{0/1/2/3/4/ 5}_CKE[3:0]						
DDR4 Data Signals								
Differential	SSTL Input/Output	DDR{0/1/2/3/4/5}_DQS_D[N/P] [17:0]						
Single-ended	SSTL Input/Output	DDR{0/1/2/3/4/5}_DQ[63:0] DDR{0/ 1/2/3/4/5}_ECC[7:0]						



Table 2-7. Signal Groups (Sheet 2 of 4)

Differential/Single Ended	Buffer Type	Signal
DDR4 Miscellaneous Signals		
	SSTL Input	DDR{0/1/2/3/4/5}_ALERT_N
	CMOS Input Note: Input voltage from platform cannot exceed 1.2 V max. Refer to PDG for implementation details.	DDR{012,345}_DRAM_PWR_OK
Single-ended	CMOS 1.2 V Output	DDR{012,345}_RESET_N
	Open Drain Output / CMOS Input	DDR[012,345]_SPDSCL DDR[012,345]_SPDSDA
	DC Output	DDR{5:0}_CAVREF
	DDR Compensation resistance control	DDR{012,345}_RCOMP[2:0]
PCI Express* Port 1, 2, & 3 Signature	gnals	
Differential	PCI Express* Input	PE{3:1}_RX_DN/DP[15:0]
Differential	PCI Express* Output	PE{3:1}_TX_DN/DP[15:0]
PCI Express* Miscellaneous Si	gnals	
Single-ended	Open Drain Output	PE_HP_SCL
	Open Drain Output /CMOS	PE_HP_SDA
DMI3/PCI Express* Signals		
Differential	DMI3 Input	DMI3_RX_D[N/P][3:0]
Differential	DMI3 Output	DMI3_TX_D[N/P][3:0]
Single-ended	DMI Miscellaneous	DMIMODE_OVERRIDE
Intel® UPI Signals		
Differential	Intel® UPI Input Output	UPI{2:1}_RX/TX_DN/DP[19:0]
Single-ended	Intel® UPI Miscellaneous	UPI{01,2}_RBIAS
Single-ended	Intel® UPI Power	UPI{01,2}_VCCQ
Platform Environmental Contr	ol Interface (PECI)	
Single-ended	PECI Input/Output	PECI
System Reference Clock (BCLk	({0/1/2})	
Differential	CMOS 1.05 V Input	BCLK{0/1/2}_D[N/P]



## Table 2-7. Signal Groups (Sheet 3 of 4)

Differential/Single Ended	Buffer Type	Signal				
JTAG & TAP Signals						
Single ended	CMOS Input	TCK,TDI,TMS,TRST_N,PREQ_N				
	Open Drain Output /CMOS	BPM_N[7:0]				
	Open Drain Output	TDO, PRDY_N				
Serial VID Interface (SVID) S	ignals					
Single ended	CMOS Input	SVIDALERT_N[1:0]				
	Open Drain Output / CMOS	SVIDDATA [1:0]				
	Open Drain Output	SVIDCLK [1:0]				
Processor Asynchronous Side	band Signals					
Single ended	CMOS Input	BIST_ENABLE, BMCINIT, DEBUG_EN_N				
		FRMAGENT, PWRGOOD, PMSYNC RESET_N, SAFE_MODE_BOOT, SOCKET_ID[1:0], TXT_AGENT TXT_PLTEN				
	CMOS Output	FIVR_FAULT				
	Open Drain Output / CMOS Input	CATERR_N, MEM_HOT_C01_N, MEM_HOT_C23_N, MSMI_N, PM_FAST_WAKE_N, PROCHOT_N				
	Open Drain Output	ERROR_N[2:0], THERMTRIP_N				
Miscellaneous Signals						
	CMOS Input	EAR_N,LEGACY_SKT,NMI,PMSYNCPMSY NC_CLK,PROCDIS_N, PWR_DEBUG_N,SOCKET_ID2				
	Open Drain Output / CMOS Input	TSC_SYNC				
	Not connected to Silicon	SKTOCC_N,PKGID[2:0], PROC_ID[1:0]				
Intel Omni-Path Host Fabric I	nterface (Intel® OP HFI) Signal	ls				
	Open Drain Output / CMOS 2.5 Input	CD_HFI[1:0]_I2CCLK, - CD_HFI[1:0]_I2CDAT				
	CMOS 2.5V Input	CD_HFI[1:0]_INT_N, CD_HFI[1:0]_MODPRST_N				
	CMOS 1.8V Input	CD_TCLK, CD_TDI, CD_TMS, CD_TRST_N				
	Open Drain Output	CD_HFI[1:0]_RESET_N, CD_HFI[1:0]_LED_N				
	CMOS 1.8V Output	CD_TDO				
	CMOS Input	CD_HFI_REFCLK_DN/DP				
		CD_POR_N				
		MCP01_RBIAS				



Table 2-7. Signal Groups (Sheet 4 of 4)

Differential/Single Ended	Buffer Type	Signal
Power/Other Signals		
	Power / Ground	VCCIN, VCCD_012, VCCD_345, VCCIO, VCC33, VCC33, VSS
	Sense Points	VCCIN_SENSE, VCCIO_SENSE, VCCSA_SENSE, VSS_VCCIN_SENSE, VSS_VCCIO_SENSE, VSS_VCCSA_SENSE, VCCIN_PMAX, VSENSEPMAX

#### Notes:

- Refer to Chapter 4, "Signal Descriptions" for signal description details.

  DDR{0/1/2/3/4/5} refers to DDR4 Channel 0, DDR4 Channel 1, DDR4 Channel 2, DDR4 Channel 3, DDR4
  Chapter 4, "Signal Descriptions" and DDR4 Chapter 5, "PIROM."

#### **Table 2-8.** Signals with On-Die Weak PU/PD

Signal Name	Pull Up/Pull Down	Rail	Value	Units
BIST_ENABLE	Pull Up	Vccio	3K-8K	ohm
BMCINIT	Pull Down	VSS	3K-8K	ohm
DEBUG_EN_N	Pull Up	Vccio	3K-8K	ohm
DMIMODE_OVERRIDE	Pull Up	Vccio	3K-8K	ohm
EAR_N	Pull Up	Vccio	3K-8K	ohm
FRMAGENT	Pull Down	VSS	3K-8K	ohm
LEGACY_SKT	Pull Down	VSS	3K-8K	ohm
MSMI_N	Pull Up	Vccio	3K-8K	ohm
NMI	Pull Down	VSS	3K-8K	ohm
PM_FAST_WAKE_N	Pull Up	Vccio	3K-8K	ohm
PROCDIS_N	Pull Up	Vccio	3K-8K	ohm
SAFE_MODE_BOOT	Pull Down	VSS	3K-8K	ohm
SOCKET_ID[2:0]	Pull Down	VSS	3K-8K	ohm
TCK	Pull Down	VSS	3K-8K	ohm
TDI	Pull Up	Vccio	3K-8K	ohm
TMS	Pull Up	Vccio	3K-8K	ohm
TRST_N	Pull Up	Vccio 3K-8K		ohm
TXT_AGENT	Pull Down	VSS	3K-8K	ohm
TXT_PLTEN	Pull Up	Vccio	3K-8K	ohm

#### Fault Resilient Booting (FRB) 2.4

FRB is a RASM (Reliability, Availability, Serviceability, and Manageability) feature and this section describes the processor implementation.



The processor supports both socket and core level Fault Resilient Booting (FRB), which provides the ability to boot the system as long as there is one processor functional in the system. One limitation to socket level FRB is that the system cannot boot if the legacy socket that connects to an active PCH becomes unavailable since this is the path to the system BIOS. See the table below for a list of output tri-state FRB signals.

Socket level FRB will tri-state processor outputs via the PROCDIS\_N signal. Assertion of the PROCDIS\_N signal through RESET\_N de-assertion will tri-state processor outputs. Note, that individual core disabling is also supported for those cases where disabling the entire package is not desired.

The processor extends the FRB capability to the core granularity by maintaining a register in the Uncore so that BIOS or another entity can disable one or more specific processor cores.

#### Table 2-9. Fault Resilient Booting (Output Tri-State) Signals

Output Tri-State Signal Groups	Tri-State Signals
Intel® UPI	KTI{2:1}TX_DN/DP[19:0]
PCI Express*	PE_TX_DN[15:0] PE_TX_DP[15:0] PE_HP_SCL PE_HP_SDA
DDR4	Control, Address and DQ, DDR4 RESET_N asserted
DMI3	DMI_TX_DN[3:0] DMI_TX_DP[3:0]
SMBus (SPD)	DDR[012,345]_SPDSCL DDR[012,345]_SPDSDA
Processor Sideband	CATERR_N, ERROR_N[2:0], BPM_N[7:0], THERMTRIP_N, PROCHOT_N, PECI, PM_FAST_WAKE_N, MSMI_N, TSC_SYNC, FIVR_FAULT
SVID	SVIDCLK, SVIDDATA

## 2.4.1 Power-On Configuration (POC) Options

Several configuration options can be configured by hardware. The processor samples its hardware configuration at reset, on the active-to-inactive transition of RESET\_N, or upon assertion of PWRGOOD (inactive-to-active transition). For specifics on these options, please see the following table.

The sampled information configures the processor for subsequent operation. These configuration options cannot be changed except by another reset transition of the latching signal (RESET N or PWRGOOD).

Table 2-10. Power-On Configuration Option Lands (Sheet 1 of 2)

Configuration Option	Land Name	Notes
Output tri state	PROCDIS_N	1
Execute BIST (Built-In Self Test)	BIST_ENABLE	2
Enable Service Processor Boot Mode	BMCINIT	3
Power-up Sequence Halt	EAR_N	3
Enable Intel® Trusted Execution Technology (Intel® TXT) Platform	TXT_PLTEN	3
Enable Bootable Firmware Agent	FRMAGENT	3
Enable Intel Trusted Execution Technology (Intel TXT) Agent	TXT_AGENT	3



#### Table 2-10. Power-On Configuration Option Lands (Sheet 2 of 2)

Configuration Option	Land Name	Notes
Enable Safe Mode Boot	SAFE_MODE_BOOT	3
Configure Socket ID	SOCKET_ID[1:0]	3
Enable legacy socket boot	LEGACY_SKT	3

#### Notes:

- 1. Output tri-state option enables Fault Resilient Booting (FRB), for FRB details see the Fault Resilient Booting (FRB) Section. The signal used to latch PROCDIS\_N for enabling FRB mode is RESET\_N.
- 2. BIST\_ENABLE is sampled at RESET\_N de-assertion
- 3. This signal is sampled after PWRGOOD assertion.

## 2.5 Mixing Processors

Intel supports and validates two and four processor configurations only where all processors operate with the same Intel® UPI frequency, core frequency, power segment, and have the same internal cache sizes. Mixing components operating at different internal clock frequencies is not supported and will not be validated by Intel. Combining processors from different power segments is also not supported.

#### Note:

All processors within a system must run at a common maximum non-Turbo ratio. The system BIOS may be required to program the FLEX\_RATIO register if mixed frequency processors are populated.

Not all operating systems can support dual processors with mixed frequencies. Mixing processors of different steppings but the same model (as per CPUID instruction) is supported, provided there is no more than one stepping delta between the processors, for example, S and S+1.

S and S+1 is defined as mixing of two CPU steppings in the same platform where one CPU is S (stepping) = CPUID.(EAX=01h):EAX[3:0], and the other is S+1 = CPUID. (EAX=01h):EAX[3:0]+1. The stepping ID is found in EAX[3:0] after executing the CPUID instruction with Function 01h. Details regarding the CPUID instruction are provided in the Intel @ 64 and IA-32 Architectures Software Developer's Manuals, Volume 2A: Instruction Set Reference, A-M.

## 2.6 Flexible Motherboard Guidelines (FMB)

The Flexible Motherboard (FMB) guidelines are estimates of the maximum values the processor will have over certain time periods. The values are only estimates and actual specifications for future processors may differ. Processors may or may not have specifications equal to the FMB value in the foreseeable future. System designers should meet the FMB values to ensure their systems will be compatible with future processors.

## 2.7 Absolute Maximum and Minimum Ratings

The table below specifies absolute maximum and minimum ratings. At conditions outside functional operation condition limits, but within absolute maximum and minimum ratings, neither functionality nor long-term reliability can be expected. If a device is returned to conditions within functional operation limits after having been subjected to conditions outside these limits, but within the absolute maximum and



minimum ratings, the device may be functional, but with its lifetime degraded depending on exposure to conditions exceeding the functional operation condition limits.

Although the processor contains protective circuitry to resist damage from Electro-Static Discharge (ESD), precautions should always be taken to avoid high static voltages or electric fields.

#### Table 2-11. Processor Absolute Minimum and Maximum Ratings

Symbol	Parameter	Min	Max	Unit
VCCIN	Processor input voltage with respect to Vss	-0.3	2.15	V
Vccd	Processor IO supply voltage for DDR4 (standard voltage) with respect to Vss	-0.3	1.50	V
Vccio	IO voltage supply input with respect to Vss	-0.3	1.45	V
Vccsa	IO voltage supply input with respect to Vss	-0.3	1.45	V

#### Notes:

- 1. For functional operation, all processor electrical, signal quality, mechanical, and thermal specifications must be satisfied.
- Overshoot and undershoot voltage guidelines for input, output, and I/O signals are outlined in Section 2.10.5, "Overshoot/Undershoot Tolerance." Excessive Overshoot or undershoot on any signal will likely result in permanent damage to the processor.

### 2.7.1 Storage Conditions Specifications

Environmental storage condition limits define the temperature and relative humidity limits to which the device is exposed to while being stored in a Moisture Barrier Bag. The specified storage conditions are for component level prior to board attach (see notes in the following table for post board attach limits).

The table below specifies absolute maximum and minimum storage temperature limits which represent the maximum or minimum device condition beyond which damage, latent or otherwise, may occur. The table also specifies sustained storage temperature, relative humidity, and time-duration limits. These limits specify the maximum or minimum device storage conditions for a sustained period of time. At conditions outside sustained limits, but within absolute maximum and minimum ratings, quality and reliability may be affected.

Table 2-12. Storage Condition Ratings

Symbol	Parameter	Min	Max	Unit
Tabsolute storage	The minimum/maximum device storage temperature beyond which damage (latent or otherwise) may occur when subjected to for any length of time.	-25	125	°C
Tsustained storage	The minimum/maximum device storage temperature for a sustained period of time.	-5	40	°C
Tshort term storage	The ambient storage temperature (in shipping media) for a short period of time.	-20	85	°C
RHsustained storage	The maximum device storage relative humidity for a sustained period of time. Unopened bag, includes 6 months storage time by customer.	60% @ 24		°C
Timeshort term storage	A short period of time (in shipping media).	0	72	hours



#### Notes:

- Storage conditions are applicable to storage environments only. In this scenario, the processor must not
  receive a clock, and no lands can be connected to a voltage bias. Storage within these limits will not affect
  the long-term reliability of the device. For functional operation, please refer to the processor case
  temperature specifications.
- 2. These ratings apply to the Intel component and do not include the tray or packaging.
- 3. Failure to adhere to this specification can affect the long-term reliability of the processor.
- Non-operating storage limits post board attach: Storage condition limits for the component once attached to the application board are not specified. Intel does not conduct component level certification assessments post board attach given the multitude of attach methods, socket types and board types used by customers. Provided as general guidance only, Intel board products are specified and certified to meet the following temperature and humidity limits (Non-Operating Temperature Limit: -40C to 70C & Humidity: 50% to 90%, non condensing with a maximum wet bulb of 28°C).
   Device storage temperature qualification methods follow JEDEC High and Low Temperature Storage Life
- Device storage temperature qualification methods follow JEDEC High and Low Temperature Storage Life Standards: JESD22-A119 (low temperature) and JESD22-A103 (high temperature).

## 2.8 DC Specifications

#### DC specifications are defined at the processor pads, unless otherwise noted.

DC specifications are only valid while meeting specifications for case temperature (TCASE specified in the Second Generation Intel® Xeon® Scalable Processors Thermal/Mechanical Specification and Design Guide (TMSDG)), clock frequency, and input voltages. Care should be taken to read all notes associated with each specification.

### 2.8.1 Voltage and Current Specifications

Table 2-13. Voltage Specification (Sheet 1 of 2)

Symbols	Parameter	Voltage Plane	Min	Nom	Max	Unit	Notes <sub>1</sub>
Vccin	Input to Integrated Voltage Regulator (Launch - FMB)	Vccin	= VID - RII*Iout- 0.022V	= VID - RII*Iout	= VID - Rll*Iout+0.022V	V	2, 3, 4, 5, 8, 12
VCCIN VID Range		VCCIN	1.60	1.80	1.83	v	2, 3, 4, 5, 8, 12
VVID_STEP (VCCIN)	VID step size during a transition	Vccin		10.0		mV	6
VVID_STEP (VCCD)	VID step size during a transition		5		10	mV	
V CCD (V CCD_012, V CCD_345)	I/O Voltage for DDR4 (Standard Voltage)	Vccd	1.17	1.2	1.26	V	7, 9, 10, 11
VccSA	Power supply for Intel® UPI and IIO	VccSA	VID - 0.111	VID	VID + 0.100	V	



Table 2-13. Voltage Specification (Sheet 2 of 2)

Symbols	Parameter	Voltage Plane	Min	Nom	Max	Unit	Notes <sub>1</sub>
VCCSA VID Range			0.5	0.85	1.1	V	
Vccio	IO voltage supply input		0.937	1.00	1.057	V	
Vcc33	Power supply for PIROM		3.14	3.3	3.47	V	
CD_VCC_CO RE			0.814	0.9	0.974	V	

#### Notes:

- 1. Unless otherwise noted, all specifications in this table apply to all processors. These specifications are based on pre-silicon characterization and will be updated as further data becomes available.
- 2. These voltages are targets only. A variable voltage source should exist on systems in the event that a different voltage is required.
- 3. The VCCIN voltage specification requirements are measured across the remote sense pin pairs (VCCIN\_SENSE and VSS\_VCCIN\_SENSE) on the processor package. Voltage measurement should be taken with a DC to 100 MHz bandwidth oscilloscope limit (or DC to 20 MHz for older model oscilloscopes), using a 1.5 pF maximum probe capacitance, and 1 Mohm minimum impedance. The maximum length of the ground wire on the probe should be less than 5 mm to ensure external noise from the system is not coupled in the scope probe.
- 4. Refer to VCCIN Static and Transient Tolerance Second Generation Intel® Xeon® Scalable Processors and corresponding Figure 2-3, "VCCIN Static and Transient Tolerance Load Lines 1.0 mOHM." The processor should not be subjected to any static VCCIN level that exceeds the VCCIN\_MAX associated with any particular current. Failure to adhere to this specification can shorten processor lifetime.
- 5. Minimum VCCIN and maximum ICCIN are specified at the maximum processor case temperature (TCASE) shown in the Second Generation Intel® Xeon® Scalable Processorsr Thermal/Mechanical Specification and Design Guide (TMSDG). ICCIN\_MAX is specified at the relative VCC\_MAX point on the VCCIN load line. The processor is capable of drawing ICCIN\_MAX for up to 2 ms.
- 6. This specification represents the VCCIN reduction or VCCIN increase due to each VID transition. For Voltage Identification (VID) see Table 2-4, "VR13.0 Reference Code VCCIN Voltage Identification (VID)."
- 7. Baseboard bandwidth is limited to 20 MHz.
- 8. FMB is the flexible motherboard guidelines. See Section 2.4, "Fault Resilient Booting (FRB)" for details.
- 9. DC + AC + Ripple = Tolerance
- 10. VCCD tolerance at processor pins. Required in order to meet ±5% tolerance at processor die.
- 11. The VCCD012, VCCD345 voltage specification requirements are measured across vias on the platform. Choose VCCD012 or VCCD345 vias close to the socket and measure with a DC to 100 MHz bandwidth oscilloscope limit (or DC to 20 MHz for older model oscilloscopes), using 1.5 pF maximum probe capacitance, and 1M ohm minimum impedance. The maximum length of the ground wire on the probe should be less than 5 mm to ensure external noise from the system is not coupled in the scope probe.
- VCCIN has a Vboot setting of 1.7 V and is not included in the PWRGOOD indication. Refer to the VR13.0 PWM Server VR Vendor PWM Enabling Specification.

Table 2-14. Current (ICCIN\_MAX and ICCIN\_TDC) Specification (Sheet 1 of 2)

TDP (W)	205	200	165	150	145	140	135	130	125	120	115	105	85	70
Segment		Single Die Package												
VCCIN ICCMAX (A)	228	228	228	205	205	190	190	177	160	160	154	132	102	85
VCCSA ICCMAX (A)	16	16	16	16	16	16	16	16	16	16	16	16	16	16
VCCIO ICCMAX (A)	21	21	21	21	21	21	21	21	21	21	21	21	21	21
VCCD ICCMAX (A)	8	8	8	8	8	8	8	8	8	8	8	8	8	8
VCC33 ICCMAX(A)	.075	.075	.075	.075	.075	.075	.075	.075	.075	.075	.075	.075	.075	.075
VCCIN TDC (A)	112	112	89	80	77	73	70	68	65	62	54	54	42	33
VCCSA TDC (A)	15	15	15	15	15	15	15	15	15	15	15	15	15	15
VCCIO TDC (A)	14	14	14	14	14	14	14	14	14	14	14	14	14	14
VCCD TDC (A)	6	6	6	6	6	6	6	6	6	6	6	6	6	6
VCC33 TDC (A)	.075	.075	.075	.075	.075	.075	.075	.075	.075	.075	.075	.075	.075	.075
Pmax Package (W)	413	413	363	319	319	297	297	286	264	264	253	231	187	154



Table 2-14. Current (ICCIN\_MAX and ICCIN\_TDC) Specification (Sheet 2 of 2)

TDP (W)	165	160	145	135	120	105	85					
Segment							Fab	ric				
VCCIN ICCMAX (A)	228	221	205	190	160	132	102					
VCCSA ICCMAX (A)	16	16	16	16	16	16	16					
VCCIO ICCMAX (A)	21	21	21	21	21	21	21					
VCCD ICCMAX (A)	8	8	8	8	8	8	8					
VCC33 ICCMAX(A)	.075	.075	.075	.075	.075	.075	.075					
VCCIN TDC (A)	89	86	77	70	62	54	42					
VCCSA TDC (A)	15	15	15	15	15	15	15					
VCCIO TDC (A)	14	14	14	14	14	14	14					
VCCD TDC (A)	6	6	6	6	6	6	6					
VCC33 TDC (A)	.075	.075	.075	.075	.075	.075	.075					
Pmax Package (W)	363	352	319	297	264	231	187					
CD_VCC_CORE ICCMAX (A)								10				
CD_VCCIN ICCMAX (A)								.01				
CD_VCCP ICCMAX (A)								.015				
CD_VPP ICCMAX (A)								7				
CD_VCC_CORE TDC (A)								9				
CD_VCCIN TDC (A)				.01								
CD_VCCP TDC (A)				.01								
CD_VPP TDC (A)								6				

- Unless otherwise noted, all specifications in this table apply to all processors. These specifications are based on pre-silicon characterization and will be updated as further data becomes available. FMB is the flexible motherboard guidelines. See Section 2.6, "Flexible Motherboard Guidelines (FMB)" for
- further details.
- ICCIN\_TDC (Thermal Design Current) is the sustained (DC equivalent) current that the processor is capable of drawing indefinitely and should be used for the voltage regulator thermal assessment. The voltage regulator is responsible for monitoring its temperature and asserting the necessary signal to inform the processor of a thermal excursion. Please refer to the VR13.0 PWM Server VR Vendor PWM Enabling Specification for further details.
- specification for further details. Minimum VCCIN and maximum ICCIN are specified at the maximum processor case temperature (TCASE) shown in the VR13.0 PWM Server VR Vendor PWM Enabling Specification for further details. ICCIN\_MAX is specified at the relative VCCIN\_MAX point on the VCCIN load line. The processor is capable of drawing ICCIN\_MAX for up to 2 ms.
- Values on this table correspond to SKT-P.

Table 2-15. VCCIN Static and Transient Tolerance for 0.9LL (Sheet 1 of 2)

ICCIN (A)	VCCIN_Max (V)	VCCIN_Nom (V)	VCCIN_Min (V)	Notes
0	VID +0.022	VID -0.000	VID -0.022	
10	VID +0.013	VID -0.009	VID -0.031	
20	VID +0.004	VID -0.018	VID -0.040	
30	VID -0.005	VID -0.027	VID -0.049	
40	VID -0.014	VID -0.036	VID -0.058	
50	VID -0.023	VID -0.045	VID -0.067	
60	VID -0.032	VID -0.054	VID -0.076	



Table 2-15. VCCIN Static and Transient Tolerance for 0.9LL (Sheet 2 of 2)

Iccin (A)	VCCIN_Max (V)	VCCIN_Nom (V)	VCCIN_Min (V)	Notes
70	VID -0.041	VID -0.063	VID -0.085	
80	VID -0.050	VID -0.072	VID -0.094	
90	VID -0.059	VID -0.081	VID -0.103	
100	VID -0.068	VID -0.090	VID -0.112	
110	VID -0.077	VID -0.099	VID -0.121	
120	VID -0.086	VID -0.108	VID -0.130	
130	VID -0.095	VID -0.117	VID -0.139	
140	VID -0.104	VID -0.126	VID -0.148	
150	VID -0.113	VID -0.135	VID -0.157	
160	VID -0.122	VID -0.144	VID -0.166	
170	VID -0.131	VID -0.153	VID -0.175	
180	VID -0.140	VID -0.162	VID -0.184	
190	VID -0.149	VID -0.171	VID -0.193	
200	VID -0.158	VID -0.180	VID -0.202	
210	VID -0.167	VID -0.189	VID -0.211	
220	VID -0.176	VID -0.198	VID -0.220	
230	VID -0.185	VID -0.207	VID -0.229	

- The Vccin\_min and Vccin\_max loadlines represent static and transient limits. Please see for Section 2.8.2.1, "VCCIN Overshoot Specifications."
- 2. This table is intended to aid in reading discrete points on graph in Figure 2-2, "VCCIN Static and Transient Tolerance Load Lines 0.9 mOHM."
- 3. The loadlines specify voltage limits at the die measured at the Vccin\_sense and Vss\_vccin\_sense lands. Voltage regulation feedback for voltage regulator circuits must also be taken from processor Vccin\_sense and Vss\_vccin\_sense lands. Refer to the VR13.0 PWM Server VR Vendor PWM Enabling Specification for loadline guidelines and VR implementation details.

Table 2-16. VCCIN Static and Transient Tolerance for 1.0LL (Sheet 1 of 2)

ICCIN (A)	VCCIN_Max (V)	VCCIN_Nom (V)	VCCIN_Min (V)	Notes
0	VID +0.022	VID -0.000	VID -0.022	
10	VID +0.012	VID -0.010	VID -0.032	
20	VID +0.002	VID -0.020	VID -0.042	
30	VID -0.008	VID -0.030	VID -0.052	
40	VID -0.018	VID -0.040	VID -0.062	
50	VID -0.028	VID -0.050	VID -0.072	
60	VID -0.038	VID -0.060	VID -0.082	
70	VID -0.048	VID -0.070	VID -0.092	
80	VID -0.058	VID -0.080	VID -0.102	
90	VID -0.068	VID -0.090	VID -0.112	
100	VID -0.078	VID -0.100	VID -0.122	
110	VID -0.088	VID -0.110	VID -0.132	



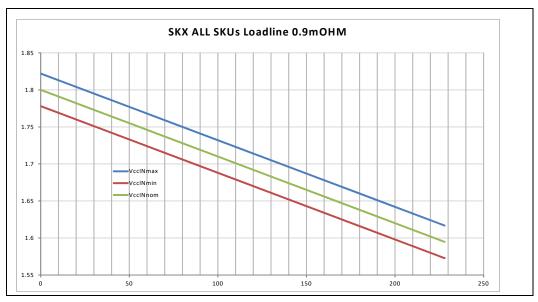
Table 2-16. VCCIN Static and Transient Tolerance for 1.0LL (Sheet 2 of 2)

ICCIN (A)	VCCIN_Max (V)	VCCIN_Nom (V)	VCCIN_Min (V)	Notes
120	VID -0.098	VID -0.120	VID -0.142	
130	VID -0.108	VID -0.130	VID -0.152	
140	VID -0.118	VID -0.140	VID -0.162	
150	VID -0.128	VID -0.150	VID -0.172	
160	VID -0.138	VID -0.160	VID -0.182	
170	VID -0.148	VID -0.170	VID -0.192	
180	VID -0.158	VID -0.180	VID -0.202	
190	VID -0.168	VID -0.190	VID -0.212	
200	VID -0.178	VID -0.200	VID -0.222	
210	VID -0.188	VID -0.210	VID -0.232	
220	VID -0.198	VID -0.220	VID -0.242	
230	VID - 0.208	VID - 0.230	VID - 0.252	

- The Vccin\_min and Vccin\_max loadlines represent static and transient limits. Please see Section 2.8.2.1, "VCCIN Overshoot Specifications."
- This table is intended to aid in reading discrete points on graph in Figure 2-3, "VCCIN Static and Transient Tolerance Load Lines 1.0 mOHM."
- The loadlines specify voltage limits at the die measured at the Vccin\_sense and Vss\_vccin\_sense lands. Voltage regulation feedback for voltage regulator circuits must also be taken from processor VCCIN\_SENSE and Vss\_vccin\_sense lands. Refer to the VR13.0 PWM Server VR Vendor PWM Enabling Specification for loadline guidelines and VR implementation details.

  The Adaptive Loadline Positioning slope is 1.00 m? (mohm) with ±22mV TOB (Tolerance of Band).

Figure 2-2. VCCIN Static and Transient Tolerance Load Lines 0.9 mOHM





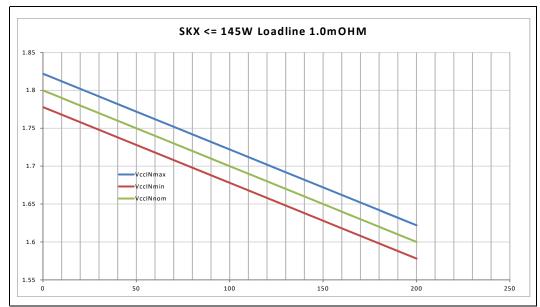


Figure 2-3. VCCIN Static and Transient Tolerance Load Lines 1.0 mOHM

## 2.8.2 Die Voltage Validation

Overshoot events at the processor must meet the specifications in Table 2-17, "VCCIN Overshoot Specifications" when measured across the VCCIN\_SENSE and VSS\_VCCIN\_SENSE lands. Overshoot events that are < 10 ns in duration may be ignored. These measurements of processor die level overshoot should be taken with a 100 MHz bandwidth limited oscilloscope.

### 2.8.2.1 VCCIN Overshoot Specifications

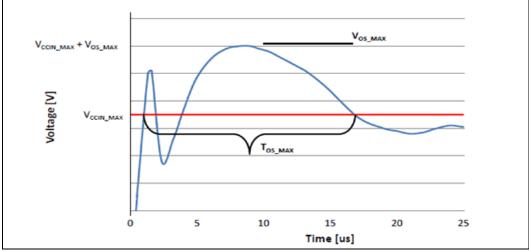
The processor can tolerate short transient overshoot events where V<sub>CCIN</sub> exceeds the VID voltage when transitioning from a high-to-low current load condition. This overshoot cannot exceed VID + Vos\_Max (Vos\_Max is the maximum allowable overshoot above VID). These specifications apply to the processor die voltage as measured across the V<sub>CCIN\_SENSE</sub> and V<sub>SS\_VCCIN\_SENSE</sub> lands. The processor can tolerate overshoot to phase added bumps as well.

**Table 2-17. VCCIN Overshoot Specifications** 

Symbol	Parameter	Min	Max	Units	Figure	Notes
Vos_max	Magnitude of Vccin overshoot above VID		92 from VID, 70 from VccMAX	mV	Figure 2-4	
Tos_max	Time duration of Vccin overshoot above Vccin_Max value at the new lighter load		25	μs	Figure 2-4	



Figure 2-4. VCCIN Overshoot Example Waveform



- VOS\_MAX is the measured overshoot voltage above VCCIN\_MAX.
- TOS\_MAX is the measured time duration above VCCIN\_MAX. VCCIN\_MAX = VID + TOB

### 2.8.3 **Signal DC Specifications**

For additional specifications, refer to Section 1.2, "Related Publications."

### 2.8.3.1 **DDR4 Signal DC Specifications**

For the next table please use Signal Group Table 2-7, "Signal Groups" to identify which signals belong to each group.

Symbol	Parameter	Min	Nom	Max	Units	Notes1			
IIL	Input Leakage Current	-1.4		+1.4	mA	9			
Data Signals									
Ron	DDR4 Data Buffer On Resistance	25.5	30	34.5	ohm	6			
Data ODT	On-Die Termination for Data Signals	42.5	50	57.5	ohm	8			
Reference Clock	Reference Clock and Command Signals								
VoL	Output Low Voltage		(V CCD / 2)* (R ON /(R ON +R VTT_TERM ))		v	2, 7			
Vон	Output High Voltage		V CCD - ((V CCD / 2)* (R ON /(R ON +R VTT_TERM )))		v	2, 5, 7			
Data Signals									
Vol	Output Low Voltage		Vol=(Ron / (Ron + RVDD_TERM)) *VCCD			10			
Vон	Output High Voltage		Vccd						



Symbol	Parameter	Min	Nom	Max	Units	Notes1
Reference Clock	Signal					
R on	DDR4 Clock Buffer On Resistance	25.5	30	34.5	ohm	6
<b>Command Signa</b>	ls			-		•
R on	DDR4 Command Buffer On Resistance	15.3	18	20.7	ohm	6,11
R on	DDR4 Reset Buffer On Resistance	76.5	90	103.5	ohm	6
Vol_cmos1.2V	Output Low Voltage, Signals DDR_RESET_C{01/23}_N			0.2*V <sub>CCD</sub>	V	1, 2
V OH_CMOS1.2V	Output High Voltage, Signals DDR_RESET_C{01/23}_N	0.9*V <sub>CCD</sub>			V	1, 2
<b>Control Signals</b>						
Ron	DDR4 Control Buffer On Resistance	25.5	30	34.5	ohm	6
DDR4 Miscellane	eous Signals	•		•	•	•
DRAM_PWR_OK_C	C{01/23}					
V <sub>IL</sub>	Input Low Voltage		0.3*VCCD		mV	2, 3
VIH	Input High Voltage		0.7*VCCD		mV	2, 4, 5
ALERT_N						
V <sub>IL</sub>	Input Low Voltage	Vref-90		Vref - 70	mV	3
VIH	Input High Voltage	Vref+70		Vref+90	mV	4
ODT	On Die Termination	36	45	54	ohms	

- Unless otherwise noted, all specifications in this table apply to all processor frequencies.
  The voltage rail V<sub>CCD</sub> which will be set to 1.2 V nominal depending on the voltage of all DIMMs connected to the processor.
- VIL is the maximum voltage level at a receiving agent that will be interpreted as a logical low value.
- VIH is the minimum voltage level at a receiving agent that will be interpreted as a logical high value.
- VIH and VOH may experience excursions above VCCD. However, input signal drivers must comply with the signal quality specifications. Refer to Section 2.10, "Signal Quality."

  This is the pull down driver resistance. Refer to processor signal integrity models for I/V characteristics. Reset drive does not
- RVIT\_TERM is the termination on the DIMM and not controlled by the processor. Please refer to the applicable DIMM datasheet.
- The minimum and maximum values for these signals are programmable by BIOS to one of the pairs.
- Input leakage current is specified for all DDR4 signals.
- Vol = Ron \* [VCCD/(Ron + Rtt\_Eff)], where Rtt\_Eff is the effective pull-up resistance of all DIMMs in the system, including ODTs and series resistors on the DIMMs.
- This Ron value is only for UDIMM, otherwise the Ron Value is 30 ohm.

### 2.8.3.2 **PECI DC Specifications**

Symbol	Definition and Conditions	Min	Max	Units	Figure	Notes <sub>1</sub>
VIn	Input Voltage Range	-0.15	0.15 + Vccio	V		1
VHysteresis	Hysteresis	0.1*Vccio		V		
Vn	Negative-edge threshold voltage	0.275*Vccio	0.500*Vccio	V	Figure 2-1	2
VP	Positive-edge threshold voltage	0.550*Vccio	0.725*Vccio	V	Figure 2-1	2
I Source	Pullup Resistance (Vон = 0.75*Vccio)	-6.00		mA		



Symbol	Definition and Conditions	Min	Max	Units	Figure	Notes <sub>1</sub>
I <sub>Leak+</sub>	High impedance state leakage to Vccio (Vleak = Vol.)	±50	±200	μΑ		3, 4
Ron	High impedance leakage to GND (Vleak = VoH)	41	11	ohm		
C <sub>Bus</sub>	Bus capacitance per node		10	pF		5
VNoise	Signal noise immunity above 300 MHz	0.100*Vccio		V <sub>p-p</sub>		
	Output Edge Rate (50 ohm to Vss, between V <sub>IL</sub> and V <sub>IH</sub> )	5	15	V/ns		

- The input voltage range specifies an overshoot/undershoot that applies only to the PECI data signal and not to the VTTreference itself.
- It is expected that the PECI driver will take into account, the variance in the receiver input thresholds and consequently, be able to drive its output within safe limits (-0.150 V to 0.275\*Vccio for the low level and 0.725\*Vccio to Vccio+0.150 V for the high level).
- VccIo nominal levels will vary between processor families. All PECI devices will operate at the VccIo level determined by the processor installed in the system.
- The leakage specification applies to powered devices on the PECI bus.
- Excessive capacitive loading on the PECI line may slow down the signal rise/fall times and consequently limit the maximum bit rate at which the interface can operate.

### System Reference Clock (BCLK{0/1/2}) DC Specifications 2.8.3.3

Symbol	Parameter	Signal	Min	Max	Unit	Figure	Notes <sub>1</sub>
VBCLK_diff_ih	Differential Input High Voltage	Differential	0.150	N/A	V	Figure 2-5	9
VBCLK_diff_il	Differential Input Low Voltage	Differential		-0.150	V	Figure 2-5	9
Vcross (abs)	Absolute Crossing Point	Single Ended	0.250	0.550	V	Figure 2-6 and Figure 2-7	2, 4, 7, 9
V <sub>cross</sub> (rel)	Relative Crossing Point	Single Ended	0.250 + 0.5* (VH <sub>avg</sub> - 0.700)	0.550 + 0.5*(Vavg - 0.700)	V	Figure 2-6	3, 4, 5, 9
Vcross	Range of Crossing Points	Single Ended	N/A	0.140	V	Figure 2-8	6, 9
Vтн	Threshold Voltage	Single Ended	Vcross - 0.1	Vcross + 0.1	V		9
I <sub>IL</sub>	Input Leakage	N/A		1.50	mA		8, 9
C <sub>pad</sub>	Pad Capacitance	N/A	1.90	1.72	pF		9

- Unless otherwise noted, all specifications in this table apply to all processor frequencies.
- Crossing Voltage is defined as the instantaneous voltage value when the rising edge of BCLK{0/1}\_DN is equal to the falling edge of BCLK{0/1}\_DP.
- V<sub>Havg</sub> is the statistical average of the VH measured by the oscilloscope.
- The crossing point must meet the absolute and relative crossing point specifications simultaneously. VHavg can be measured directly using "Vtop" on Agilent\* and "High" on Tektronix oscilloscopes.
- Various is defined as the total variation of all crossing voltages as defined in Note 3. The rising edge of BCLK $\{0/1\}$ \_DN is equal to the falling edge of BCLK $\{0/1\}$ \_DP.
- For Vin between 0 and Vih.
- Specifications can be validated at the pin.



Figure 2-5. BCLK{0/1/2} Differential Clock Measurement Point for Ringback

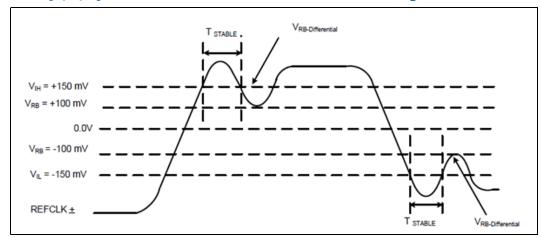


Figure 2-6. BCLK{0/1/2} Differential Clock Crosspoint Specification

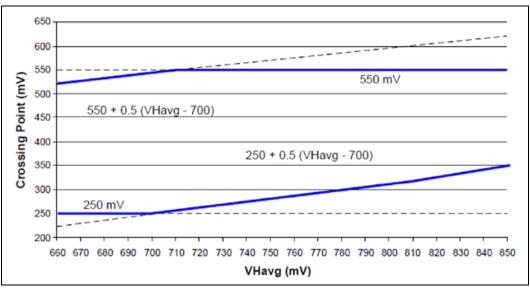
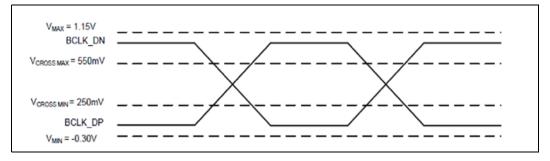


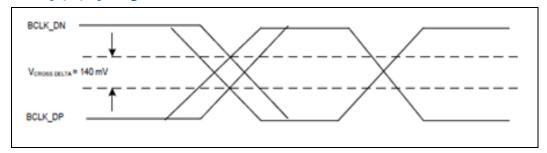
Figure 2-7. BCLK{0/1/2} Single Ended Clock Measurement Points for Absolute Cross Point and Swing



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Figure 2-8. BCLK{0/1/2} Single Ended Clock Measure Points for Delta Cross Point



### **SMBus DC Specifications** 2.8.3.4

Symbol	Parameter	Min	Max	Units	Notes
VIL	Input Low Voltage		0.3*Vccio	V	
V IH	Input High Voltage	0.7*Vccio		V	
V <sub>Hysteresis</sub>	Hysteresis	0.1*Vccio		V	
V ol	Output Low Voltage		0.2*Vccio	V	1
R on	Buffer On Resistance	14	4	ohm	
IL	Leakage Current Signals	±50	±200	μΑ	
	Output Edge Rate (50 ohm to Vccio, between Vil and Vih)	1.13	5	V/ns	1

Value obtained through test bench with 50 ohm pull up to Vccio.

### **JTAG and TAP Signals DC Specifications** 2.8.3.5

Symbol	Parameter	Min	Max	Units	Notes
V <sub>IL</sub>	Input Low Voltage		0.3*Vccio	٧	
VIH	Input High Voltage	0.7*Vccio		٧	
VoL	Output Low Voltage		0.2*Vccio	٧	
V <sub>Hysteresis</sub>	Hysteresis	0.1*Vccio			
SR	Input Slew Rate: TCK0, TCK1, BPM_N[7:0],TDI	0.05		V/ns	2
Ron	Buffer On Resistance Signals BPM_N[7:0], TDO	14	4	ohm	
I <sub>IL</sub>	Input Leakage Current Signals	±50	±200	μΑ	
SR	Output Edge Rate (50 ohm to Vccio) Signal: BPM_N[7:0], PRDY_N, TDO	1.13	5	V/ns	1

- These are measured between V<sub>IL</sub> and V<sub>IH</sub>.

  The signal edge rate must be met or the signal must transition monotonically to the asserted state.



### **Serial VID Interface (SVID) DC Specifications** 2.8.3.6

Symbol	Parameter	Min	Nom	Max	Units	Notes
Vccio	CPU I/O Voltage	Vccio - 5%	1.0	Vccio + 5%	V	1
V IL	Input Low Voltage Signals SVIDDATA, SVIDALERT_N			0.3*Vccio	٧	1
V <sub>IH</sub>	Input High Voltage Signals SVIDDATA, SVIDALERT_N	0.7*Vccio			٧	1
VoL	Output Low Voltage Signals: SVIDCLK, SVIDDATA			0.2*Vccio	٧	1, 6
V <sub>Hysteresis</sub>	Hysteresis	0.1*V <sub>CCIO</sub>			٧	1
Ron	Buffer On Resistance Signals SVIDCLK, SVIDDATA	14		4	ohm	2
I IL	Input Leakage Current	±50		±200	μΑ	3,4
	Input Edge Rate Signal: SVIDALERT_N	0.05			V/ns	5
	Output Edge Rate	1.13		5	V/ns	5, 6

- Vccio refers to instantaneous Vccio.
- Measured at 0.31\*Vccio.
- Vin between 0V and Vccio (applies to SVIDDATA and SVIDALERT\_N only).
- These are measured between V<sub>II</sub> and V<sub>IH</sub>.
  Value obtained through test bench with 50? pull up to Vccio.

### **Processor Asynchronous Sideband DC Specifications** 2.8.3.7

Symbol	Parameter	Min	Max	Units	Notes
CMOS Outp	ut Buffers				
I <sub>IL</sub>	Input Leakage Current	±50	±200	μΑ	1,2,4
VoL	Low Output Voltage		0.2*Vccio	V	1,2,4
Vон	High Output Voltage	0.9*Vccio		V	1,2,4
R <sub>PD</sub>	Pull down Resistance		50	ohm	1,2,4
Rpu	Pull up Resistance		50	ohm	1,2,4
SR	Output Edge Rate	0.8	3	V/ns	
CMOS Input	t Buffers		•		
VIL	Input Low Voltage		0.3*Vccio	V	1, 2,4
V <sub>IH</sub>	Input High Voltage	0.7*Vccio		V	1, 2,4
VHysteresis	Hysteresis Signals	0.1*Vccio		V	1,2,4
SRI	Input Slew Rate	0.005		V/ns	
SR <sub>2</sub>	Input Slew Rate: PMSYNC	0.05		V/ns	
Open Drain	Output Buffers				
IL	Input Leakage Current	±50	±200	μA	1,2,4
Ron	Buffer On Resistance	14	4	ohm	1, 2,4
SR	Output Edge Rate	1.13	5	V/ns	3,5

- This table applies to processor sideband and miscellaneous signals specified in Table 2-7, "Signal Groups." Unless otherwise noted, all specifications in this table apply to all processor frequencies.
- These are measured between  $V_{\text{IL}}$  and  $V_{\text{IH}}.$
- In the case of bidirectional signals they use either a CMOS output /CMOS input buffer or they use Open 4. Drain / CMOS input buffer.
- VOL level for open drain buffers may be obtained with the Buffer ON Resistance and the external 50 ohm pull up to VCCIO.



### 2.8.3.8 **Miscellaneous Signals DC Specifications**

Symbol	Parameter	Min	Nominal	Max	Units
SKTOCC_N Signal					
Vo_abs_max	Output Absolute Max Voltage		3.30	3.50	V
Іомах	OMAX Output Max Current			1	mA

## Intel® Omni-Path Host Fabric Interface (Intel® OP HFI) DC Specifications 2.8.3.9

Symbol	Parameter	Min	Max	Units	Notes	
CMOS 2.5V Inputs						
VIL	Input Low Voltage		0.7	V		
VIH	Input High Voltage	1.7		V		
CMOS 1.8V	Inputs		•			
VIL	Input Low Voltage		0.63	V		
VIH	Input High Voltage	1.17		V		
Open Drain	2.5 Output		•			
IL	Input Leakage Current	±50	±200	uA		
Ron	Buffer On Resistance	32	20	ohm		
CMOS 1.8 O	utput					
VoL	Low Output Voltage		0.45	V		
Vон	High Output Voltage	1.3		V		
RPD	Pull down Resistance	32	20	ohm		
R <sub>PU</sub>	Pull up Resistance:	32	20	ohm		

### 2.9 **Package C-State Power Specifications**

The table below lists the processor package C-state power specifications for the various processor SKUs.

Die Type	C6 (W)
XCC	13
нсс	12
LCC	12

- SKUs are subject to change. Please contact your Intel Field Representative to obtain the latest SKU information.
   Package C6 power specified at Tcase = 50°C.



## 2.10 Signal Quality

Data transfer requires the clean reception of data signals and clock signals. Ringing below receiver thresholds, non-monotonic signal edges, and excessive voltage swings will adversely affect system timings. Ringback and signal non-monotonicity cannot be tolerated since these phenomena may inadvertently advance receiver state machines. Excessive signal swings (overshoot and undershoot) are detrimental to silicon gate oxide integrity, and can cause device failure if absolute voltage limits are exceeded.

Overshoot and undershoot can also cause timing degradation due to the build up of inter-symbol interference (ISI) effects.

For these reasons, it is crucial that the designer work towards a solution that provides acceptable signal quality across all systematic variations encountered in volume manufacturing.

This section documents signal quality metrics used to derive topology and routing guidelines through simulation. All specifications are specified at the processor die (pad measurements).

Specifications for signal quality are for measurements at the processor core only and are only observable through simulation. Therefore, proper simulation is the only way to verify proper timing and signal quality.

## 2.10.1 DDR Signal Quality Specifications

Various scenarios for the DDR Signals have been simulated to generate a set of layout guidelines.

Overshoot (or undershoot) is the absolute value of the maximum voltage above or below VSS. The overshoot/undershoot specifications limit transitions beyond specified maximum voltages or VSS due to the fast signal edge rates. The processor can be damaged by single and/or repeated overshoot or undershoot events on any input, output, or I/O buffer if the charge is large enough (i.e., if the over/undershoot is great enough). Baseboard designs which meet signal integrity and timing requirements and which do not exceed the maximum overshoot or undershoot limits listed in Table 2-18, "Processor I/O Overshoot/Undershoot Specifications" ensure reliable IO performance for the lifetime of the processor.

## **2.10.2 PCIe Signal Quality Specifications**

Signal Quality specifications for PCIe Signals are included as part of the PCIe DC specifications and PCIe AC specifications. Various scenarios have been simulated to generate a set of layout guidelines.

# 2.10.3 Intel® Ultra Path Interconnect (Intel® UPI) Signal Quality Specifications

Signal Quality specifications for Differential Intel® UPI Signals are included as part of the Intel® UPI defined in the Intel® Ultra Path Interconnect (Intel® UPI) Specifications.



## 2.10.4 Input Reference Clock Signal Quality Specifications

Overshoot/Undershoot and Ringback specifications for BCLK{0/1}\_D[N/P] are found in Table 2-18, "Processor I/O Overshoot/Undershoot Specifications." Overshoot/ Undershoot and Ringback specifications for the DDR4 Reference Clocks are specified by the DIMM manufacturer.

## 2.10.5 Overshoot/Undershoot Tolerance

Overshoot (or undershoot) is the absolute value of the maximum voltage above or below VSS, see Figure 2-9, "Maximum Acceptable Overshoot/Undershoot Waveform." The overshoot/undershoot specifications limit transitions beyond VCCD or VSS due to the fast signal edge rates. The processor can be damaged by single and/or repeated overshoot or undershoot events on any input, output, or I/O buffer if the charge is large enough (i.e., if the over/undershoot is great enough). Baseboard designs which meet signal integrity and timing requirements and which do not exceed the maximum overshoot or undershoot limits listed in the following table will insure reliable IO performance for the lifetime of the processor.

Table 2-18. Processor I/O Overshoot/Undershoot Specifications

Signal Group	Maximum Undershoot	Maximum Overshoot	Overshoot Duration	Undershoot Duration	Notes
DDR4	-0.22*Vccb	1.22*Vccb	0.25*Тсн	0.1*T <sub>CH</sub>	1,2,3,5
Processor Asynchronous Sideband Signals, SVID, miscellaneous and JTAG/Tap Signals	-0.35*Vccio	1.35*Vccio	1.25ns	0.5ns	1,2,5
System Reference Clock (BCLK{0/1/2})	-0.15V	1.15V	N/A	N/A	1,2,5
PWRGOOD Signal	-0.42V	Vccio + 0.28 V	5ns	5ns	1,2,4
PMSYNC Signal	-0.35*Vccio	1.35*Vccio	5ns	5ns	1,2
PMSYNC_CLK Signal	-0.3V	1.35V	5ns	5ns	1,2
PECI Signal	-0.35V	1.35V	5ns	5ns	1,2
SVIDDATA Signal	-0.3V	1.3V	10ns	10ns	1,2

- These specifications are computer simulated at the processor pad (inside the CPU package).
- 2. Refer to Figure 2-9, "Maximum Acceptable Overshoot/Undershoot Waveform" for description of allowable Overshoot/Undershoot magnitude and duration.
- 3. Tch is the minimum high pulse width duration.
- 4. For PWRGOOD DC specifications see Section 2.8.3.7, "Processor Asynchronous Sideband DC Specifications"
- 5. Refer to Table 2-7, "Signal Groups" for a list of signals under the different signal groups, except for the signals that are explicitly listed on this table.



### 2.10.5.1 Overshoot/Undershoot Magnitude

Magnitude describes the maximum potential difference between a signal and its voltage reference level. For the processor, both are referenced to VSS. It is important to note that the overshoot and undershoot conditions are separate and their impact must be determined independently.

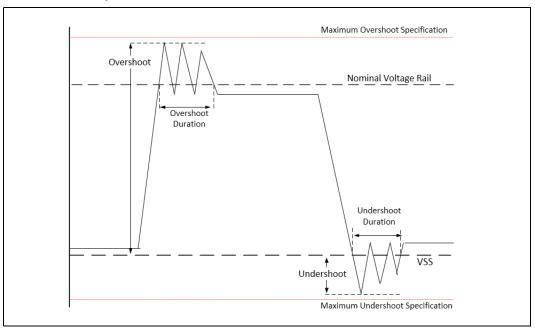
### 2.10.5.2 Overshoot/Undershoot Pulse Duration

Pulse duration describes the total amount of time that an overshoot/undershoot event exceeds the overshoot/undershoot reference voltage. The total time could encompass several oscillations above the reference voltage. Multiple overshoot/undershoot pulses within a single overshoot/undershoot event may need to be measured to determine the total pulse duration.

Note: 0s

Oscillations below the reference voltage cannot be subtract the total overshoot/undershoot pulse duration.

Figure 2-9. Maximum Acceptable Overshoot/Undershoot Waveform



### 2.10.5.3 Reading Overshoot/Undershoot Specification Tables

The overshoot/undershoot specification for the processor is not a simple single value. Instead, many factors are needed to determine the over/undershoot specification. In addition to the magnitude of the overshoot the width of the overshoot is needed. To determine the allowed overshoot for a particular overshoot event, the following must be done:

- 1. Determine the signal group a particular signal falls into.
- 2. Determine the magnitude of the overshoot or the undershoot (relative to nominal Voltage or VSS).
- 3. Determine the duration of the undershoot or the overshoot.
- 4. Compare the values obtained with the maximum overshoot/undershoot magnitude and duration specification.



Undershoot events must be analyzed separately from overshoot events as they are mutually exclusive.

# **2.10.5.4** Determining if a System Meets the Overshoot/Undershoot Specifications

The overshoot/undershoot specifications listed in the table specify the allowable overshoot/undershoot for a single overshoot/undershoot event. However most signals will have multiple overshoot and/or undershoot events that each have their own set of parameters (duration and magnitude). To ensure a signal passes the overshoot and undershoot specifications, measure the worst case pulse duration and the worst case magnitude and compare the results against the specifications. If all of these worst case overshoot or undershoot events meet the specifications then the signal passes. If they do not meet the specification, please contact the Intel Representative.







# **3** Processor Land Listing

Please refer to Appendix A, "Pin Listing."

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# 4 Signal Descriptions

This chapter describes the Second Generation Intel® Xeon® Scalable Processors signals. They are arranged in functional groups according to their associated interface or category.

# 4.1 System Memory Interface

### Table 4-1. Memory Channel DDR0, DDR1, DDR2, DDR3, DDR4, DDR5

Signal Name	Description
DDR{5:0}_ACT_N	Activate. When asserted, indicates MA[16:14] are command signals (RAS_N, CAS_N, WE_N).
DDR{5:0}_ALERT_N	Parity Error detected by the DIMM (one for each channel).
DDR{5:0}_BA[1:0]	Bank Address. Defines which bank is the destination for the current Activate, Read, Write, or Precharge command.
DDR{5:0}_BG[1:0]	Bank Group: Defines which bank group is the destination for the current Active, Read, Write or Precharge command. BG0 also determines which mode register is to be accessed during a MRS cycle.
DDR{5:0}_CID[2]	3DS DRAM Chip ID signal
DDR{5:0}_CKE[3:0]	Clock Enable.
DDR{5:0}_CLK_DN[3:0] DDR{5:0}_CLK_DP[3:0]	Differential clocks to the DIMM. All command and control signals are valid on the rising edge of clock.
DDR{5:0}_CS_N[7:0]	Chip Select. Each signal selects one rank as the target of the command and address.  CS_N[7:6] are MUXed with CID[4:3], respectively. CS_N[3:2] are MUXed with CID[1:0], respectively.
DDR{5:0}_DQ[63:0]	Data Bus. DDR4 Data bits.
DDR{5:0}_DQS_DP[17:0] DDR{5:0}_DQS_DN[17:0]	Data strobes. Differential pair, Data/ECC Strobe. Differential strobes latch data/ECC for each DRAM. Different numbers of strobes are used depending on whether the connected DRAMs are x4,x8. Driven with edges in center of data, receive edges are aligned with data edges.
DDR{5:0}_ECC[7:0]	Check bits. An error correction code is driven along with data on these lines for DIMMs that support that capability
DDR{5:0}_MA[17:0]	Memory Address. Selects the Row address for Reads and writes, and the column address for activates. Also used to set values for DRAM configuration registers.  MA[16], MA[15], and MA[14] are multi-function and MUXed with RAS_N, CAS_N, and WE_N, respectively.  Note: MA[17] is not used on Second Generation Intel® Xeon® Scalable Processors It is reserved for future processor implementations on the platform. The pin still requires to be routed appropriately on the board to support future drop-in compatibility.
DDR{5:0}_PAR	Even parity across Address and Command.
DDR{5:0}_ODT[3:0]	On Die Termination. Enables DRAM on die termination during Data Write or Data Read transactions.



### **Table 4-2.** Memory Channel Miscellaneous

Signal Name	Description
DDR {012,345}_RESET_N	System memory reset: Reset signal from processor to DRAM devices on the DIMMs. DDR012_RESET_N is used for memory channels 0, 1 and 2 while DDR345_RESET_N is used for memory channels 3, 4 and 5.
DDR{012,345}_SPDSCL	SMBus clock for the dedicated interface to the serial presence detect (SPD) and thermal sensors (TSoD) on the DIMMs. DDR_SCL_C012 is used for memory channels 0, 1 and 2 while DDR_SCL_C345 is used for memory channels 3, 4 and 5.
DDR{012,345}_SPDSDA	SMBus data for the dedicated interface to the serial presence detect (SPD) and thermal sensors (TSoD) on the DIMMs. DDR_SDA_C012 is used for memory channels 0, 1 and 2 while DDR_SDA_C345 is used for memory channels 3, 4 and 5.
DDR{5:0}_CAVREF	DIMM Command address VREF signal
DDR{012,345}_DRAM_PWR_OK	Power good for VCCD rail used by the DRAM. This is an input signal used to indicate the VCCD power supply is stable for memory channels 0, 1, 2 and channels 3, 4, 5.
DDR{012,345}_RCOMP[2:0]	DDR Compensation resistance control

# **4.2 PCI Express\* Based Interface Signals**

**Note:** PCI Express\* Ports 1, 2 and 3 Signals are receive and transmit differential pairs.

## **Table 4-3. PCI Express Signals**

Signal Name	Description
PE{3:1}_RX_DN/DP[15:0]	PCIe Receive Data Input
PE{3:1}_TX_DN/DP[15:0]	PCIe Transmit Data Output

### **Table 4-4. PCI Express Miscellaneous Signals**

Signal Name	Description
PE_HP_SCL	PCI Express Hot-Plug SMBus Clock: Provides PCI Express* hot-plug support via a dedicated SMBus interface. Requires an external general purpose input/output (GPIO) expansion device on the platform.
PE_HP_SDA	PCI Express Hot-Plug SMBus Data: Provides PCI Express* hot-plug support via a dedicated SMBus interface. Requires an external general purpose input/output (GPIO) expansion device on the platform.
PE{012,3}_RBIAS	50 ohm bias resistor for PCI Express

# 4.3 DMI3 Signals

## Table 4-5. DMI3 Signals

Signal Name	Description
DMI_RX_DN/DP[3:0]	DMI3 Receive Data Input
DMI_TX_DN/DP[3:0]	DMI3 Transmit Data Output



# 4.4 Intel® Ultra Path Interconnect (Intel® UPI) Signals

### Table 4-6. Intel® UPI Signals

Signal Name	Description
UPI{2:1}_RX_DN/DP[19:0]	Intel® UPI Receive data input.
UPI{2:1}_TX_DN/DP[19:0]	Intel® UPI Transmit data output.
UPI{01,2}_RBIAS	50 ohm bias resistor for Intel® UPI

# 4.5 PECI Signal

## Table 4-7. PECI Signal

Signal Name	Description
PECI	PECI (Platform Environment Control Interface) is the serial sideband interface to the processor and is used primarily for thermal, power and error management.

# 4.6 System Reference Clock Signals

### Table 4-8. System Reference Clock (BCLK{0/1/2}) Signals

Signal Name	Description
BCLK{0,1,2}_DN/DP	Reference Clock Differential input.  These pins provide the required reference inputs to various PLLs inside the processor, such as Intel® UPI and PCIe. BCLK0, BCLK1 and BCLK2 run at 100 MHz from the same clock source.

# 4.7 JTAG and TAP Signals

### Table 4-9. JTAG and TAP Signals

Signal Name	Description
BPM_N[7:0]	Breakpoint and Performance Monitor Signals: I/O signals from the processor that indicate the status of breakpoints and programmable counters used for monitoring processor performance. These are 100 MHz signals.
PRDY_N	Probe Mode Ready is a processor output used by debug tools to determine processor debug readiness.
PREQ_N	Probe Mode Request is used by debug tools to request debug operation of the processor.
TCK	TCK (Test Clock) provides the clock input for the processor Test Bus (also known as the Test Access Port).
TDI	TDI (Test Data In) transfers serial test data into the processor. TDI provides the serial input needed for JTAG specification support.
TDO	TDO (Test Data Out) transfers serial test data out of the processor. TDO provides the serial output needed for JTAG specification support.
TMS	TMS (Test Mode Select) is a JTAG specification support signal used by debug tools.
TRST_N	TRST_N (Test Reset) resets the Test Access Port (TAP) logic. TRST_N must be driven low during power on Reset.



# 4.8 Serial VID Interface (SVID) Signals

Table 4-10. SVID Signals

Signal Name	Description
SVIDALERT_N [1:0]	Serial VID alert.
SVIDCLK [1:0]	Serial VID clock.
SVIDDATA [1:0]	Serial VID data out.

# 4.9 Processor Asynchronous Sideband and Miscellaneous Signals

**Table 4-11. Processor Asynchronous Sideband Signals (Sheet 1 of 2)** 

Signal Name	Description
CATERR_N	Indicates that the system has experienced a fatal or catastrophic error and cannot continue to operate. The processor will assert CATERR_N for unrecoverable machine check errors and other internal unrecoverable errors. It is expected that every processor in the system will wire-OR CATERR_N for all processors. Since this is an I/O land, external agents are allowed to assert this land which will cause the processor to take a machine check exception. The CATERR_N signal can be sampled any time after 1.5 ms after the assertion of PWRGOOD. On Second Generation Intel® Xeon® Scalable Processors, CATERR_N is used for signaling the following types of errors:  • Legacy MCERR's, CATERR_N is asserted for 16 BCLKs.
ERROR_N[2:0]	Error status signals for integrated I/O (IIO) unit:
	0 = Hardware correctable error (no operating system or firmware action necessary)
	1 = Non-fatal error (operating system or firmware action required to contain and recover)
	2 = Fatal error (system reset likely required to recover)
MEM_HOT_C{012/345}_N	Memory throttle control. Signals external BMC-less controller that DIMM is exceeding temperature limit and needs to increase to max fan speed.
	MEM_HOT_C012_N and MEM_HOT_C345_N signals have two modes of operation - input and output mode.
	Input mode is externally asserted and is used to detect external events such as VR_HOT# from the memory voltage regulator and causes the processor to throttle the appropriate memory channels.
	Output mode is asserted by the processor known as level mode. In level mode, the output indicates that a particular branch of memory subsystem is hot.
	MEM_HOT_C012_N is used for memory channels 0,1 & 2 while MEM_HOT_C345_N is used for memory channels 3, 4 & 5.
MSMI_N	Machine Check Exception (MCE) is signaled via this pin when eMCA2 is enabled. The MSMI_N signal can be sampled any time after 1.5 ms after the assertion of PWRGOOD
PMSYNC	Power Management Sync. A sideband signal to communicate power management status from the Platform Controller Hub (PCH) to the processor.
PMSYNC_CLK	24 MHz SE Clock used for PCH PMSYNC.
PROCHOT_N	PROCHOT_N will go active when the processor temperature monitoring sensor detects that the processor has reached its maximum safe operating temperature. This indicates that the processor Thermal Control Circuit has been activated, if enabled. This signal can also be driven to the processor to activate the Thermal Control Circuit. This signal is sampled after PWRGOOD assertion.



Table 4-11. Processor Asynchronous Sideband Signals (Sheet 2 of 2)

Signal Name	Description
PWRGOOD	PWRGOOD is a processor input. The processor requires this signal to be a clean indication that all processor clocks and power supplies are stable and within their specifications.
	"Clean" implies that the signal will remain low (capable of sinking leakage current), without glitches, from the time that the power supplies are turned on until they come within specification. The signal must then transition monotonically to a high state.
	PWRGOOD can be driven inactive at any time, but clocks and power must again be stable before a subsequent rising edge of PWRGOOD. PWRGOOD transitions from inactive to active when all supplies except VCCIN are stable.
	The signal must be supplied to the processor; it is used to protect internal circuits against voltage sequencing issues. It should be driven high throughout boundary scan operation.
RESET_N	Global reset signal. Asserting the RESET_N signal resets the processor to a known state and invalidates its internal caches without writing back any of their contents. Note some PLL, Intel UPI and error states are not affected by reset and only PWRGOOD forces them to a known state.
THERMTRIP_N	Assertion of THERMTRIP_N (Thermal Trip) indicates one of two possible critical over-temperature conditions: One, the processor junction temperature has reached a level beyond which permanent silicon damage may occur and Two, the system memory interface has exceeded a critical temperature limit set by BIOS. Measurement of the processor junction temperature is accomplished through multiple internal thermal sensors that are monitored by the Digital Thermal Sensor (DTS). Simultaneously, the Power Control Unit (PCU) monitors external memory temperatures via the dedicated SMBus interface to the DIMMs. If any of the DIMMs exceed the BIOS defined limits, the PCU will signal THERMTRIP_N to prevent damage to the DIMMs. Once activated, the processor will stop all execution and shut down all PLLs. To further protect the processor, its core voltage (Vccin), Vcco, Vccio, Vccio supplies must be removed following the assertion of THERMTRIP_N. Once activated, THERMTRIP_N remains latched until RESET_N is asserted. While the assertion of the RESET_N signal may deassert THERMTRIP_N, if the processor's junction temperature remains at or above the trip level, THERMTRIP_N will again be asserted after RESET_N is de-asserted. This signal can also be asserted if the system memory interface has exceeded a critical temperature limit set by BIOS. The THERMTRIP_N signal can be sampled any time after 1.5 ms after the

Table 4-12. Miscellaneous Signals (Sheet 1 of 3)

Signal Name	Description	
BIST_ENABLE	BIST Enable Strap. Input which allows the platform to enable or disable built-in self test (BIST) on the processor. This signal is pulled up on the die. Refer to Table 2-8, "Signals with On-Die Weak PU/PD" for details.	
BMCINIT	BMC Initialization Strap. Indicates whether Service Processor Boot Mode should be used. Used in combination with FRMAGENT and SOCKET_ID inputs.  O Service Processor Boot Mode Disabled. Example boot modes: Local PCH	
	(this processor hosts a legacy PCH with firmware behind it)  1 Service Processor Boot Mode Enabled. In this mode of operation, the processor performs the absolute minimum internal configuration and then waits for the Service Processor to complete its initialization. The socket boots after receiving a "GO" handshake signal via a firmware scratchpad register.	
	This signal is pulled down on the die, refer to Table 2-8, "Signals with On-Die Weak PU/PD" for details.	
DEBUG_EN_N	This pin is used to force debug to be enabled when the ITP is connected to the main board. This allows debug to occur beginning from cold boot.	
DMIMODE_OVERRIDE	BMCINIT, DMIMODE_OVERRIDE, FRMAGENT, and LEGACY_SKT, whether local or remote, whether the boot PCH is attached, whether the socket is legacy and whether port0 is DMI or PCIe.	



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Table 4-12. Miscellaneous Signals (Sheet 2 of 3)

Signal Name	Description
EAR_N	External Alignment of Reset, used to bring the processor up into a deterministic state. This signal is pulled up on the die, refer to Table 2-8, "Signals with On-Die Weak PU/PD" for details.
FIVR_FAULT	Indicates an internal error has occurred with the integrated voltage regulator. The FIVR_FAULT signal can be sampled any time after 1.5 ms after the assertion of PWRGOOD. FIVR_FAULT must be qualified by THERMTRIP_N assertion.
FRMAGENT	Bootable Firmware Agent Strap. This input configuration strap used in combination with SOCKET_ID to determine whether the socket is a legacy socket, bootable firmware agent is present, and DMI links are used in PCIe* mode (instead of DMI3 mode).  The firmware flash ROM is located behind the local PCH attached to the processor via the DMI3 interface. This signal is pulled down on the die, refer to Table 2-8, "Signals with On-Die Weak PU/PD" for details.
PM_FAST_WAKE_N	Power Management Fast Wake. Enables quick package C3 - C6 exits of all sockets. Asserted if any socket detects a break from package C3 - C6 state requiring all sockets to exit the low power state to service a snoop, memory access, or interrupt. Expected to be wired-OR among all processor sockets within the platform.
PROC_ID [1:0]	This output can be used by the platform to determine if the installed processor is a Second Generation Intel® Xeon® Scalable Processors or a future processor. There is no connection to the processor silicon for this signal. The processor package grounds or floats the pin to set '0' or '1', respectively.  Second Generation Intel® Xeon® Scalable Processors  00: Second Generation Intel® Xeon® Scalable Processors  01: Reserved  10: Reserved  11: Reserved  Intel Xeon processor-W Family  00: Reserved  10: Future Processor  11: Intel Xeon processor-W Family
RSVD	RESERVED. All signals that are RSVD must be left unconnected on the board.
SAFE_MODE_BOOT	Safe Mode Boot Strap. SAFE_MODE_BOOT allows the processor to wake up safely by disabling all clock gating. This allows BIOS to load registers or patches if required. This signal is sampled after PWRGOOD assertion. The signal is pulled down on the die. Refer to Table 2-8, "Signals with On-Die Weak PU/PD" for details.
SKTOCC_N	SKTOCC_N (Socket Occupied) is used to indicate that a processor is present. This is pulled to ground on the processor package; there is no connection to the processor silicon for this signal.
SOCKET_ID[2:0]	SOCKET_IDStrap. Socket identification configuration straps for establishing the PECI address and Intel UPI Node ID. This signal is used in combination with FRMAGENT to determine whether the socket is a legacy socket, bootable firmware agent is present, and DMI links are used in PCIe* mode (instead of DMI3 mode). Each processor socket consumes one Node ID, and there are 128 Home Agent tracker entries. This signal is pulled down on the die. Refer to Table 2-8, "Signals with On-Die Weak PU/PD" for details.  SOCKET_ID[1:0] is used for 2S platforms and SOCKET_ID[2:0] is implemented on 4S/8S platforms. This is an asynchronous signal to other clocks in the processor.
TEST[15:1]	TEST[14:13], TEST[2:1]] must be individually connected to an appropriate power source or ground through a resistor for proper processor operation.



Table 4-12. Miscellaneous Signals (Sheet 3 of 3)

Signal Name	Description
TXT_AGENT	Intel® Trusted Execution Technology (Intel® TXT) Agent Strap. 0 = Default. The socket is not the Intel® TXT Agent.  1 = The socket is the Intel® TXT Agent.  The legacy socket (identified by SOCKET_ID[1:0] = 00b) with Intel® TXT Agent should always set the TXT_AGENT to 1b.  This signal is pulled down on the die, refer to Table 2-8, "Signals with On-Die Weak PU/PD" for details.
TXT_PLTEN	Intel® Trusted Execution Technology (Intel® TXT) Platform Enable Strap. 0 = The platform is not Intel® TXT enabled. All sockets should be set to zero. Scalable DP (sDP) platforms should choose this setting if the Node Controller does not support Intel® TXT.  1 = Default. The platform is Intel® TXT enabled. All sockets should be set to one. In a non-Scalable DP platform this is the default. When this is set, Intel® TXT functionality requires user to explicitly enable Intel® TXT via BIOS setup.  This signal is pulled up on the die, refer to Table 2-8, "Signals with On-Die Weak PU/PD" for details.
LEGACY_SKT	BMCINIT, FRMAGENT, LEGACY_SKT together determine the boot mode (SSP, Intel® UPI Link boot modes, DCF boot), whether local or remote, whether the boot PCH is attached, whether the socket is legacy and whether port0 is DMI or PCIe (Gen1/2. With one exception, this input configuration strap indicates to the processor that it is the legacy socket. The legacy SKT must be strapped for NODE ID 0, via the SKIT ID pins. There is only 1 legacy SKT in a partition.
PKGID[2:0]	An indicator to the Second Generation Intel® Xeon® Scalable Processors-based platform of the Intel® Omni-Path Technology configuration.
PROCDIS_N	PROCDIS_N assert initiates FRB and tri-states the processor.
PWR_DEBUG_N	This is a debug signal for power debug using Intel® In-Target Probe on the
SOCKET_ID2	Asynchronous to other clocks in the processor.
TSC_SYNC	Time stamp counter sync. Used to help align the time stamp counters of a newly socket to the time stamp counters of existing sockets.

## Table 4-13. PIROM Signals

Signal Name	Description
PIROM_ADDR[2:0]	Address for PIROM (Processor Information ROM/OEM scratch pad).
SM_WP	WP (Write Protect) can be used to write protect the Scratch EEPROM. The Scratch EEPROM is write-protected when this input is pulled high to VCCSTBY33.
SMBCLK	The SMBus Clock (SMBCLK) signal is an input clock which is required for operation of PIROM. This clock is driven by the SMBus controller and is asynchronous to other clocks in the processor.
SMBDAT	The SMBus Data (SMBDAT) signal is the data signal for the SMBus. This signal provides the single-bit mechanism for transferring data between SMBus devices.



Table 4-14. Intel® Omni-Path Host Fabric Interface (Intel® OP HFI) Signals

Signal Name	Description
CD_HFI[1:0]_I2CCLK	2-wire serial interface clock
CD_HFI[1:0]_I2CDAT	2-wire serial interface data
CD_HFI[1:0]_INT_N	Interrupt. Used to inform the CPU that the module has encountered a potential error condition
CD_HFI[1:0]_LED_N	Indicates activity on the link
CD_HFI[1:0]_MODPRST_N	Module present
CD_HFI[1:0]_RESET_N	Module reset
CD_HFI_REFCLK_DN/DP	HFI Reference Clock
CD_POR_N	Power on reset for HFI ASIC
MCP01_RBIAS	Multi-chip Bus RBIAS

# **4.10** Processor Power and Ground Supplies

Table 4-15. Power and Ground Signals (Sheet 1 of 2)

Signal Name	Description
V <sub>CCIN</sub>	1.8 V - 1.55 V input to the Integrated Voltage Regulator (IVR) for the processor cores, lowest level caches (LLC), ring interface, PLL, IO, and home agent. It is provided by a VR 13.0 compliant motherboard voltage regulator (MBVR) for each CPU socket. The output voltage of this MBVR is controlled by the processor, using the serial voltage ID (SVID) bus.
VCCIN_SENSE VSS_VCCIN_SENSE	VCCIN_SENSE and VSS_VCCIN_SENSE are remote sense signals for VCCIN MBVR13.0 and are used by the voltage regulator to ensure accurate voltage regulation. These signals must be connected to the voltage regulator feedback circuit, which insures the output voltage remains within specification.
VCCIO_SENSE VSS_VCCIO_SENSE	VCCIO_SENSE and VSS_VCCIO_SENSE are remote sense signals for VCCIO and are used by the voltage regulator to ensure accurate voltage regulation. These signals must be connected to the voltage regulator feedback circuit, which insures the output voltage remains within specification.
VCCSA_SENSE VSS_VCCSA_SENSE	VCCSA_SENSE and VSS_VCCSA_SENSE are remote sense signals, and are used by the voltage regulator to ensure accurate voltage regulation. These signals must be connected to the voltage regulator feedback circuit, which insures the output voltage remains within specification.
CD_VCC_CORE	Companion die 0.9 V core supply
CD_VCCP	Companion die 1.0 V IO supply. Connects to memory voltage regulator.
CD_VCCIN	Companion die voltage rail tied to VCCIN through filter
CD_VPP	Companion die 2.5 V supply
CD_VCCP	Companion die 1.0 V IO supply
VCCIO	.95V-1.0V power supply for the processor IO.
VCC33	VCC33 supplies 3.3 V to PIROM/OEM Scratch ROM. This supply is required for PIROM usage.
VCCIO	.95 V - 1.0 V power supply for the processor IO.
VCCINPMAX	Pmax detect VCCIN supply through board R2 thermistor for VCCIN loadline temperature compensation
VCCSA	1.05 V - 0.55 V supply for Intel® UPI and IIO
VSENSEPMAX	Pmax detect circuit output voltage



## Table 4-15. Power and Ground Signals (Sheet 2 of 2)

Signal Name	Description
VCCD_012 VCCD_345	1.2 V - 1.05 V power supply for the processor system memory interface.
Vss	Processor ground return.
Vccio	IO voltage supply input.







# 5 PIROM

## **5.1** Processor Information ROM

The Processor Information ROM (PIROM) is a memory device located on the processor and is accessible via the System Management Bus (SMBus) which contains information regarding the processor's features. These features are listed in Table 5-1, "Processor Information ROM Table."

The PIROM resides in the lower half of the memory component (addresses 00 to 7Fh), which is permanently write-protected by Intel. The upper half comprises the Scratch EEPROM (addresses 80 to FFh).

Table 5-1. Processor Information ROM Table (Sheet 1 of 3)

Offset/ Section	# of Bits	Function	Notes	Examples
Header				
00h	8	Data Format Revision	Two 4-bit hex digits	Start with 00h
02-01h	16	PIROM Size	Size in bytes (LSB first)	Use a decimal to hex transfer; 128 bytes = 0080h:
03h	8	Processor Data Address	Byte pointer, 00h if not present	0Dh
04h	8	Processor Core Data Address	Byte pointer, 00h if not present	19h
05h	8	Processor Uncore Data Address	Byte pointer, 00h if not present	21h
06h	8	Cache Data Address	Byte pointer, 00h if not present	2Bh
07h	8	Package Data Address	Byte pointer, 00h if not present	31h
08h	8	Voltage Data Address	Byte pointer, 00h if not present	34h
09h	8	Part Number Data Address	Byte pointer, 00h if not present	56h
0Ah	8	Thermal Data Address	Byte pointer, 00h if not present	65h
0Bh	8	Feature Data Address	Byte pointer, 00h if not present	6Ch
0Ch	8	PPIN Data Address	Byte pointer, 00h if not present	77h
Processor	Data		•	-
0D to 12h	48	S-spec/QDF Number	Six 8-bit ASCII characters	
13h	7/1	Sample/Production	First seven bits reserved	0b = Sample, 1b = Production 00000001 = production
14h	8	Number of Cores	Binary Coded Decimal	24h=24 Cores
15	7/1	Hyper-Threading Support	First seven bits reserved	0b = no Hyper-Threading, 1b = Hyper-Threading 00000001 = Hype- Threading
17 to 16h	16	System Clock Speed	Binary Coded Decimal (Mhz)	0100h = 100MHz <sup>1</sup>
18h	8	Reserved	Reserved for future use	00000000
Processor	Core D	ata	•	•
1A to 19h	16	CPUID	4 bit Binary Coded Decimal	
1B to 1Ch	16	Reserved	Reserved for future use	000000000000000
1E to 1Dh	16	Maximum P1 Core Frequency	4 bit Binary Coded Decimal	2500h = 2500 MHz <sup>1</sup>
20 to 1Fh	16	Maximum P0 Core Frequency	4 bit Binary Coded Decimal	2800h = 2800 MHz <sup>1</sup>



Table 5-1. Processor Information ROM Table (Sheet 2 of 3)

Offset/ Section	# of Bits	Function	Notes	Examples	
Processor	Uncore	e Data			
21h	8	Number of Intel <sup>®</sup> UPI Links	4 bit Binary Coded Decimal	03h=3 UPI links	
23 to 22h	16	Maximum Intel <sup>®</sup> UPI Link Transfer Rate	4 bit Binary Coded Decimal	1040h = 10.4 GT/s <sup>1</sup>	
25 to 24h	16	Maximum PCIe Link Transfer Rate	4 bit Binary Coded Decimal	8000h = 8000 MT/s <sup>1</sup>	
27 to 26h	16	Maximum DDR 1DPC Speed	4 bit Binary Coded Decimal	2666h = 2666 MT/S	
29 to 28h	16	Maximum DDR 2DPC Speed	4 bit Binary Coded Decimal	2400h = 2400 MT/s	
2Ah	8	Reserved	Reserved for future use	0000000	
Cache Dat	a				
2C to 2Bh	16	MLC Cache Size	Binary (KB) Per CPU Core	0000010000000000h = 1024KB	
2E to 2Dh	16	LLC Cache Size	Binary (KB)	011000000000h = 24576KB	
30 to 2Fh	16	NVM DIMM Max Capacity	Binary	Multiplier of 96 = 6TB	
Package D	ata				
31h	8	Package Type	4 bit Binary Coded Decimal	First 4 bits reserved Output decode is below	
32 to 33h	16	Reserved	Reserved for future use	000000000000000	
Voltage D	ata			-	
35 to 34h	16	Maximum VCCIN	4 bit Binary Coded Decimal	1800h = 1800 mV <sup>1</sup>	
37 to 36h	16	Minimum VCCIN	4 bit Binary Coded Decimal	$0600h = 600 \text{ mV}^1$	
39 to 38h	16	Maximum VCCSA	4 bit Binary Coded Decimal	1350h = 1350 mV <sup>1</sup>	
3B to 3Ah	16	Minimum VCCSA	4 bit Binary Coded Decimal	$0800h = 800 \text{ mV}^1$	
3D to 3Ch	16	VCCD	4 bit Binary Coded Decimal	1200h = 1200mV <sup>1</sup>	
3F to 3Eh	16	VCCIO	4 bit Binary Coded Decimal	1000h = 1000mV <sup>1</sup>	
40 to 43h	32	Reserved	Reserved for future use	000000000000000000000000000000000000000	
45 to 44h	16	CD_VCC_CORE	4 bit Binary Coded Decimal	1000h = 1000mV <sup>1</sup>	
47 to 46h	16	CD_VCCIN	4 bit Binary Coded Decimal	1000h = 1000mV <sup>1</sup>	
49 to 48h	16	CD_VCCP	4 bit Binary Coded Decimal	1000h = 1000mV <sup>1</sup>	
4B to 4A	16	CD_VPP	4 bit Binary Coded Decimal	1000h = 1000mV <sup>1</sup>	
4D to 4C	16	RC_VCC_CORE	4 bit Binary Coded Decimal	1000h = 1000mV <sup>1</sup>	
4F to 4Eh	16	RC_VCCH	4 bit Binary Coded Decimal	1000h = 1000 mV <sup>1</sup>	
50 to 55h	48	Reserved	Reserved for future use	000000000000000000000000000000000000000	
Part Numl	oers				
5C to 56h	56	Processor Family Number	Seven 8-bit ASCII characters	CM80645	
64 to 5Dh	64	Processor SKU Number	Eight 8-bit ASCII characters	41272834	
Thermal R	eferen	ce		•	
65h	8	Tcase Maximum	4 bit Binary Coded Decimal	69h = 69°C <sup>1</sup>	
67 to 66h	16	Thermal Design Power	4 bit Binary Coded Decimal	0130h = 130 Watts <sup>1</sup>	
69 to 68h	16	DTS Maximum	4 bit Binary Coded Decimal	102h = 102°C <sup>1</sup>	
6B to 6Ah	16	Pn Limit	4 bit Binary Coded Decimal	53h = 53 Watts <sup>1</sup>	



**Table 5-1.** Processor Information ROM Table (Sheet 3 of 3)

Offset/ Section	# of Bits	Function	Notes	Examples
Features				
6F to 6Ch	32	Processor Core Feature Flags	From CPUID function 1, EDX contents	4387FBFFh
70 to 71h	16	Processor Feature Flags	Up to 16 features - Binary 1 indicates functional feature	000000000001111
72	6/2	Multiprocessor Support	000b=1S, 001b = 2S, 010b=4S GLULS, 011b=S4S, 100b=Reserved, and 101b=S8S.	00000101b=S8S
73h	4/4	Number of Devices in TAP Chain	First four bits reserved One 4-bit hex digit - Bits	*0h <sup>1</sup>
74 to 75h	16	Reserved	Reserved for future use	0000h
76h	8	Static Checksum	1 byte checksum	Add up by byte and take 2's complement.
Other				
7E to 77h	64 PPIN Coded binary			See description
7Fh	8	Reserved	Reserved for future use	00000000

### 5.2 Scratch EEPROM

Also available in the memory component on the processor SMBus is an EEPROM which may be used for other data at the system or processor vendor's discretion. The data in this EEPROM, once programmed, can be write-protected by asserting the active-high SM\_WP signal. This signal has a weak pull-down (10 Kohm) to allow the EEPROM to be programmed in systems with no implementation of this signal. The Scratch EEPROM resides in the upper half of the memory component (addresses 80 - FFh). The lower half comprises the Processor Information ROM (addresses 00 - 7Fh), which is permanently write-protected by Intel.

## 5.3 PIROM and Scratch EEPROM Supported SMBus Transactions

The PIROM responds to two SMBus packet types: Read Byte and Write Byte. However, since the PIROM is write-protected, it will acknowledge a Write Byte command but ignore the data. The Scratch EEPROM responds to Read Byte and Write Byte commands. Table 5-2, "Read Byte SMBus Packet" illustrates the Read Byte command. Table 5-3, "Write Byte SMBus Packet" illustrates the Write Byte command.

In the tables, 'S' represents a SMBus start bit, 'P' represents a stop bit, 'A' represents an acknowledge (ACK), and '///' represents a negative acknowledge (NACK). The shaded bits are transmitted by the PIROM or Scratch EEPROM, and the bits that aren't shaded are transmitted by the SMBus host controller. In the tables, the data addresses indicate 8 bits.

The SMBus host controller should transmit 8 bits with the most significant bit indicating which section of the EEPROM is to be addressed: the PIROM (MSB = 0) or the Scratch EEPROM (MSB = 1).

<sup>1.</sup> Uses Binary Coded Decimal (BCD) translation.



### Table 5-2. Read Byte SMBus Packet

S	Slave Address	Write	A	Command Code	A	S	Slave Address	Read	A	Data	///	Р
1	7-bits	1	1	8-bits	1	1	7-bits	1	1	8-bits	1	1

### Table 5-3. Write Byte SMBus Packet

S	Slave Address	Write	A	Command Code	A	Data	A	Р
1	7-bits	1	1	8-bits	1	8-bits	1	1

## 5.4 SMBus Memory Component Addressing

Of the addresses broadcast across the SMBus, the memory component claims those of the form "10100XXZb". The "XX" bits are defined by pull-up and pull-down of the PIROM\_ADDR[2:0] pins. These address pins are pulled down weakly (10 k) on the processor substrate to ensure that the memory components are in a known state in systems which do not support the SMBus (or only support a partial implementation). The "Z" bit is the read/write bit for the serial bus transaction.

Note that addresses of the form "0000XXXXb" are Reserved and should not be generated by an SMBus master.

Table 5-4, "Memory Device SMBus Addressing" describes the address pin connections and how they affect the addressing of the memory component.

### Table 5-4. Memory Device SMBus Addressing

Address (Hex)	Upper Address <sup>1</sup>		<b>Device Select</b>		R/W
Address (nex)	Bits 7-4	SKTID[2]	SKTID[1] Bit 2	SKTID[0] Bit 1	Bit 0
A0h/A1h	10100	10100	0	0	Χ
A2h/A3h	10100	10100	0	1	X
A4h/A5h	10100	10100	1	0	Х
A6h/A7h	10100	10100	1	1	Х

### Notes:

# **5.4.1** Managing Data in the PIROM

The PIROM consists of the following sections:

- Header
- Processor Data
- · Processor Core Data
- · Processor Uncore Data
- Cache Data
- · Package Data
- Part Number Data

<sup>1.</sup> This addressing scheme will support up to four processors on a single SMBus.



- Thermal Reference Data
- Feature Data
- Other Data

Details on each of these sections are described below.

Note:

Reserved fields or bits SHOULD be programmed to zeros. However, OEMs should not rely on this model.

### 5.4.2 Header

To maintain backward compatibility, the Header defines the starting address for each subsequent section of the PIROM. Software should check for the offset before reading data from a particular section of the ROM.

For example, Code looking for the processor uncore data of a processor would read offset 05h to find a value of 21. 21 is the first address within the 'Processor Uncore Data' section of the PIROM.

### 5.4.2.1 DFR: Data Format Revision

This location identifies the data format revision of the PIROM data structure. Writes to this register have no effect.

Offset:	00h
Bit	Description
7:0	Data Format Revision The data format revision is used whenever fields within the PIROM are redefined. The initial definition will begin at a value of 1. If a field, or bit assignment within a field, is changed such that software needs to discern between the old and new definition, then the data format revision field will be incremented.
	00h: Reserved 01h: Initial definition 02h: Second revision 03h: Third revision 04h: Fourth revision 05h: Fifth revision 06h: Sixth revision 06h: Sixth revision 07h: Seventh revision (Defined by this document) 08h-FFh: Reserved

### 5.4.2.2 PISIZE: PIROM Size

This location identifies the PIROM size. Writes to this register have no effect.

Offset:	02h-01h
Bit	Description
15:0	PIROM Size The PIROM size provides the size of the device in hex bytes. The LSB is at location 01h; the MSB is at location 02h.
	0000h - 007Fh: Reserved 0080h: 128 byte PIROM size 0081- FFFFh: Reserved



### 5.4.2.3 PDA: Processor Data Address

This location provides the offset to the Processor Data Section. Writes to this register have no effect.

Offset:	03h
Bit	Description
7:0	Processor Data Address Byte pointer to the Processor Data section
	0Dh: Processor Data section pointer value

### **5.4.2.4** PCDA: Processor Core Data Address

This location provides the offset to the Processor Core Data Section. Writes to this register have no effect.

Offset:	04h
Bit	Description
7:0	Processor Core Data Address Byte pointer to the Processor Core Data section
	19h: Processor Core Data section pointer value

### **5.4.2.5 PUDA: Processor Uncore Data Address**

This location provides the offset to the Processor Uncore Data Section. Writes to this register have no effect.

Offset:	05h
Bit	Description
7:0	Processor Uncore Data Address Byte pointer to the Processor Uncore Data section
	21h: Processor Uncore Data section pointer value

### 5.4.2.6 CDA: Cache Data Address

This location provides the offset to the Cache Data Section. Writes to this register have no effect.

Offset:	06h
Bit	Description
7:0	Cache Data Address Byte pointer to the Cache Data section
	2Bh: Cache Data section pointer value



### **5.4.2.7** PNDA: Package Data Address

This location provides the offset to the Package Data Section. Writes to this register have no effect.

Offset:	07h
Bit	Description
7:0	Package Data Address Byte pointer to the Package Data section
	31h: Package Data section pointer value

## 5.4.2.8 VDA: Voltage Data Address

This location provides the offset to the Voltage Data Section. Writes to this register have no effect.

Offset:	08h
Bit	Description
7:0	Voltage Data Address Byte pointer to the Voltage Data section
	34h: Voltage Data section pointer value

### **5.4.2.9 PNDA: Part Number Data Address**

This location provides the offset to the Part Number Data Section. Writes to this register have no effect.

Offset:	09h
Bit	Description
7:0	Part Number Data Address Byte pointer to the Part Number Data section
	56h: Part Number Data section pointer value

### 5.4.2.10 TRDA: Thermal Reference Data Address

This location provides the offset to the Thermal Reference Data Section. Writes to this register have no effect.

Offset:	0Ah
Bit	Description
7:0	Thermal Reference Data Address Byte pointer to the Thermal Reference Data section 65h: Thermal Reference Data section pointer value



### 5.4.2.11 FDA: Feature Data Address

This location provides the offset to the Feature Data Section. Writes to this register have no effect.

Offset:	0Bh
Bit	Description
7:0	Feature Data Address Byte pointer to the Feature Data section
	6Ch: Feature Data section pointer value

### **5.4.2.12** PPIN: Protected Processor Inventory Number

This location provides the offset to the PPIN Data Section. Writes to this register have no effect.

Offset:	0Ch
Bit	Description
7:0	PPIN Data Address Byte pointer to the PPIN Data section
	77h: PPIN Data section pointer value

### 5.4.3 Processor Data

This section contains five pieces of data:

- The S-spec/QDF of the part in ASCII format
- (1) 2-bit field to declare if the part is a preproduction sample or a production unit
- · Core count
- Intel® Hyper-threading Technology support status
- The system bus speed in BCD format

### **5.4.3.1 SAMPROD:** Sample/Production

This location contains the sample/production field, which is a two-bit field and is LSB aligned. All S-spec material will use a value of 01b. All other values are reserved. Writes to this register have no effect.

A processor with an Sxxxx mark (production unit) will use 01h at offset 14h.

Offset:	13h
Bit	Description
7:2	RESERVED
	000000b-111111b: Reserved
1:0	Sample/Production Sample or Production indicator
	00b: Sample 01b: Production 10b-11b: Reserved



#### **5.4.3.2** Processor Core Information

This location contains information regarding the number of cores on the processor. Writes to this register have no effect. Data format is binary coded decimal.

Offset:	14h
Bit	Description
7:0	Number of cores
	0000h-FFFFh: Cores

#### 5.4.3.3 Processor Thread Information

This location contains information regarding the number of cores and threads on the processor. Writes to this register have no effect. Data format is binary coded decimal.

Offset:	15h
Bit	Description
7:0	Number of threads per core
	0000h-FFFFh: Threads

## 5.4.3.4 SCS: System Clock Speed

This location contains the system clock frequency information. Systems may need to read this offset to decide if all installed processors support the same system clock speed. The data provided is the speed, rounded to a whole number, and reflected in binary coded decimal. Writes to this register have no effect.

For example, a processor with system bus speed of 100 MHz will have a value of 0100h.

Offset:	17h-16h
Bit	Description
15:0	System Bus Speed
	0000h-FFFFh: MHz

#### 5.4.3.5 RES1: Reserved 1

This location is reserved. Writes to this register have no effect.

Offset:	18h
Bit	Description
7:0	RESERVED
	00h-FFh: Reserved

#### 5.4.4 Processor Core Data

This section contains silicon-related data relevant to the processor cores.



#### 5.4.4.1 CPUID: CPUID

This location contains the CPUID, Processor Type, Family, Model and Stepping. The CPUID field is a copy of the results in EAX[15:0] from Function 1 of the CPUID instruction. For example, bit 15 is MSB in offset 1Ah and bit 0 is LSB in offset 19h. Writes to this register have no effect. Data format is hexadecimal.

Offset:	1Ah-1	9h
Bit	Byte	Description
15:13	1Ah	Reserved
		00b-11b: Reserved
12:12		Processor Type
		0b-1b: Processor Type
11:8		Processor Family
		0h-Fh: Processor Family
7:4	19h	Processor Model
		0h-Fh: Processor Model
3:0		Processor Stepping
		0h-Fh: Processor Stepping

#### **5.4.4.2** RES2: Reserved 2

This locations are reserved. Writes to this register have no effect.

Offset:	1Bh-1Ch	
Bit	Description	
15:0	RESERVED	
	0000h-FFFFh: Reserved	

# **5.4.4.3** MP1CF: Maximum P1 Core Frequency

This location contains the maximum non-Intel® Turbo Boost Technology core frequency for the processor. The frequency should equate to the markings on the processor and/ or the QDF/S-spec speed even if the parts are not limited or locked to the intended speed. Format of this field is in megahertz, rounded to a whole number, and encoded in binary coded decimal. Writes to this register have no effect.

For example, a 2.6 GHz processor will have a value of 2600h.

Offset:	1Eh-1Dh
Bit	Description
15:0	Maximum P1 Core Frequency
	0000h-FFFFh: MHz



## 5.4.4.4 MP0CF: Maximum P0 Core Frequency

This location contains the maximum Intel Turbo Boost Technology core frequency for the processor. This is the maximum intended speed for the part under any functional conditions. Format of this field is in megahertz, rounded to a whole number, and encoded in binary coded decimal. Writes to this register have no effect.

**For example,** A processor with a maximum Intel Turbo Boost Technology frequency of 2.8 GHz will have a value of 2800h.

Offset:	20h-1Fh
Bit	Description
15:0	Maximum P0 Core Frequency
	0000h-FFFFh: MHz

# 5.4.5 Processor Uncore Data

This section contains silicon-related data relevant to the processor Uncore.

# 5.4.5.1 UPIL: Number of Intel® UPI Links

Systems may need to read this offset to decide if the device has enough Intel® UPI Links to operate the number of processors your system is capable of supporting. The data provided is the number of links, and reflected in binary coded decimal. Writes to this register have no effect.

For example, the Second Generation Intel® Xeon® Scalable Processors supports a maximum of three links. Therefore, offset 21h could have a value of 03.

Offset:	21h
Bit	Description
7:0	Number of Intel <sup>®</sup> UPI links
	00h-FFh: Links

# 5.4.5.2 MAXUPI: Maximum Intel® UPI Transfer Rate

Systems may need to read this offset to decide if all installed processors support the same Intel<sup>®</sup> UPI link transfer rate. The data provided is the transfer rate, rounded to a whole number, and reflected in binary coded decimal. Writes to this register have no effect.

For example, the Second Generation Intel® Xeon® Scalable Processors supports a maximum Intel® UPI link transfer rate of 10.4 GT/s. Therefore, offset 23h-22h has a value of 1040.

Offset:	23h-22h
Bit	Description
15:0	Maximum Intel® UPI Transfer Rate
	0000h-FFFFh: 10 MHz



#### 5.4.5.3 MAXPCI: Maximum PCIe Transfer Rate

Systems may need to read this offset to decide if all installed processors support the same Intel PCIe Link Transfer Rate. The data provided is the transfer rate, rounded to a whole number, and reflected in binary coded decimal. Writes to this register have no effect.

For example, the Second Generation Intel® Xeon® Scalable Processors supports a maximum Intel PCIe2 link transfer rate of 8.0 GT/s. Therefore, offset 25h-24h has a value of 8000.

Offset:	25h-24h
Bit	Description
15:0	Minimum PCIe Transfer Rate
	0000h-FFFFh: MHz

## 5.4.5.4 DDR1DPC: Maximum Intel DDR4 1 DPC DIMM Speed

Systems may need to read this offset to set maximum DIMM speeds supporting the 1 DPC usage. The data provided is maximum supported DIMM frequency, rounded to a whole number, and reflected in binary coded decimal. Writes to this register have no effect.

For example, the Second Generation Intel® Xeon® Scalable Processors supports a maximum DDR4 frequency of 2667Gh/s. Therefore, offset 27h-26h has a value of 2667h.

Offset:	27h-26h	
Bit	Description	
15:0	Maximum Intel SMI Transfer Rate	
	0000h-FFFFh: MHz	

# 5.4.5.5 DDR2DPC: Maximum Intel DDR4 2 DPC DIMM Speed

Systems may need to read this offset to set maximum DIMM speeds supporting the 2DPC usage. The data provided is maximum supported DIMM frequency, rounded to a whole number, and reflected in binary coded decimal. Writes to this register have no effect.

Offset:	29h-28h
Bit	Description
15:0	Minimum Intel SMI Transfer Rate
	0000h-FFFFh: MHz

#### 5.4.5.6 RES3: Reserved 3

This locations are reserved. Writes to this register have no effect.



Offset:	2Ah
Bit	Description
8:0	RESERVED
	00h-FFh: Reserved

# **5.4.6** Processor Cache Data

This section contains silicon-related data relevant to the processor caches.

#### 5.4.6.1 MLC: Mid Level Cache Size

This location contains the size of the level-two cache in kilobytes per core. Writes to this register have no effect. Data format is decimal.

For example, the Second Generation Intel® Xeon® Scalable Processors has a 1 MB MLC cache per core. Thus, offset 2Ch-2Bh will contain a value of 0400h, which is 1024.

Offset:	2Ch-2Bh
Bit	Description
15:0	Mid Level Cache Size
	0000h-FFFFh: KB

#### 5.4.6.2 LLC: Low Level Cache Size

This location contains the size of the level-three cache in megabytes per package. Writes to this register have no effect. Data format is decimal.

For example, the Second Generation Intel® Xeon® Scalable Processors has a 33 MB LLC cache. Thus, offset 2Eh-2Dh will contain a value of 8400h.

Offset:	2Eh-2Dh
Bit	Description
15:0	Low Level Cache Size
	0000h-FFFFh: KB

#### 5.4.6.3 RES2 and RES3: Reserved 2 and Reserved 3

This location contains NVM DIMM Max Capacity information. Bit 15:0 is binary value representation of multiplier of 64 GB to indicate NVM DIMM Max Capacity. Writes to this register have no effect.



Offset:	30h-2Fh
Bit	Description
15:8	Offset 30h: NVM DIMM Max Capacity
	00h-FFh:
7:0	Offset 2Fh: NVM DIMM Max Capacity
	00h-FFh:

# **5.4.7** Package Data

This section contains substrate and other package related data.

# **5.4.7.1 PKGT: Package Type**

This location tracks the whether the part is a multi-chip package, and which type if so. 0 = non-MCP package. 1 = fabric. Writes to this register have no effect.

Offset:	31h
Bit	Description
7:0	Package Type
	00h-FFh:

#### 5.4.7.2 RES5: Reserved 5

This location is reserved. Writes to this register have no effect.

Offset:	32h-33h
Bit	Description
15:0	RESERVED
	0000h-FFFFh: Reserved

# **5.4.8** Processor Voltage Data

This section contains silicon-related data relevant to the processor voltage rails.

#### 5.4.8.1 MXVCCIN: MAX VCCIN VID

Offset 35h-34h is the Processor VCCIN maximum VID (Voltage Identification) field and contains the maximum voltage requested via the VID pins. This field, rounded to the next thousandth, is in mV and is reflected in binary coded decimal. Some systems read this offset to determine if all processors support the same default VID setting. Writes to this register have no effect.

For example, a voltage of 1.800 V maximum core VID would contain 1800h in offset 35- 34h.



Offset:	35h-34h
Bit	Description
15:0	MAX VCCIN VID
	0000h-FFFFh: mV

#### 5.4.8.2 MNVCCIN: MIN VCCIN VID

Offset 37h-36h is the Processor Vsa minimum VID (Voltage Identification) field and contains the minimum voltage requested via the VID pins. This field, rounded to the next thousandth, is in mV and is reflected in binary coded decimal. Some systems read this offset to determine if all processors support the same default VID setting. Writes to this register have no effect.

For example, a voltage of 0.600 V maximum core VID would contain 0600h in offset 37h- 36h.

Offset:	37-36h
Bit	Description
15:0	MIN VCCIN VID
	0000h-FFFFh: mV

#### 5.4.8.3 MXSAVD: MAX VSA VID

Offset 39h-38h is the Processor Vsa maximum VID (Voltage Identification) field and contains the maximum voltage requested via the VID pins. This field, rounded to the next thousandth, is in mV and is reflected in binary coded decimal. Some systems read this offset to determine if all processors support the same default VID setting. Writes to this register have no effect.

For example, a voltage of 1.000 V maximum core VID would contain 1000h in offset 39h- 38h.

Offset:	39h-38h
Bit	Description
15:0	MAX VSA VID
	0000h-FFFFh: mV

#### 5.4.8.4 MNSAVD: MIN VSA VID

Offset 3Bh-3Ah is the Processor Vsa minimum VID (Voltage Identification) field and contains the minimum voltage requested via the VID pins. This field, rounded to the next thousandth, is in mV and is reflected in binary coded decimal. Some systems read this offset to determine if all processors support the same default VID setting. Writes to this register have no effect.

For example, a voltage of 0.600 V maximum core VID would contain 0600h in offset  $3\mathrm{Bh}\text{-}3\mathrm{Ah}$ .



Offset:	3Bh-3Ah
Bit	Description
15:0	MIN VSA VID
	0000h-FFFFh: mV

#### 5.4.8.5 VCCD: VCCD

This field contains the voltage requested for the VCCD pins. This field is in mV and is reflected in hex. Some systems read this offset to determine if all processors support the same default VCCD settings. Writes to this register have no effect.

For example, a voltage of 1.200 VCCD would contain an offset 3D-3Ch value of 1200h.

Offset:	3Dh-3Ch
Bit	Description
15:0	VCCD
	0000h-FFFFh: mV

#### **5.4.8.6 VCCIO: VCCIO**

This field contains the voltage requested for the VccIO pins. This field is in mV and is reflected in hex. Some systems read this offset to determine if all processors support the same default VccIO settings. Writes to this register have no effect.

For example, a voltage of 1.000 VccIO\_IN would contain an offset 3Fh-3Eh value of 1000h.

Offset:	3Fh-3Eh
Bit	Description
15:0	VCCIO
	0000h-FFFFh: mV

#### **5.4.8.7 RES6:** Reserved 6

This location is reserved. Writes to this register have no effect.

Offset:	43h-40h
Bit	Description
31:0	RESERVED
	0000000h-FFFFFFh:

#### 5.4.8.8 CDVCORE: CD Vcc Core

This field contains the voltage requested for the CD Vcc Core pins. This field is in mV and is reflected in hex. Some systems read this offset to determine if all processors support the same default CD Vcc Core settings. Writes to this register have no effect.

For example, a voltage of 1.000 CD Vcc Core would contain an offset 45-44h value of 1000h.



Offset:	45h-44h
Bit	Description
15:0	CD Vcc Core
	0000h-FFFFh: mV

#### 5.4.8.9 CDVCCIN: CD Vcc In

This field contains the voltage requested for the CD Vcc In pins. This field is in mV and is reflected in hex. Some systems read this offset to determine if all processors support the same default CD Vcc In settings. Writes to this register have no effect.

For example, a voltage of 1.000 VccIO\_IN would contain an offset 47-46h value of 1000h.

Offset: 47E-46h	
Bit	Description
15:0	CD Vcc In
	0000h-FFFFh: mV

#### 5.4.8.10 CDVCCP: CD VCCP

This field contains the voltage requested for the CDVCCP pins. This field is in mV and is reflected in hex. Some systems read this offset to determine if all processors support the same default CDVCCP settings. Writes to this register have no effect.

For example, a voltage of 1.000 CDVCCP would contain an offset 49h-48h value of 1000h.

Offset:	49h-48h
Bit	Description
15:0	CDVCCP
	0000h-FFFFh: mV

#### 5.4.8.11 CDVPP: CD VPP

This field contains the voltage requested for the CD VPP pins. This field is in mV and is reflected in hex. Some systems read this offset to determine if all processors support the same default CD VPP settings. Writes to this register have no effect.

For example, a voltage of 1.000 CD VPP would contain an offset 4Bh-4Ah value of 1000h.

Offset:	4B-4Ah
Bit	Description
15:0	CD VPP
	0000h-FFFFh: mV



#### 5.4.8.12 RCVCORE: RC VCORE

This field contains the voltage requested for the RC VCORE pins. This field is in mV and is reflected in hex. Some systems read this offset to determine if all processors support the same default RC VCORE settings. Writes to this register have no effect.

For example, a voltage of 1.000 VCCD would contain an offset 4Dh-4Ch value of 1000h.

Offset:	4Dh-4Ch
Bit	Description
15:0	RC VCORE
	0000h-FFFFh: mV

#### 5.4.8.13 RCVCCH: RC VCCH

This field contains the voltage requested for the RC VCCH pins. This field is in mV and is reflected in hex. Some systems read this offset to determine if all processors support the same default RC VCCH settings. Writes to this register have no effect.

For example, a voltage of  $1.000\ RC\ VCCH$  would contain an offset 4Eh-4Fh value of 1000h.

Offset:	4Fh-4Eh
Bit	Description
15:0	RC VCCH
	0000h-FFFFh: mV

#### 5.4.8.14 RES7: Reserved 7

This location is reserved. Writes to this register have no effect.

Offset:	50h-55h
Bit	Description
39:0	RESERVED
	00000000h-FFFFFFFh: Reserved

#### 5.4.9 Part Number Data

This section provides device traceability.

#### **5.4.9.1 PFN: Processor Family Number**

This location contains seven ASCII characters reflecting the Intel® family number for the processor. This number is the same on all Intel® Xeon® E7 v3 processors. Combined with the Processor SKU Number below, this is the complete processor part number. This information is typically marked on the outside of the processor. If the part number is less than 15 total characters, a leading space is inserted into the value. The part number should match the information found in the marking specification. Writes to this register have no effect.

For example, a processor with a part number of AT80604\*\*\*\*\*\* will have the following data found at offset 5Ch-56h: 41h, 54h, 38h, 30h, 36h, 30h, 34h.



Offset:	5Ch-56h
Bit	Description
55:48	Character 1 ASCII character
	00h-0FFh: ASCII character
47:40	Character 2 ASCII character
	00h-0FFh: ASCII character
39:32	Character 3 ASCII character
	00h-0FFh: ASCII character
31:24	Character 4 ASCII character
	00h-0FFh: ASCII character
23:16	Character 5 ASCII character or 20h
	00h-0FFh: ASCII character
15:8	Character 6 ASCII character or 20h
	00h-0FFh: ASCII character
7:0	Character 7 ASCII character or 20h
	00h-0FFh: ASCII character

#### 5.4.9.2 PSN: Processor SKU Number

This location contains eight ASCII characters reflecting the SKU number for the processor. Added to the end of the Processor Family Number above, this is the complete processor part number. This information is typically marked on the outside of the processor. If the part number is less than 15 total characters, a leading space is inserted into the value. The part number should match the information found in the marking specification. Writes to this register have no effect.

For example, a processor with a part number of \*\*\*\*\*\*\*003771AA will have the following data found at offset 64h-5Dh: 30h, 30h, 33h, 37h, 37h, 31h, 41h.

Offset:	64h-5Dh
Bit	Description
63:56	Character 1 ASCII character
	00h-0FFh: ASCII character
55:48	Character 2 ASCII character
	00h-0FFh: ASCII character
47:40	Character 3 ASCII character
	00h-0FFh: ASCII character



Offset:	64h-5Dh
Bit	Description
39:32	Character 4 ASCII character or 20h
	00h-0FFh: ASCII character
31:24	Character 5 ASCII character or 20h
	00h-0FFh: ASCII character
23:16	Character 6 ASCII character or 20h
	00h-0FFh: ASCII character
15:8	Character 7 ASCII character or 20h
	00h-0FFh: ASCII character
7:0	Character 8 ASCII character
	00h-0FFh: ASCII character

# **5.4.10** Thermal Reference Data

# 5.4.10.1 TCASE: T<sub>CASE</sub> Maximum

This location provides the maximum  $T_{CASE}$  for the processor. The field reflects temperature in degrees Celsius in binary coded decimal format. The thermal specifications are specified at the case Integrated Heat Spreader (IHS). Writes to this register have no effect.

For example, a temperature of 66°C would contain a value of 66h.

Offset:	65h
Bit	Description
7:0	T <sub>CASE</sub> Maximum
	00h-FFh: Degrees Celsius

#### **5.4.10.2 TDP: Thermal Design Power**

This location contains the maximum Thermal Design Power for the part. The field reflects power in watts in binary coded decimal format. Writes to this register have no effect. A zero value means that the value was not programmed.

For example, a 130 W TDP would be saved as 0130h. Offset 67h is 01h and offset 66h is 30h.

Offset:	67h-66h
Bit	Description
15:0	Thermal Design Power
	0000h-FFFFh: Watts



### 5.4.10.3 DTSMAX: Digital Thermal Sensor Maximum

This location provides the Digital Thermal Sensor Maximum temperature for the processor. The field reflects temperature in degrees Celsius in binary coded decimal format. The thermal specifications are specified at the sensor nearest the CPU hot spot. Writes to this register have no effect.

For example, a temperature of 103°C would contain a value of 0103h.

Offset:	69h-68h
Bit	Description
15:0	Digital Thermal Sensor Maximum
	0000h-FFFFh: Degrees Celsius

#### 5.4.10.4 PN: Pn Power Limit

This location contains the maximum Pn power for the part. The field reflects power in watts in binary coded decimal format. Writes to this register have no effect. A zero value means that the value was not programmed.

For example, a 35 W would be saved as 0035h. Offset 6Ah is 00h and offset 69h is 35h.

Offset:	6Ah-69h
Bit	Description
15:0	Pn Power Limit
	0000h-FFFFh: Watts

#### 5.4.11 Feature Data

This section provides information on key features that the platform may need to understand without powering on the processor.

# **5.4.11.1** PCFF: Processor Core Feature Flags

This location contains a copy of results in EDX[31:0] from Function 1 of the CPUID instruction. These details provide instruction and feature support by product family. Writes to this register have no effect.

For example, a value of BFEBFBFFh can be found at offset 6Ch - 6Fh.

Offset:	6Ch-6Fh
Bit	Description
31:0	Processor Core Feature Flags
	0000000h-FFFFFFFF: Feature Flags

#### **5.4.11.2 PFF: Processor Feature Flags**

This location contains additional feature information from the processor. Writes to this register have no effect.



Offset:	71h-	70h
Bit	Byte	Description
	71h	Reserved
		Reserved
7	70h	Reserved
6		Reserved
5		Reserved
4		AEP Enabled
3		TXT Enabled
2		EMCA2 Enabled
1		Turbo Enabled
0		avx512_2ndFMA

Bits are set when a feature is present, and cleared when they are not.

#### 5.4.11.3 MPSUP: Multiprocessor Support

This location contains 2 bits for representing the supported number of physical processors on the bus. These two bits are LSB aligned where 000b equates to non-scalable 1socket (1S) operation, 001b to non-scalable 2 socket (2S), 010b to 4 socket glueless (4S GLULS), 011b to scalable 4 socket (S4S), and 101b scalable 8 socket (S8S). The is a 1S, 2S, 4S GLULS, S4S, or S8S processor. The first six bits in this field are reserved for future use. Writes to this register have no effect.

For example, a scalable 8-socket processor will have a value of 100h at offset 72h.

Offset:	72h
Bit	Description
7:3	RESERVED
	000000b-111111b: Reserved
2:0	Multiprocessor Support 1S, 2S, 4S GLULS, S4S, or S8S indicator
	000b: Nonscalable, 1 Socket 001b: Nonscalable, up to 2 Socket Glueless 010b: Nonscalable, up to 4 Socket Glueless in Ring. 011b: Scalable, up to 4 Socket Glueless Fully Connected. 100b: Reserved 101b: Scalable, up to 8 Socket Glueless



# **5.4.11.4** TCDC: Tap Chain Device Count

At offset 73, a 4-bit hex digit is used to tell how many devices are in the TAP Chain. A Second Generation Intel® Xeon® Scalable Processors with ten cores, this field would be set to Bh.

Offset:	73h
Bit	Description
7:0	TAP Chain Device Count
	0000h-FFFFh: Reserved

#### 5.4.11.5 RES9: Reserved 9

This location is reserved. Writes to this register have no effect.

Offset:	74h-75h
Bit	Description
15:0	RESERVED
	0000h-FFFFh: Reserved

#### 5.4.11.6 STTCKS: Static Checksum

This location provides the checksum of the static values per SKU. Writes to this register have no effect.

Offset:	76h
Bit	Description
7:0	Static Checksum One-byte checksum of the Static Checksum
	00h- FFh: See Section 5.4.13, "Checksums" for calculation of this value.

# **5.4.12** Protected Processor Inventory Number

This section contains the Protected Processor Inventory Number.

#### **5.4.12.1** PPIN: Protected Processor Inventory Number

This location contains a 64-bit identification number. The value in this field is the PPIN number, which will be the same value as the PPIN accessed through the BIOS MSR. Writes to this register have no effect.

Offset:	7Eh-77h
Bit	Description
63:0	PPIN
	00000000000000h-FFFFFFFFFFFFFh: PPIN



#### 5.4.12.2 RES10: Reserved 10

This location is reserved. Writes to this register have no effect.

Offset:	7Fh
Bit	Description
7:0	RESERVED
	00h- FFh: Reserved.

# 5.4.13 Checksums

The PIROM includes checksums. The following table includes the checksum values for each section defined in the 128-byte ROM.

#### Table 5-5. 128-Byte ROM Checksum Values

Section	Checksum Address
Static Features	76h

Checksums are automatically calculated and programmed by Intel. The first step in calculating the checksum is to add each byte from the field to the next subsequent byte. This result is then negated to provide the checksum.

For example, for a byte string of AA445Ch, the resulting checksum will be B6h.

AA = 10101010 44 = 01

44 = 01000100 5C = 01011100

AA + 44 + 5C = 01001010

Negate the sum: 10110101 + 1 = 10110110 (B6h)

§



# A Pin Listing

Table A-1. Pin List By Name (Sheet 1 of 90)

90)			
Pin Name	Locati on	Туре	I/O
BCLK0_DN	AU24	CMOS	I
BCLK0_DP	AW24	CMOS	I
BCLK1_DN	CR26	CMOS	I
BCLK1_DP	CP27	CMOS	I
BCLK2_DN	CT25	CMOS	I
BCLK2_DP	CU26	CMOS	I
BIST_ENABLE	BA20	CMOS	I
BMCINIT	BD23	CMOS	I
BPM_N[0]	AJ10	ODCMOS	I/O
BPM_N[1]	AH11	ODCMOS	I/O
BPM_N[2]	AG10	ODCMOS	I/O
BPM_N[3]	AF11	ODCMOS	I/O
BPM_N[4]	AA12	ODCMOS	I/O
BPM_N[5]	Y11	ODCMOS	I/O
BPM_N[6]	AE12	ODCMOS	I/O
BPM_N[7]	AC12	ODCMOS	I/O
CATERR_N	AL14	ODCMOS	I/O
CD_HFI_REFCLK_DN	BE16	CMOS	I
CD_HFI_REFCLK_DP	BG16	CMOS	I
CD_HFI0_I2CCLK	BN22	ODCMOS	I/O
CD_HFI0_I2CDAT	BP23	ODCMOS	I/O
CD_HFI0_INT_N	BP19	CMOS	I
CD_HFI0_LED_N	BK21	OD	0
CD_HFI0_MODPRST_N	BR20	CMOS	I
CD_HFI0_RESET_N	BN24	OD	0
CD_HFI1_I2CCLK	BJ22	ODCMOS	I/O
CD_HFI1_I2CDAT	BH23	ODCMOS	I/O
CD_HFI1_INT_N	BM21	CMOS	I
CD_HFI1_LED_N	BM23	OD	0
CD_HFI1_MODPRST_N	BT19	CMOS	I
CD_HFI1_RESET_N	BK23	OD	0
CD_PE_REFCLK_DN	BU24	CMOS	I
CD_PE_REFCLK_DP	BW24	CMOS	I
CD_POR_N	CF25		

Table A-1. Pin List By Name (Sheet 2 of 90)

Pin Name	Locati on	Туре	I/O
CD_TCLK	CB23		
CD_TDI	BY21	GTL	I
CD_TDO	CC22	OD	0
CD_TMS	CE24	GTL	I
CD_TRST_N	CD23	GTL	I
CD_VCC_CORE	BD13	PWR	
CD_VCC_CORE	BE12	PWR	
CD_VCC_CORE	BE14	PWR	
CD_VCC_CORE	BF11	PWR	
CD_VCC_CORE	BF13	PWR	
CD_VCC_CORE	BG12	PWR	
CD_VCC_CORE	BG14	PWR	
CD_VCC_CORE	BH13	PWR	
CD_VCC_CORE	BJ12	PWR	
CD_VCC_CORE	BJ14	PWR	
CD_VCC_CORE	BK13	PWR	
CD_VCC_CORE	BK15	PWR	
CD_VCC_CORE	BL14	PWR	
CD_VCC_CORE_SENSE	BN16	PWR	
CD_VCCIN	BT27	PWR	
CD_VCCIN	BU26	PWR	
CD_VCCIN	BV27	PWR	
CD_VCCIN	BY27	PWR	
CD_VCCP	BM11	PWR	
CD_VCCP	BN12	PWR	
CD_VCCP	BN14	PWR	
CD_VCCP	BP11	PWR	
CD_VCCP	BP13	PWR	
CD_VCCP	BP15	PWR	
CD_VCCP	BR12	PWR	
CD_VCCP	BR14	PWR	
CD_VCCP	BT11	PWR	
CD_VCCP	BT13	PWR	
CD_VCCP	BT15	PWR	
CD_VCCP	BU12	PWR	



Table A-1. Pin List By Name (Sheet 3 of 90)

Locati **Pin Name** Type I/O on CD\_VCCP **BU14 PWR** CD\_VCCP **BV11 PWR** CD VCCP BV13 **PWR** CD\_VCCP BV15 PWR CD\_VCCP\_SENSE BT17 **PWR** CD VPP A10 **PWR** CD\_VPP A12 **PWR** CD\_VPP B11 **PWR** CD\_VSS\_VCC\_CORE\_SENSE **BL16 PWR** CD\_VSS\_VCCP\_SENSE **BU16 PWR** DDR0\_ACT\_N J60 SSTL 0 DDR0\_ALERT\_N B61 SSTL DDR0\_BA[0] C52 SSTL 0 G54 SSTL 0 DDR0\_BA[1] DDR0\_BG[0] D61 SSTL 0 DDR0\_BG[1] F63 SSTL 0 DDR0\_CAVREF 0 AJ64 SSTL DDR0\_CID[2] G46 SSTL 0 DDR0\_CKE[0] C62 SSTL 0 0 DDR0\_CKE[1] C64 SSTL DDR0\_CKE[2] B63 0 SSTL DDR0\_CKE[3] D63 SSTL 0 DDR0\_CLK\_DN[0] F55 0 SSTL C54 0 DDR0\_CLK\_DN[1] SSTL DDR0\_CLK\_DN[2] J56 SSTL 0 DDR0\_CLK\_DN[3] C56 SSTL 0 SSTL DDR0\_CLK\_DP[0] D55 0 0 DDR0\_CLK\_DP[1] B55 SSTL DDR0\_CLK\_DP[2] G56 SSTL 0 SSTL DDR0\_CLK\_DP[3] B57 0 0 DDR0\_CS\_N[0] G52 SSTL DDR0\_CS\_N[1] F49 SSTL 0 DDR0\_CS\_N[2] D47 SSTL 0 F47 0 DDR0\_CS\_N[3] SSTL 0 DDR0\_CS\_N[4] B51 SSTL DDR0\_CS\_N[5] D49 SSTL 0 DDR0\_CS\_N[6] F45 SSTL 0 0 DDR0\_CS\_N[7] K45 SSTL DDR0\_DQ[0] AN86 SSTL I/O DDR0\_DQ[1] AN84 SSTL I/O DDR0\_DQ[10] L86 I/O **SSTL** 

Table A-1. Pin List By Name (Sheet 4 of 90)

Pin Name	Locati on	Туре	I/O
DDR0_DQ[11]	L84	SSTL	I/O
DDR0_DQ[12]	AA86	SSTL	I/O
DDR0_DQ[13]	AA84	SSTL	I/O
DDR0_DQ[14]	N86	SSTL	I/O
DDR0_DQ[15]	N84	SSTL	I/O
DDR0_DQ[16]	V81	SSTL	I/O
DDR0_DQ[17]	T79	SSTL	I/O
DDR0_DQ[18]	N82	SSTL	I/O
DDR0_DQ[19]	M81	SSTL	I/O
DDR0_DQ[2]	AE86	SSTL	I/O
DDR0_DQ[20]	W80	SSTL	I/O
DDR0_DQ[21]	V79	SSTL	I/O
DDR0_DQ[22]	R82	SSTL	I/O
DDR0_DQ[23]	N80	SSTL	I/O
DDR0_DQ[24]	L76	SSTL	I/O
DDR0_DQ[25]	R76	SSTL	I/O
DDR0_DQ[26]	M73	SSTL	I/O
DDR0_DQ[27]	P73	SSTL	I/O
DDR0_DQ[28]	M77	SSTL	I/O
DDR0_DQ[29]	P77	SSTL	I/O
DDR0_DQ[3]	AE84	SSTL	I/O
DDR0_DQ[30]	L74	SSTL	I/O
DDR0_DQ[31]	R74	SSTL	I/O
DDR0_DQ[32]	C42	SSTL	I/O
DDR0_DQ[33]	B41	SSTL	I/O
DDR0_DQ[34]	C38	SSTL	I/O
DDR0_DQ[35]	E38	SSTL	I/O
DDR0_DQ[36]	E42	SSTL	I/O
DDR0_DQ[37]	F41	SSTL	I/O
DDR0_DQ[38]	B39	SSTL	I/O
DDR0_DQ[39]	F39	SSTL	I/O
DDR0_DQ[4]	AR86	SSTL	I/O
DDR0_DQ[40]	K37	SSTL	I/O
DDR0_DQ[41]	P37	SSTL	I/O
DDR0_DQ[42]	L34	SSTL	I/O
DDR0_DQ[43]	N34	SSTL	I/O
DDR0_DQ[44]	L38	SSTL	I/O
DDR0_DQ[45]	N38	SSTL	I/O
DDR0_DQ[46]	K35	SSTL	I/O
DDR0_DQ[47]	P35	SSTL	I/O
DDR0_DQ[48]	K31	SSTL	I/O



Table A-1. Pin List By Name (Sheet 5 of 90)

Locati **Pin Name** Type I/O on DDR0\_DQ[49] P31 SSTL I/O DDR0\_DQ[5] AR84 SSTL I/O DDR0 DQ[50] L28 SSTL I/O DDR0\_DQ[51] N28 SSTL I/O L32 SSTL I/O DDR0\_DQ[52] DDR0 DQ[53] N32 SSTL I/O DDR0\_DQ[54] K29 SSTL I/O DDR0\_DQ[55] P29 SSTL I/O DDR0\_DQ[56] K25 SSTL I/O P25 DDR0\_DQ[57] SSTL I/O DDR0\_DQ[58] P23 SSTL I/O DDR0\_DQ[59] T23 **SSTL** I/O DDR0\_DQ[6] AG86 SSTL I/O DDR0\_DQ[60] L26 SSTL I/O DDR0\_DQ[61] N26 **SSTL** I/O DDR0\_DQ[62] H23 SSTL I/O DDR0\_DQ[63] K23 SSTL I/O DDR0\_DQ[7] AG84 SSTL I/O DDR0\_DQ[8] W86 SSTL I/O DDR0\_DQ[9] W84 SSTL I/O DDR0\_DQS\_DN[0] AJ84 SSTL I/O DDR0\_DQS\_DN[1] R84 SSTL I/O DDR0\_DQS\_DN[10] U84 SSTL I/O U82 DDR0\_DQS\_DN[11] SSTL I/O DDR0\_DQS\_DN[12] K75 SSTL I/O DDR0\_DQS\_DN[13] A40 SSTL I/O DDR0\_DQS\_DN[14] J36 SSTL I/O J30 I/O DDR0\_DQS\_DN[15] SSTL DDR0\_DQS\_DN[16] J24 SSTL I/O DDR0\_DQS\_DN[17] **AB67** SSTL I/O P79 SSTL I/O DDR0\_DQS\_DN[2] DDR0\_DQS\_DN[3] T75 SSTL I/O DDR0\_DQS\_DN[4] G40 SSTL I/O DDR0\_DQS\_DN[5] R36 SSTL I/O DDR0\_DQS\_DN[6] R30 SSTL I/O DDR0\_DQS\_DN[7] N24 SSTL I/O DDR0\_DQS\_DN[8] AH67 SSTL I/O DDR0\_DQS\_DN[9] AL84 SSTL I/O DDR0\_DQS\_DP[0] **AH85** SSTL I/O DDR0\_DQS\_DP[1] P85 SSTL I/O DDR0\_DQS\_DP[10] V85 **SSTL** I/O

Table A-1. Pin List By Name (Sheet 6 of 90)

Pin Name	Locati on	Туре	I/O
DDR0_DQS_DP[11]	T81	SSTL	I/O
DDR0_DQS_DP[12]	M75	SSTL	I/O
DDR0_DQS_DP[13]	C40	SSTL	I/O
DDR0_DQS_DP[14]	L36	SSTL	I/O
DDR0_DQS_DP[15]	L30	SSTL	I/O
DDR0_DQS_DP[16]	L24	SSTL	I/O
DDR0_DQS_DP[17]	AD67	SSTL	I/O
DDR0_DQS_DP[2]	R80	SSTL	I/O
DDR0_DQS_DP[3]	P75	SSTL	I/O
DDR0_DQS_DP[4]	E40	SSTL	I/O
DDR0_DQS_DP[5]	N36	SSTL	I/O
DDR0_DQS_DP[6]	N30	SSTL	I/O
DDR0_DQS_DP[7]	R24	SSTL	I/O
DDR0_DQS_DP[8]	AF67	SSTL	I/O
DDR0_DQS_DP[9]	AM85	SSTL	I/O
DDR0_ECC[0]	AC68	SSTL	I/O
DDR0_ECC[1]	AG68	SSTL	I/O
DDR0_ECC[2]	AD65	SSTL	I/O
DDR0_ECC[3]	AF65	SSTL	I/O
DDR0_ECC[4]	AD69	SSTL	I/O
DDR0_ECC[5]	AF69	SSTL	I/O
DDR0_ECC[6]	AC66	SSTL	I/O
DDR0_ECC[7]	AG66	SSTL	I/O
DDR0_MA[0]	F53	SSTL	0
DDR0_MA[1]	F57	SSTL	0
DDR0_MA[10]	J54	SSTL	0
DDR0_MA[11]	G62	SSTL	0
DDR0_MA[12]	J64	SSTL	0
DDR0_MA[13]	J48	SSTL	0
DDR0_MA[14]	F51	SSTL	0
DDR0_MA[15]	K49	SSTL	0
DDR0_MA[16]	D51	SSTL	0
DDR0_MA[17]	K47	SSTL	0
DDR0_MA[2]	D57	SSTL	0
DDR0_MA[3]	C58	SSTL	0
DDR0_MA[4]	G58	SSTL	0
DDR0_MA[5]	F59	SSTL	0
DDR0_MA[6]	D59	SSTL	0
DDR0_MA[7]	G60	SSTL	0
DDR0_MA[8]	C60	SSTL	0
DDR0_MA[9]	F61	SSTL	0



Table A-1. Pin List By Name (Sheet 7 of 90)

Locati **Pin Name** Type I/O on C50 DDR0\_ODT[0] SSTL 0 DDR0\_ODT[1] C48 SSTL 0 DDR0 ODT[2] G50 SSTL 0 G48 0 DDR0\_ODT[3] SSTL DDR0\_PAR D53 SSTL 0 DDR012 DRAM PWR OK AN30 **CMOS** DDR012\_RCOMP[0] Y43 DDR012\_RCOMP[1] **AB43** DDR012\_RCOMP[2] AC42 DDR012\_RESET\_N U64 **CMOS** 0 DDR012\_SPDSCL ODCMOS AJ18 I/O DDR012\_SPDSDA AF17 **ODCMOS** I/O DDR1\_ACT\_N T63 SSTL 0 DDR1\_ALERT\_N W62 SSTL Ι DDR1\_BA[0] T53 SSTL 0 DDR1\_BA[1] K55 SSTL 0 DDR1\_BG[0] M61 0 SSTL DDR1\_BG[1] N60 SSTL 0 DDR1\_CAVREF AK63 SSTL 0 0 DDR1\_CID[2] M47 SSTL DDR1\_CKE[0] 0 N62 SSTL DDR1\_CKE[1] R64 SSTL 0 0 DDR1\_CKE[2] K63 SSTL 0 DDR1\_CKE[3] L64 SSTL DDR1\_CLK\_DN[0] M53 SSTL 0 DDR1\_CLK\_DN[1] R54 SSTL 0 DDR1\_CLK\_DN[2] N56 SSTL 0 0 DDR1\_CLK\_DN[3] R56 SSTL DDR1\_CLK\_DP[0] N54 SSTL 0 SSTL DDR1\_CLK\_DP[1] T55 0 0 DDR1\_CLK\_DP[2] M57 SSTL DDR1\_CLK\_DP[3] T57 SSTL 0 DDR1\_CS\_N[0] K51 SSTL 0 R50 0 DDR1\_CS\_N[1] SSTL 0 DDR1\_CS\_N[2] N46 SSTL DDR1\_CS\_N[3] V47 SSTL 0 DDR1\_CS\_N[4] J50 SSTL 0 0 DDR1\_CS\_N[5] T49 SSTL DDR1\_CS\_N[6] M45 SSTL 0 DDR1\_CS\_N[7] R46 SSTL 0 DDR1\_DQ[0] AV81 SSTL I/O

Table A-1. Pin List By Name (Sheet 8 of 90)

Pin Name	Locati on	Туре	I/O
DDR1_DQ[1]	AT79	SSTL	I/O
DDR1_DQ[10]	AC82	SSTL	I/O
DDR1_DQ[11]	AB81	SSTL	I/O
DDR1_DQ[12]	AJ80	SSTL	I/O
DDR1_DQ[13]	AH79	SSTL	I/O
DDR1_DQ[14]	AE82	SSTL	I/O
DDR1_DQ[15]	AC80	SSTL	I/O
DDR1_DQ[16]	E80	SSTL	I/O
DDR1_DQ[17]	J80	SSTL	I/O
DDR1_DQ[18]	F77	SSTL	I/O
DDR1_DQ[19]	H77	SSTL	I/O
DDR1_DQ[2]	AN82	SSTL	I/O
DDR1_DQ[20]	F81	SSTL	I/O
DDR1_DQ[21]	H81	SSTL	I/O
DDR1_DQ[22]	E78	SSTL	I/O
DDR1_DQ[23]	J78	SSTL	I/O
DDR1_DQ[24]	D75	SSTL	I/O
DDR1_DQ[25]	C74	SSTL	I/O
DDR1_DQ[26]	D71	SSTL	I/O
DDR1_DQ[27]	F71	SSTL	I/O
DDR1_DQ[28]	F75	SSTL	I/O
DDR1_DQ[29]	G74	SSTL	I/O
DDR1_DQ[3]	AM81	SSTL	I/O
DDR1_DQ[30]	C72	SSTL	I/O
DDR1_DQ[31]	G72	SSTL	I/O
DDR1_DQ[32]	K43	SSTL	I/O
DDR1_DQ[33]	H43	SSTL	I/O
DDR1_DQ[34]	L40	SSTL	I/O
DDR1_DQ[35]	N40	SSTL	I/O
DDR1_DQ[36]	P43	SSTL	I/O
DDR1_DQ[37]	T43	SSTL	I/O
DDR1_DQ[38]	K41	SSTL	I/O
DDR1_DQ[39]	P41	SSTL	I/O
DDR1_DQ[4]	AW80	SSTL	I/O
DDR1_DQ[40]	C36	SSTL	I/O
DDR1_DQ[41]	B35	SSTL	I/O
DDR1_DQ[42]	C32	SSTL	I/O
DDR1_DQ[43]	E32	SSTL	I/O
DDR1_DQ[44]	E36	SSTL	I/O
DDR1_DQ[45]	F35	SSTL	I/O
DDR1_DQ[46]	B33	SSTL	I/O



Table A-1. Pin List By Name (Sheet 9 of 90)

Locati **Pin Name** Type I/O on DDR1\_DQ[47] F33 SSTL I/O DDR1\_DQ[48] C30 SSTL I/O DDR1\_DQ[49] B29 SSTL I/O DDR1\_DQ[5] AV79 SSTL I/O I/O DDR1\_DQ[50] C26 SSTL DDR1 DQ[51] E26 SSTL I/O DDR1\_DQ[52] E30 SSTL I/O DDR1\_DQ[53] F29 SSTL I/O DDR1\_DQ[54] B27 SSTL I/O DDR1\_DQ[55] F27 SSTL I/O DDR1\_DQ[56] U28 SSTL I/O DDR1\_DQ[57] AA28 **SSTL** I/O DDR1\_DQ[58] V25 SSTL I/O Y25 SSTL I/O DDR1\_DQ[59] DDR1\_DQ[6] AR82 **SSTL** I/O DDR1\_DQ[60] V29 SSTL I/O DDR1\_DQ[61] Y29 SSTL I/O DDR1\_DQ[62] U26 SSTL I/O DDR1\_DQ[63] AA26 SSTL I/O DDR1\_DQ[7] AN80 SSTL I/O SSTL AH81 DDR1\_DQ[8] I/O DDR1\_DQ[9] AF79 SSTL I/O DDR1\_DQS\_DN[0] AP79 SSTL I/O AD79 SSTL DDR1\_DQS\_DN[1] I/O DDR1\_DQS\_DN[10] AG82 SSTL I/O DDR1\_DQS\_DN[11] D79 SSTL I/O DDR1\_DQS\_DN[12] B73 SSTL I/O DDR1\_DQS\_DN[13] I/O J42 SSTL DDR1\_DQS\_DN[14] A34 SSTL I/O DDR1\_DQS\_DN[15] A28 SSTL I/O SSTL I/O DDR1\_DQS\_DN[16] T27 DDR1\_DQS\_DN[17] G68 SSTL I/O DDR1\_DQS\_DN[2] K79 SSTL I/O DDR1\_DQS\_DN[3] H73 SSTL I/O DDR1\_DQS\_DN[4] N42 SSTL I/O DDR1\_DQS\_DN[5] G34 SSTL I/O DDR1\_DQS\_DN[6] G28 SSTL I/O DDR1\_DQS\_DN[7] AB27 SSTL I/O DDR1\_DQS\_DN[8] N68 SSTL I/O DDR1\_DQS\_DN[9] AU82 SSTL I/O DDR1\_DQS\_DP[0] AR80 SSTL I/O

Table A-1. Pin List By Name (Sheet 10 of 90)

Pin Name	Locati on	Туре	I/O
DDR1_DQS_DP[1]	AE80	SSTL	I/O
DDR1_DQS_DP[10]	AF81	SSTL	I/O
DDR1_DQS_DP[11]	F79	SSTL	I/O
DDR1_DQS_DP[12]	D73	SSTL	I/O
DDR1_DQS_DP[13]	L42	SSTL	I/O
DDR1_DQS_DP[14]	C34	SSTL	I/O
DDR1_DQS_DP[15]	C28	SSTL	I/O
DDR1_DQS_DP[16]	V27	SSTL	I/O
DDR1_DQS_DP[17]	J68	SSTL	I/O
DDR1_DQS_DP[2]	H79	SSTL	I/O
DDR1_DQS_DP[3]	F73	SSTL	I/O
DDR1_DQS_DP[4]	R42	SSTL	I/O
DDR1_DQS_DP[5]	E34	SSTL	I/O
DDR1_DQS_DP[6]	E28	SSTL	I/O
DDR1_DQS_DP[7]	Y27	SSTL	I/O
DDR1_DQS_DP[8]	L68	SSTL	I/O
DDR1_DQS_DP[9]	AT81	SSTL	I/O
DDR1_ECC[0]	J70	SSTL	I/O
DDR1_ECC[1]	H69	SSTL	I/O
DDR1_ECC[2]	J66	SSTL	I/O
DDR1_ECC[3]	L66	SSTL	I/O
DDR1_ECC[4]	L70	SSTL	I/O
DDR1_ECC[5]	M69	SSTL	I/O
DDR1_ECC[6]	H67	SSTL	I/O
DDR1_ECC[7]	M67	SSTL	I/O
DDR1_MA[0]	J52	SSTL	0
DDR1_MA[1]	J58	SSTL	0
DDR1_MA[10]	M55	SSTL	0
DDR1_MA[11]	R60	SSTL	0
DDR1_MA[12]	T61	SSTL	0
DDR1_MA[13]	M51	SSTL	0
DDR1_MA[14]	T51	SSTL	0
DDR1_MA[15]	N52	SSTL	0
DDR1_MA[16]	R52	SSTL	0
DDR1_MA[17]	N48	SSTL	0
DDR1_MA[2]	K57	SSTL	0
DDR1_MA[3]	N58	SSTL	0
DDR1_MA[4]	M59	SSTL	0
DDR1_MA[5]	R58	SSTL	0
DDR1_MA[6]	T59	SSTL	0
DDR1_MA[7]	V61	SSTL	0



Table A-1. Pin List By Name (Sheet 11 of 90)

Locati **Pin Name** Type I/O on DDR1\_MA[8] W60 SSTL 0 DDR1\_MA[9] K59 SSTL 0 DDR1\_ODT[0] N50 SSTL 0 0 DDR1\_ODT[1] R48 SSTL DDR1\_ODT[2] M49 SSTL 0 DDR1\_ODT[3] T47 SSTL 0 DDR1\_PAR K53 SSTL 0 DDR2\_ACT\_N AB61 SSTL 0 DDR2\_ALERT\_N AD61 SSTL 0 DDR2\_BA[0] W52 SSTL DDR2\_BA[1] AE56 SSTL 0 DDR2\_BG[0] AA60 SSTL 0 DDR2\_BG[1] AE62 SSTL 0 DDR2\_CAVREF SSTL 0 AH63 DDR2\_CID[2] **AB45** SSTL 0 DDR2\_CKE[0] AA62 SSTL 0 DDR2\_CKE[1] 0 AD63 SSTL DDR2\_CKE[2] V63 SSTL 0 DDR2\_CKE[3] **AB63** SSTL 0 DDR2\_CLK\_DN[0] AA54 SSTL 0 W54 DDR2\_CLK\_DN[1] 0 SSTL DDR2\_CLK\_DN[2] AA56 SSTL 0 DDR2\_CLK\_DN[3] 0 W56 SSTL 0 DDR2\_CLK\_DP[0] **AB55** SSTL DDR2\_CLK\_DP[1] V55 SSTL 0 DDR2\_CLK\_DP[2] AB57 SSTL 0 DDR2\_CLK\_DP[3] V57 SSTL 0 0 DDR2\_CS\_N[0] V51 SSTL DDR2\_CS\_N[1] AB49 SSTL 0 SSTL DDR2\_CS\_N[2] W46 0 0 DDR2\_CS\_N[3] **AA46** SSTL DDR2\_CS\_N[4] AB51 SSTL 0 DDR2\_CS\_N[5] W48 SSTL 0 T45 0 DDR2\_CS\_N[6] SSTL 0 DDR2\_CS\_N[7] V45 SSTL DDR2\_DQ[0] AR76 SSTL I/O DDR2\_DQ[1] AN74 SSTL I/O DDR2\_DQ[10] Y77 SSTL I/O DDR2\_DQ[11] W76 SSTL I/O DDR2\_DQ[12] AF75 SSTL I/O DDR2\_DQ[13] I/O AE74 SSTL

Table A-1. Pin List By Name (Sheet 12 of 90)

Pin Name	Locati on	Туре	I/O
DDR2_DQ[14]	AB77	SSTL	I/O
DDR2_DQ[15]	Y75	SSTL	I/O
DDR2_DQ[16]	W72	SSTL	I/O
DDR2_DQ[17]	AA70	SSTL	I/O
DDR2_DQ[18]	R70	SSTL	I/O
DDR2_DQ[19]	T69	SSTL	I/O
DDR2_DQ[2]	AK77	SSTL	I/O
DDR2_DQ[20]	AA72	SSTL	I/O
DDR2_DQ[21]	AB71	SSTL	I/O
DDR2_DQ[22]	T71	SSTL	I/O
DDR2_DQ[23]	V69	SSTL	I/O
DDR2_DQ[24]	AM67	SSTL	I/O
DDR2_DQ[25]	AT67	SSTL	I/O
DDR2_DQ[26]	AN64	SSTL	I/O
DDR2_DQ[27]	AR64	SSTL	I/O
DDR2_DQ[28]	AN68	SSTL	I/O
DDR2_DQ[29]	AR68	SSTL	I/O
DDR2_DQ[3]	AJ76	SSTL	I/O
DDR2_DQ[30]	AM65	SSTL	I/O
DDR2_DQ[31]	AT65	SSTL	I/O
DDR2_DQ[32]	U40	SSTL	I/O
DDR2_DQ[33]	AA40	SSTL	I/O
DDR2_DQ[34]	V37	SSTL	I/O
DDR2_DQ[35]	Y37	SSTL	I/O
DDR2_DQ[36]	V41	SSTL	I/O
DDR2_DQ[37]	Y41	SSTL	I/O
DDR2_DQ[38]	U38	SSTL	I/O
DDR2_DQ[39]	AA38	SSTL	I/O
DDR2_DQ[4]	AT75	SSTL	I/O
DDR2_DQ[40]	U34	SSTL	I/O
DDR2_DQ[41]	AA34	SSTL	I/O
DDR2_DQ[42]	V31	SSTL	I/O
DDR2_DQ[43]	Y31	SSTL	I/O
DDR2_DQ[44]	V35	SSTL	I/O
DDR2_DQ[45]	Y35	SSTL	I/O
DDR2_DQ[46]	U32	SSTL	I/O
DDR2_DQ[47]	AA32	SSTL	I/O
DDR2_DQ[48]	AD31	SSTL	I/O
DDR2_DQ[49]	AH31	SSTL	I/O
DDR2_DQ[5]	AR74	SSTL	I/O
DDR2_DQ[50]	AE28	SSTL	I/O
DDR2_DQ[31]  DDR2_DQ[32]  DDR2_DQ[33]  DDR2_DQ[34]  DDR2_DQ[35]  DDR2_DQ[36]  DDR2_DQ[37]  DDR2_DQ[38]  DDR2_DQ[39]  DDR2_DQ[4]  DDR2_DQ[40]  DDR2_DQ[41]  DDR2_DQ[42]  DDR2_DQ[42]  DDR2_DQ[43]  DDR2_DQ[44]  DDR2_DQ[45]  DDR2_DQ[45]  DDR2_DQ[47]  DDR2_DQ[48]  DDR2_DQ[49]  DDR2_DQ[5]	AT65 U40 AA40 V37 Y37 V41 Y41 U38 AA38 AT75 U34 AA34 V31 Y31 V35 Y35 U32 AA32 AD31 AH31 AR74	SSTL  SSTL	I/O



Table A-1. Pin List By Name (Sheet 13 of 90)

Locati **Pin Name** Type I/O on DDR2\_DQ[51] AG28 SSTL I/O DDR2\_DQ[52] AE32 SSTL I/O DDR2 DQ[53] AG32 SSTL I/O DDR2\_DQ[54] AD29 SSTL I/O I/O DDR2\_DQ[55] AH29 SSTL DDR2 DQ[56] AD25 SSTL I/O DDR2\_DQ[57] AH25 SSTL I/O DDR2\_DQ[58] AE22 SSTL I/O DDR2\_DQ[59] AG22 SSTL I/O DDR2\_DQ[6] AM77 SSTL I/O DDR2\_DQ[60] AE26 SSTL I/O DDR2\_DQ[61] AG26 **SSTL** I/O DDR2\_DQ[62] AD23 SSTL I/O AH23 SSTL I/O DDR2\_DQ[63] DDR2\_DQ[7] AK75 **SSTL** I/O DDR2\_DQ[8] AE76 SSTL I/O DDR2\_DQ[9] AC74 SSTL I/O DDR2\_DQS\_DN[0] AL74 SSTL I/O DDR2\_DQS\_DN[1] AA74 SSTL I/O DDR2\_DQS\_DN[10] AD77 SSTL I/O SSTL U72 DDR2\_DQS\_DN[11] I/O DDR2\_DQS\_DN[12] AL66 SSTL I/O DDR2\_DQS\_DN[13] T39 SSTL I/O SSTL DDR2\_DQS\_DN[14] T33 I/O DDR2\_DQS\_DN[15] AC30 SSTL I/O DDR2\_DQS\_DN[16] AC24 SSTL I/O SSTL DDR2\_DQS\_DN[17] AT71 I/O DDR2\_DQS\_DN[2] Y69 SSTL I/O DDR2\_DQS\_DN[3] AU66 SSTL I/O DDR2\_DQS\_DN[4] **AB39** SSTL I/O I/O DDR2\_DQS\_DN[5] **AB33** SSTL DDR2\_DQS\_DN[6] AJ30 SSTL I/O DDR2\_DQS\_DN[7] AJ24 SSTL I/O BB71 SSTL I/O DDR2\_DQS\_DN[8] DDR2\_DQS\_DN[9] AP77 SSTL I/O DDR2\_DQS\_DP[0] AM75 SSTL I/O DDR2\_DQS\_DP[1] **AB75** SSTL I/O DDR2\_DQS\_DP[10] AC76 SSTL I/O DDR2\_DQS\_DP[11] V71 SSTL I/O DDR2\_DQS\_DP[12] AN66 SSTL I/O

Table A-1. Pin List By Name (Sheet 14 of 90)

Pin Name	Locati on	Туре	I/O
DDR2_DQS_DP[14]	V33	SSTL	I/O
DDR2_DQS_DP[15]	AE30	SSTL	I/O
DDR2_DQS_DP[16]	AE24	SSTL	I/O
DDR2_DQS_DP[17]	AV71	SSTL	I/O
DDR2_DQS_DP[2]	W70	SSTL	I/O
DDR2_DQS_DP[3]	AR66	SSTL	I/O
DDR2_DQS_DP[4]	Y39	SSTL	I/O
DDR2_DQS_DP[5]	Y33	SSTL	I/O
DDR2_DQS_DP[6]	AG30	SSTL	I/O
DDR2_DQS_DP[7]	AG24	SSTL	I/O
DDR2_DQS_DP[8]	AY71	SSTL	I/O
DDR2_DQS_DP[9]	AN76	SSTL	I/O
DDR2_ECC[0]	AU72	SSTL	I/O
DDR2_ECC[1]	BA72	SSTL	I/O
DDR2_ECC[2]	AV69	SSTL	I/O
DDR2_ECC[3]	AY69	SSTL	I/O
DDR2_ECC[4]	AV73	SSTL	I/O
DDR2_ECC[5]	AY73	SSTL	I/O
DDR2_ECC[6]	AU70	SSTL	I/O
DDR2_ECC[7]	BA70	SSTL	I/O
DDR2_MA[0]	AB53	SSTL	0
DDR2_MA[1]	AE58	SSTL	0
DDR2_MA[10]	AD55	SSTL	0
DDR2_MA[11]	AG60	SSTL	0
DDR2_MA[12]	AG62	SSTL	0
DDR2_MA[13]	AD53	SSTL	0
DDR2_MA[14]	W50	SSTL	0
DDR2_MA[15]	AE54	SSTL	0
DDR2_MA[16]	AA52	SSTL	0
DDR2_MA[17]	AC46	SSTL	0
DDR2_MA[2]	AD57	SSTL	0
DDR2_MA[3]	W58	SSTL	0
DDR2_MA[4]	AA58	SSTL	0
DDR2_MA[5]	V59	SSTL	0
DDR2_MA[6]	AB59	SSTL	0
DDR2_MA[7]	AE60	SSTL	0
DDR2_MA[8]	AD59	SSTL	0
DDR2_MA[9]	AG58	SSTL	0
DDR2_ODT[0]	AA50	SSTL	0
DDR2_ODT[1]	AA48	SSTL	0
DDR2_ODT[2]	V49	SSTL	0

V39

SSTL

I/O

DDR2\_DQS\_DP[13]



Table A-1. Pin List By Name (Sheet 15 of 90)

Locati **Pin Name** Type I/O on SSTL DDR2\_ODT[3] AB47 0 DDR2\_PAR V53 SSTL 0 DDR3 ACT N DW60 SSTL 0 DDR3\_ALERT\_N Ι ED63 SSTL DDR3\_BA[0] EE52 SSTL 0 DDR3 BA[1] EA54 SSTL 0 DDR3\_BG[0] ED61 SSTL 0 DDR3\_BG[1] DW62 SSTL 0 DDR3\_CAVREF CP61 SSTL 0 0 DDR3\_CID[2] DV47 SSTL DDR3\_CKE[0] EE62 SSTL 0 DDR3\_CKE[1] EF63 SSTL 0 DDR3\_CKE[2] EA62 SSTL 0 DDR3\_CKE[3] EB63 SSTL 0 DDR3\_CLK\_DN[0] ED55 SSTL 0 DDR3\_CLK\_DN[1] EF55 SSTL 0 DDR3\_CLK\_DN[2] 0 **DW56** SSTL DDR3\_CLK\_DN[3] EF57 SSTL 0 DDR3\_CLK\_DP[0] EB55 SSTL 0 DDR3\_CLK\_DP[1] EE54 SSTL 0 DDR3\_CLK\_DP[2] 0 EA56 SSTL DDR3\_CLK\_DP[3] EE56 SSTL 0 0 DDR3\_CS\_N[0] EF51 SSTL 0 DDR3\_CS\_N[1] ED49 SSTL DDR3\_CS\_N[2] ED47 SSTL 0 DDR3\_CS\_N[3] EB47 SSTL 0 DDR3\_CS\_N[4] EB51 SSTL 0 SSTL 0 DDR3\_CS\_N[5] EB49 DDR3\_CS\_N[6] DV45 SSTL 0 DDR3\_CS\_N[7] EB45 SSTL 0 DDR3\_DQ[0] CN84 SSTL I/O DDR3\_DQ[1] CN86 SSTL I/O DDR3\_DQ[10] DV83 SSTL I/O I/O DDR3\_DQ[11] DY83 SSTL DDR3\_DQ[12] DD85 SSTL I/O DDR3\_DQ[13] DE84 SSTL I/O DDR3\_DQ[14] **DR84** SSTL I/O DDR3\_DQ[15] **DV85** SSTL I/O DDR3\_DQ[16] DM79 SSTL I/O DDR3\_DQ[17] DK81 SSTL I/O DDR3\_DQ[18] I/O DT81 SSTL

Table A-1. Pin List By Name (Sheet 16 of 90)

Pin Name	Locati on	Туре	I/O
DDR3_DQ[19]	DR82	SSTL	I/O
DDR3_DQ[2]	DA86	SSTL	I/O
DDR3_DQ[20]	DK79	SSTL	I/O
DDR3_DQ[21]	DJ80	SSTL	I/O
DDR3_DQ[22]	DR80	SSTL	I/O
DDR3_DQ[23]	DN82	SSTL	I/O
DDR3_DQ[24]	DN76	SSTL	I/O
DDR3_DQ[25]	DU76	SSTL	I/O
DDR3_DQ[26]	DP73	SSTL	I/O
DDR3_DQ[27]	DT73	SSTL	I/O
DDR3_DQ[28]	DP77	SSTL	I/O
DDR3_DQ[29]	DT77	SSTL	I/O
DDR3_DQ[3]	DA84	SSTL	I/O
DDR3_DQ[30]	DN74	SSTL	I/O
DDR3_DQ[31]	DU74	SSTL	I/O
DDR3_DQ[32]	EC40	SSTL	I/O
DDR3_DQ[33]	ED39	SSTL	I/O
DDR3_DQ[34]	EA36	SSTL	I/O
DDR3_DQ[35]	EC36	SSTL	I/O
DDR3_DQ[36]	DY39	SSTL	I/O
DDR3_DQ[37]	EA40	SSTL	I/O
DDR3_DQ[38]	DY37	SSTL	I/O
DDR3_DQ[39]	ED37	SSTL	I/O
DDR3_DQ[4]	CL84	SSTL	I/O
DDR3_DQ[40]	DN36	SSTL	I/O
DDR3_DQ[41]	DU36	SSTL	I/O
DDR3_DQ[42]	DP33	SSTL	I/O
DDR3_DQ[43]	DT33	SSTL	I/O
DDR3_DQ[44]	DP37	SSTL	I/O
DDR3_DQ[45]	DT37	SSTL	I/O
DDR3_DQ[46]	DN34	SSTL	I/O
DDR3_DQ[47]	DU34	SSTL	I/O
DDR3_DQ[48]	DN30	SSTL	I/O
DDR3_DQ[49]	DU30	SSTL	I/O
DDR3_DQ[5]	CL86	SSTL	I/O
DDR3_DQ[50]	DP27	SSTL	I/O
DDR3_DQ[51]	DT27	SSTL	I/O
DDR3_DQ[52]	DP31	SSTL	I/O
DDR3_DQ[53]	DT31	SSTL	I/O
DDR3_DQ[54]	DN28	SSTL	I/O
DDR3_DQ[55]	DU28	SSTL	I/O



Table A-1. Pin List By Name (Sheet 17 of 90)

Locati **Pin Name** Type I/O on DDR3\_DQ[56] DN24 SSTL I/O DDR3\_DQ[57] DU24 SSTL I/O DDR3 DQ[58] DY21 SSTL I/O DDR3\_DQ[59] EB21 SSTL I/O I/O DDR3\_DQ[6] CW86 SSTL DDR3 DQ[60] DP25 SSTL I/O DDR3\_DQ[61] DT25 SSTL I/O DDR3\_DQ[62] EC22 SSTL I/O DDR3\_DQ[63] DW22 SSTL I/O DDR3\_DQ[7] CW84 SSTL I/O DDR3\_DQ[8] DG84 SSTL I/O DDR3\_DQ[9] DH85 **SSTL** I/O DDR3\_DQS\_DN[0] CU84 SSTL I/O DDR3\_DQS\_DN[1] DN84 SSTL I/O DDR3\_DQS\_DN[10] DM85 SSTL I/O DDR3\_DQS\_DN[11] **DN80** SSTL I/O SSTL DDR3\_DQS\_DN[12] DP75 I/O DDR3\_DQS\_DN[13] EA38 SSTL I/O DDR3\_DQS\_DN[14] DP35 SSTL I/O DDR3\_DQS\_DN[15] DM29 SSTL I/O SSTL DM23 DDR3\_DQS\_DN[16] I/O DDR3\_DQS\_DN[17] **DB67** SSTL I/O DDR3\_DQS\_DN[2] DL82 SSTL I/O DV75 DDR3\_DQS\_DN[3] SSTL I/O DDR3\_DQS\_DN[4] EE38 SSTL I/O DDR3\_DQS\_DN[5] DV35 SSTL I/O SSTL DDR3\_DQS\_DN[6] DV29 I/O I/O DDR3\_DQS\_DN[7] DV23 SSTL DDR3\_DQS\_DN[8] DF67 SSTL I/O DDR3\_DQS\_DN[9] **CR84** SSTL I/O I/O DDR3\_DQS\_DP[0] CV85 SSTL DDR3\_DQS\_DP[1] DP85 SSTL I/O DDR3\_DQS\_DP[10] **DL84** SSTL I/O DDR3\_DQS\_DP[11] DP79 SSTL I/O DDR3\_DQS\_DP[12] DM75 SSTL I/O DDR3\_DQS\_DP[13] DW38 SSTL I/O DDR3\_DQS\_DP[14] DM35 SSTL I/O DDR3\_DQS\_DP[15] DP29 SSTL I/O DDR3\_DQS\_DP[16] DP23 SSTL I/O DDR3\_DQS\_DP[17] CY67 SSTL I/O DDR3\_DQS\_DP[2] DM81 SSTL I/O

Table A-1. Pin List By Name (Sheet 18 of 90)

Pin Name	Locati on	Туре	I/O
DDR3_DQS_DP[3]	DT75	SSTL	I/O
DDR3_DQS_DP[4]	EC38	SSTL	I/O
DDR3_DQS_DP[5]	DT35	SSTL	I/O
DDR3_DQS_DP[6]	DT29	SSTL	I/O
DDR3_DQS_DP[7]	DT23	SSTL	I/O
DDR3_DQS_DP[8]	DD67	SSTL	I/O
DDR3_DQS_DP[9]	CP85	SSTL	I/O
DDR3_ECC[0]	DA68	SSTL	I/O
DDR3_ECC[1]	DE68	SSTL	I/O
DDR3_ECC[2]	DB65	SSTL	I/O
DDR3_ECC[3]	DD65	SSTL	I/O
DDR3_ECC[4]	DB69	SSTL	I/O
DDR3_ECC[5]	DD69	SSTL	I/O
DDR3_ECC[6]	DA66	SSTL	I/O
DDR3_ECC[7]	DE66	SSTL	I/O
DDR3_MA[0]	EB53	SSTL	0
DDR3_MA[1]	ED57	SSTL	0
DDR3_MA[10]	DW54	SSTL	0
DDR3_MA[11]	EB61	SSTL	0
DDR3_MA[12]	DT63	SSTL	0
DDR3_MA[13]	DW48	SSTL	0
DDR3_MA[14]	ED51	SSTL	0
DDR3_MA[15]	DV49	SSTL	0
DDR3_MA[16]	EA52	SSTL	0
DDR3_MA[17]	EA46	SSTL	0
DDR3_MA[2]	EE58	SSTL	0
DDR3_MA[3]	EB57	SSTL	0
DDR3_MA[4]	ED59	SSTL	0
DDR3_MA[5]	EA58	SSTL	0
DDR3_MA[6]	EE60	SSTL	0
DDR3_MA[7]	EA60	SSTL	0
DDR3_MA[8]	EB59	SSTL	0
DDR3_MA[9]	EF61	SSTL	0
DDR3_ODT[0]	EE50	SSTL	0
DDR3_ODT[1]	EE48	SSTL	0
DDR3_ODT[2]	EA50	SSTL	0
DDR3_ODT[3]	EA48	SSTL	0
DDR3_PAR	ED53	SSTL	0
DDR345_DRAM_PWR_OK	CR28	CMOS	I
DDR345_RCOMP[0]	DC48		
DDR345_RCOMP[1]	DD47		



Table A-1. Pin List By Name (Sheet 19 of 90)

Locati **Pin Name** Type I/O on DDR345\_RCOMP[2] DD49 DDR345\_RESET\_N **DV63 CMOS** 0 DDR345 SPDSCL AE18 **ODCMOS** I/O DDR345\_SPDSDA AD17 **ODCMOS** I/O DDR4\_ACT\_N DR62 SSTL 0 DDR4 ALERT N DT61 SSTL DDR4\_BA[0] DM53 SSTL 0 DDR4\_BA[1] DV55 SSTL 0 DDR4\_BG[0] DJ62 SSTL 0 0 DDR4\_BG[1] DM61 SSTL DDR4\_CAVREF CT61 SSTL 0 DDR4\_CID[2] DT47 SSTL 0 DDR4\_CKE[0] DM63 0 SSTL DDR4\_CKE[1] SSTL 0 DN64 DDR4\_CKE[2] DL64 SSTL 0 DDR4\_CKE[3] DR64 SSTL 0 DDR4\_CLK\_DN[0] 0 DM55 SSTL DDR4\_CLK\_DN[1] DR54 SSTL 0 DDR4\_CLK\_DN[2] DM57 SSTL 0 DDR4\_CLK\_DN[3] DT57 SSTL 0 DDR4\_CLK\_DP[0] 0 DN54 SSTL DDR4\_CLK\_DP[1] DT53 SSTL 0 0 DDR4\_CLK\_DP[2] DN56 SSTL 0 DDR4\_CLK\_DP[3] DR56 SSTL DDR4\_CS\_N[0] DV51 SSTL 0 DDR4\_CS\_N[1] DN50 SSTL 0 DR46 DDR4\_CS\_N[2] SSTL 0 0 DDR4\_CS\_N[3] SSTL DK47 DDR4\_CS\_N[4] DW50 SSTL 0 DDR4\_CS\_N[5] DM49 SSTL 0 0 DT45 DDR4\_CS\_N[6] SSTL DDR4\_CS\_N[7] DN46 SSTL 0 DDR4\_DQ[0] CM79 SSTL I/O I/O DDR4\_DQ[1] CK81 SSTL DDR4\_DQ[10] **DE80** SSTL I/O DDR4\_DQ[11] DF81 SSTL I/O DDR4\_DQ[12] CY79 SSTL I/O DDR4\_DQ[13] CW80 SSTL I/O DDR4\_DQ[14] SSTL I/O DC82 DDR4\_DQ[15] DE82 I/O SSTI DDR4\_DQ[16] I/O **DW80** SSTL

Table A-1. Pin List By Name (Sheet 20 of 90)

DDR4_DQ[17]         EC80         SSTL         I/O           DDR4_DQ[18]         DY77         SSTL         I/O           DDR4_DQ[19]         EB77         SSTL         I/O           DDR4_DQ[2]         CT81         SSTL         I/O           DDR4_DQ[20]         DY81         SSTL         I/O           DDR4_DQ[21]         EB81         SSTL         I/O           DDR4_DQ[22]         DW78         SSTL         I/O           DDR4_DQ[23]         EC78         SSTL         I/O           DDR4_DQ[23]         EC78         SSTL         I/O           DDR4_DQ[24]         ED75         SSTL         I/O           DDR4_DQ[25]         EE74         SSTL         I/O           DDR4_DQ[26]         EB71         SSTL         I/O           DDR4_DQ[27]         ED71         SSTL         I/O           DDR4_DQ[28]         EA74         SSTL         I/O           DDR4_DQ[29]         EB75         SSTL         I/O           DDR4_DQ[3]         CR82         SSTL         I/O           DDR4_DQ[3]         EC82         SSTL         I/O           DDR4_DQ[31]         EE72         SSTL         I/O	Pin Name	Locati	Туре	I/O
DDR4_DQ[18]   DY77   SSTL   I/O				
DDR4_DQ[2]   EB77   SSTL   I/O				
DDR4_DQ[2]  DDR4_DQ[20]  DDR4_DQ[21]  DDR4_DQ[21]  EB81 SSTL I/O  DDR4_DQ[22]  DW78 SSTL I/O  DDR4_DQ[23]  EC78 SSTL I/O  DDR4_DQ[23]  EC78 SSTL I/O  DDR4_DQ[24]  ED75 SSTL I/O  DDR4_DQ[25]  EE74 SSTL I/O  DDR4_DQ[25]  EE74 SSTL I/O  DDR4_DQ[26]  EB71 SSTL I/O  DDR4_DQ[27]  ED71 SSTL I/O  DDR4_DQ[28]  EA74 SSTL I/O  DDR4_DQ[29]  EB75 SSTL I/O  DDR4_DQ[3]  CR82 SSTL I/O  DDR4_DQ[3]  CR82 SSTL I/O  DDR4_DQ[3]  DDR4_DQ[3]  EE72 SSTL I/O  DDR4_DQ[3]  DDR4_DQ[4]  CK79 SSTL I/O  DDR4_DQ[4]  CK79 SSTL I/O  DDR4_DQ[4]  DDR4_DQ[4]  EC34 SSTL I/O  DDR4_DQ[4]  DDR4_DQ[4]  DDR4_DQ[4]  EC34 SSTL I/O  DDR4_DQ[4]  ED33 SSTL I/O  DDR4_DQ[4]  DDR4_DQ[4]  DDR4_DQ[4]  DDR4_DQ[4]  EA30 SSTL I/O  DDR4_DQ[4]  DDR4_DQ[5]  EC24 SSTL I/O  DDR4_DQ[5]  DDR4_DQ[5]  DDR4_DQ[5]  EC24 SSTL I/O				
DDR4_DQ[20]   DY81   SSTL   I/O				
DDR4_DQ[21]         EB81         SSTL         I/O           DDR4_DQ[22]         DW78         SSTL         I/O           DDR4_DQ[23]         EC78         SSTL         I/O           DDR4_DQ[24]         ED75         SSTL         I/O           DDR4_DQ[25]         EE74         SSTL         I/O           DDR4_DQ[26]         EB71         SSTL         I/O           DDR4_DQ[27]         ED71         SSTL         I/O           DDR4_DQ[28]         EA74         SSTL         I/O           DDR4_DQ[29]         EB75         SSTL         I/O           DDR4_DQ[3]         CR82         SSTL         I/O           DDR4_DQ[3]         CR82         SSTL         I/O           DDR4_DQ[30]         EA72         SSTL         I/O           DDR4_DQ[31]         EE72         SSTL         I/O           DDR4_DQ[31]         DW42         SSTL         I/O           DDR4_DQ[32]         DU42         SSTL         I/O           DDR4_DQ[33]         DW42         SSTL         I/O           DDR4_DQ[35]         DT39         SSTL         I/O           DDR4_DQ[35]         DN42         SSTL         I/O				
DDR4_DQ[22]				
DDR4_DQ[23] EC78 SSTL I/O  DDR4_DQ[24] ED75 SSTL I/O  DDR4_DQ[25] EE74 SSTL I/O  DDR4_DQ[26] EB71 SSTL I/O  DDR4_DQ[27] ED71 SSTL I/O  DDR4_DQ[28] EA74 SSTL I/O  DDR4_DQ[28] EA74 SSTL I/O  DDR4_DQ[29] EB75 SSTL I/O  DDR4_DQ[3] CR82 SSTL I/O  DDR4_DQ[30] EA72 SSTL I/O  DDR4_DQ[31] EE72 SSTL I/O  DDR4_DQ[31] EE72 SSTL I/O  DDR4_DQ[32] DU42 SSTL I/O  DDR4_DQ[33] DW42 SSTL I/O  DDR4_DQ[34] DP39 SSTL I/O  DDR4_DQ[35] DT39 SSTL I/O  DDR4_DQ[36] DL42 SSTL I/O  DDR4_DQ[36] DL42 SSTL I/O  DDR4_DQ[37] DN42 SSTL I/O  DDR4_DQ[38] DN40 SSTL I/O  DDR4_DQ[39] DU40 SSTL I/O  DDR4_DQ[40] EC34 SSTL I/O  DDR4_DQ[41] CK79 SSTL I/O  DDR4_DQ[41] ED33 SSTL I/O  DDR4_DQ[41] EA30 SSTL I/O  DDR4_DQ[41] EA30 SSTL I/O  DDR4_DQ[41] EA31 SSTL I/O  DDR4_DQ[42] EA30 SSTL I/O  DDR4_DQ[43] EC30 SSTL I/O  DDR4_DQ[44] DY33 SSTL I/O  DDR4_DQ[44] DY33 SSTL I/O  DDR4_DQ[45] EA34 SSTL I/O  DDR4_DQ[46] DY31 SSTL I/O  DDR4_DQ[47] ED31 SSTL I/O  DDR4_DQ[48] EC28 SSTL I/O  DDR4_DQ[49] ED27 SSTL I/O  DDR4_DQ[49] ED27 SSTL I/O  DDR4_DQ[50] EA24 SSTL I/O				
DDR4_DQ[24]         ED75         SSTL         I/O           DDR4_DQ[25]         EE74         SSTL         I/O           DDR4_DQ[26]         EB71         SSTL         I/O           DDR4_DQ[27]         ED71         SSTL         I/O           DDR4_DQ[28]         EA74         SSTL         I/O           DDR4_DQ[29]         EB75         SSTL         I/O           DDR4_DQ[3]         CR82         SSTL         I/O           DDR4_DQ[30]         EA72         SSTL         I/O           DDR4_DQ[30]         EA72         SSTL         I/O           DDR4_DQ[31]         EE72         SSTL         I/O           DDR4_DQ[32]         DU42         SSTL         I/O           DDR4_DQ[33]         DW42         SSTL         I/O           DDR4_DQ[33]         DW42         SSTL         I/O           DDR4_DQ[35]         DT39         SSTL         I/O           DDR4_DQ[36]         DL42         SSTL         I/O           DDR4_DQ[37]         DN42         SSTL         I/O           DDR4_DQ[38]         DN40         SSTL         I/O           DDR4_DQ[39]         DU40         SSTL         I/O				
DDR4_DQ[25]         EE74         SSTL         I/O           DDR4_DQ[26]         EB71         SSTL         I/O           DDR4_DQ[27]         ED71         SSTL         I/O           DDR4_DQ[28]         EA74         SSTL         I/O           DDR4_DQ[29]         EB75         SSTL         I/O           DDR4_DQ[3]         CR82         SSTL         I/O           DDR4_DQ[30]         EA72         SSTL         I/O           DDR4_DQ[31]         EE72         SSTL         I/O           DDR4_DQ[31]         EE72         SSTL         I/O           DDR4_DQ[32]         DU42         SSTL         I/O           DDR4_DQ[33]         DW42         SSTL         I/O           DDR4_DQ[34]         DP39         SSTL         I/O           DDR4_DQ[35]         DT39         SSTL         I/O           DDR4_DQ[36]         DL42         SSTL         I/O           DDR4_DQ[37]         DN42         SSTL         I/O           DDR4_DQ[38]         DN40         SSTL         I/O           DDR4_DQ[39]         DU40         SSTL         I/O           DDR4_DQ[41]         CK79         SSTL         I/O				
DDR4_DQ[26]         EB71         SSTL         I/O           DDR4_DQ[27]         ED71         SSTL         I/O           DDR4_DQ[28]         EA74         SSTL         I/O           DDR4_DQ[29]         EB75         SSTL         I/O           DDR4_DQ[3]         CR82         SSTL         I/O           DDR4_DQ[30]         EA72         SSTL         I/O           DDR4_DQ[31]         EE72         SSTL         I/O           DDR4_DQ[32]         DU42         SSTL         I/O           DDR4_DQ[33]         DW42         SSTL         I/O           DDR4_DQ[33]         DW42         SSTL         I/O           DDR4_DQ[34]         DP39         SSTL         I/O           DDR4_DQ[35]         DT39         SSTL         I/O           DDR4_DQ[36]         DL42         SSTL         I/O           DDR4_DQ[37]         DN42         SSTL         I/O           DDR4_DQ[38]         DN40         SSTL         I/O           DDR4_DQ[39]         DU40         SSTL         I/O           DDR4_DQ[40]         EC34         SSTL         I/O           DDR4_DQ[40]         EC34         SSTL         I/O				
DDR4_DQ[27]         ED71         SSTL         I/O           DDR4_DQ[28]         EA74         SSTL         I/O           DDR4_DQ[29]         EB75         SSTL         I/O           DDR4_DQ[3]         CR82         SSTL         I/O           DDR4_DQ[30]         EA72         SSTL         I/O           DDR4_DQ[31]         EE72         SSTL         I/O           DDR4_DQ[32]         DU42         SSTL         I/O           DDR4_DQ[33]         DW42         SSTL         I/O           DDR4_DQ[33]         DW42         SSTL         I/O           DDR4_DQ[34]         DP39         SSTL         I/O           DDR4_DQ[35]         DT39         SSTL         I/O           DDR4_DQ[36]         DL42         SSTL         I/O           DDR4_DQ[36]         DL42         SSTL         I/O           DDR4_DQ[37]         DN42         SSTL         I/O           DDR4_DQ[38]         DN40         SSTL         I/O           DDR4_DQ[39]         DU40         SSTL         I/O           DDR4_DQ[49]         EC34         SSTL         I/O           DDR4_DQ[40]         EC34         SSTL         I/O				
DDR4_DQ[28]         EA74         SSTL         I/O           DDR4_DQ[29]         EB75         SSTL         I/O           DDR4_DQ[31]         CR82         SSTL         I/O           DDR4_DQ[30]         EA72         SSTL         I/O           DDR4_DQ[31]         EE72         SSTL         I/O           DDR4_DQ[32]         DU42         SSTL         I/O           DDR4_DQ[33]         DW42         SSTL         I/O           DDR4_DQ[33]         DW42         SSTL         I/O           DDR4_DQ[34]         DP39         SSTL         I/O           DDR4_DQ[35]         DT39         SSTL         I/O           DDR4_DQ[36]         DL42         SSTL         I/O           DDR4_DQ[36]         DN42         SSTL         I/O           DDR4_DQ[38]         DN40         SSTL         I/O           DDR4_DQ[38]         DN40         SSTL         I/O           DDR4_DQ[39]         DU40         SSTL         I/O           DDR4_DQ[49]         EC34         SSTL         I/O           DDR4_DQ[40]         EC34         SSTL         I/O           DDR4_DQ[41]         ED33         SSTL         I/O				
DDR4_DQ[29]         EB75         SSTL         I/O           DDR4_DQ[3]         CR82         SSTL         I/O           DDR4_DQ[30]         EA72         SSTL         I/O           DDR4_DQ[31]         EE72         SSTL         I/O           DDR4_DQ[32]         DU42         SSTL         I/O           DDR4_DQ[33]         DW42         SSTL         I/O           DDR4_DQ[34]         DP39         SSTL         I/O           DDR4_DQ[35]         DT39         SSTL         I/O           DDR4_DQ[36]         DL42         SSTL         I/O           DDR4_DQ[36]         DL42         SSTL         I/O           DDR4_DQ[37]         DN42         SSTL         I/O           DDR4_DQ[38]         DN40         SSTL         I/O           DDR4_DQ[39]         DU40         SSTL         I/O           DDR4_DQ[39]         DU40         SSTL         I/O           DDR4_DQ[41]         CK79         SSTL         I/O           DDR4_DQ[40]         EC34         SSTL         I/O           DDR4_DQ[41]         ED33         SSTL         I/O           DDR4_DQ[42]         EA30         SSTL         I/O				
DDR4_DQ[3]         CR82         SSTL         I/O           DDR4_DQ[30]         EA72         SSTL         I/O           DDR4_DQ[31]         EE72         SSTL         I/O           DDR4_DQ[32]         DU42         SSTL         I/O           DDR4_DQ[33]         DW42         SSTL         I/O           DDR4_DQ[34]         DP39         SSTL         I/O           DDR4_DQ[35]         DT39         SSTL         I/O           DDR4_DQ[36]         DL42         SSTL         I/O           DDR4_DQ[36]         DL42         SSTL         I/O           DDR4_DQ[37]         DN42         SSTL         I/O           DDR4_DQ[38]         DN40         SSTL         I/O           DDR4_DQ[39]         DU40         SSTL         I/O           DDR4_DQ[43]         CK79         SSTL         I/O           DDR4_DQ[44]         CK79         SSTL         I/O           DDR4_DQ[41]         ED33         SSTL         I/O           DDR4_DQ[42]         EA30         SSTL         I/O           DDR4_DQ[43]         EC30         SSTL         I/O           DDR4_DQ[44]         DY33         SSTL         I/O				
DDR4_DQ[30]         EA72         SSTL         I/O           DDR4_DQ[31]         EE72         SSTL         I/O           DDR4_DQ[32]         DU42         SSTL         I/O           DDR4_DQ[33]         DW42         SSTL         I/O           DDR4_DQ[34]         DP39         SSTL         I/O           DDR4_DQ[34]         DP39         SSTL         I/O           DDR4_DQ[35]         DT39         SSTL         I/O           DDR4_DQ[36]         DL42         SSTL         I/O           DDR4_DQ[37]         DN42         SSTL         I/O           DDR4_DQ[37]         DN42         SSTL         I/O           DDR4_DQ[38]         DN40         SSTL         I/O           DDR4_DQ[39]         DU40         SSTL         I/O           DDR4_DQ[43]         CK79         SSTL         I/O           DDR4_DQ[44]         CK79         SSTL         I/O           DDR4_DQ[40]         EC34         SSTL         I/O           DDR4_DQ[41]         ED33         SSTL         I/O           DDR4_DQ[43]         EC30         SSTL         I/O           DDR4_DQ[44]         DY33         SSTL         I/O	DDR4_DQ[29]	EB75	SSTL	I/O
DDR4_DQ[31]         EE72         SSTL         I/O           DDR4_DQ[32]         DU42         SSTL         I/O           DDR4_DQ[33]         DW42         SSTL         I/O           DDR4_DQ[34]         DP39         SSTL         I/O           DDR4_DQ[35]         DT39         SSTL         I/O           DDR4_DQ[36]         DL42         SSTL         I/O           DDR4_DQ[37]         DN42         SSTL         I/O           DDR4_DQ[38]         DN40         SSTL         I/O           DDR4_DQ[39]         DU40         SSTL         I/O           DDR4_DQ[39]         DU40         SSTL         I/O           DDR4_DQ[41]         CK79         SSTL         I/O           DDR4_DQ[40]         EC34         SSTL         I/O           DDR4_DQ[41]         ED33         SSTL         I/O           DDR4_DQ[42]         EA30         SSTL         I/O           DDR4_DQ[43]         EC30         SSTL         I/O           DDR4_DQ[44]         DY33         SSTL         I/O           DDR4_DQ[45]         EA34         SSTL         I/O           DDR4_DQ[46]         DY31         SSTL         I/O	DDR4_DQ[3]	CR82	SSTL	I/O
DDR4_DQ[32]         DU42         SSTL         I/O           DDR4_DQ[33]         DW42         SSTL         I/O           DDR4_DQ[34]         DP39         SSTL         I/O           DDR4_DQ[35]         DT39         SSTL         I/O           DDR4_DQ[36]         DL42         SSTL         I/O           DDR4_DQ[37]         DN42         SSTL         I/O           DDR4_DQ[38]         DN40         SSTL         I/O           DDR4_DQ[39]         DU40         SSTL         I/O           DDR4_DQ[39]         DU40         SSTL         I/O           DDR4_DQ[4]         CK79         SSTL         I/O           DDR4_DQ[40]         EC34         SSTL         I/O           DDR4_DQ[40]         EC34         SSTL         I/O           DDR4_DQ[41]         ED33         SSTL         I/O           DDR4_DQ[42]         EA30         SSTL         I/O           DDR4_DQ[43]         EC30         SSTL         I/O           DDR4_DQ[44]         DY33         SSTL         I/O           DDR4_DQ[46]         DY31         SSTL         I/O           DDR4_DQ[47]         ED31         SSTL         I/O	DDR4_DQ[30]	EA72	SSTL	I/O
DDR4_DQ[34]         DW42         SSTL         I/O           DDR4_DQ[34]         DP39         SSTL         I/O           DDR4_DQ[35]         DT39         SSTL         I/O           DDR4_DQ[36]         DL42         SSTL         I/O           DDR4_DQ[37]         DN42         SSTL         I/O           DDR4_DQ[38]         DN40         SSTL         I/O           DDR4_DQ[39]         DU40         SSTL         I/O           DDR4_DQ[39]         DU40         SSTL         I/O           DDR4_DQ[41]         CK79         SSTL         I/O           DDR4_DQ[40]         EC34         SSTL         I/O           DDR4_DQ[41]         ED33         SSTL         I/O           DDR4_DQ[42]         EA30         SSTL         I/O           DDR4_DQ[43]         EC30         SSTL         I/O           DDR4_DQ[44]         DY33         SSTL         I/O           DDR4_DQ[45]         EA34         SSTL         I/O           DDR4_DQ[46]         DY31         SSTL         I/O           DDR4_DQ[47]         ED31         SSTL         I/O           DDR4_DQ[48]         EC28         SSTL         I/O	DDR4_DQ[31]	EE72	SSTL	I/O
DDR4_DQ[34]         DP39         SSTL         I/O           DDR4_DQ[35]         DT39         SSTL         I/O           DDR4_DQ[36]         DL42         SSTL         I/O           DDR4_DQ[37]         DN42         SSTL         I/O           DDR4_DQ[38]         DN40         SSTL         I/O           DDR4_DQ[39]         DU40         SSTL         I/O           DDR4_DQ[4]         CK79         SSTL         I/O           DDR4_DQ[40]         EC34         SSTL         I/O           DDR4_DQ[40]         ED33         SSTL         I/O           DDR4_DQ[41]         ED33         SSTL         I/O           DDR4_DQ[42]         EA30         SSTL         I/O           DDR4_DQ[43]         EC30         SSTL         I/O           DDR4_DQ[43]         EC30         SSTL         I/O           DDR4_DQ[44]         DY33         SSTL         I/O           DDR4_DQ[45]         EA34         SSTL         I/O           DDR4_DQ[46]         DY31         SSTL         I/O           DDR4_DQ[47]         ED31         SSTL         I/O           DDR4_DQ[48]         EC28         SSTL         I/O	DDR4_DQ[32]	DU42	SSTL	I/O
DDR4_DQ[35]         DT39         SSTL         I/O           DDR4_DQ[36]         DL42         SSTL         I/O           DDR4_DQ[37]         DN42         SSTL         I/O           DDR4_DQ[38]         DN40         SSTL         I/O           DDR4_DQ[39]         DU40         SSTL         I/O           DDR4_DQ[4]         CK79         SSTL         I/O           DDR4_DQ[40]         EC34         SSTL         I/O           DDR4_DQ[40]         EC34         SSTL         I/O           DDR4_DQ[41]         ED33         SSTL         I/O           DDR4_DQ[42]         EA30         SSTL         I/O           DDR4_DQ[43]         EC30         SSTL         I/O           DDR4_DQ[44]         DY33         SSTL         I/O           DDR4_DQ[45]         EA34         SSTL         I/O           DDR4_DQ[46]         DY31         SSTL         I/O           DDR4_DQ[47]         ED31         SSTL         I/O           DDR4_DQ[48]         EC28         SSTL         I/O           DDR4_DQ[49]         ED27         SSTL         I/O           DDR4_DQ[5]         CJ80         SSTL         I/O	DDR4_DQ[33]	DW42	SSTL	I/O
DDR4_DQ[36]         DL42         SSTL         I/O           DDR4_DQ[37]         DN42         SSTL         I/O           DDR4_DQ[38]         DN40         SSTL         I/O           DDR4_DQ[39]         DU40         SSTL         I/O           DDR4_DQ[4]         CK79         SSTL         I/O           DDR4_DQ[40]         EC34         SSTL         I/O           DDR4_DQ[41]         ED33         SSTL         I/O           DDR4_DQ[42]         EA30         SSTL         I/O           DDR4_DQ[43]         EC30         SSTL         I/O           DDR4_DQ[43]         EC30         SSTL         I/O           DDR4_DQ[44]         DY33         SSTL         I/O           DDR4_DQ[45]         EA34         SSTL         I/O           DDR4_DQ[46]         DY31         SSTL         I/O           DDR4_DQ[47]         ED31         SSTL         I/O           DDR4_DQ[48]         EC28         SSTL         I/O           DDR4_DQ[49]         ED27         SSTL         I/O           DDR4_DQ[5]         CJ80         SSTL         I/O           DDR4_DQ[5]         CJ80         SSTL         I/O	DDR4_DQ[34]	DP39	SSTL	I/O
DDR4_DQ[37]         DN42         SSTL         I/O           DDR4_DQ[38]         DN40         SSTL         I/O           DDR4_DQ[39]         DU40         SSTL         I/O           DDR4_DQ[4]         CK79         SSTL         I/O           DDR4_DQ[40]         EC34         SSTL         I/O           DDR4_DQ[41]         ED33         SSTL         I/O           DDR4_DQ[42]         EA30         SSTL         I/O           DDR4_DQ[43]         EC30         SSTL         I/O           DDR4_DQ[44]         DY33         SSTL         I/O           DDR4_DQ[45]         EA34         SSTL         I/O           DDR4_DQ[45]         EA34         SSTL         I/O           DDR4_DQ[46]         DY31         SSTL         I/O           DDR4_DQ[47]         ED31         SSTL         I/O           DDR4_DQ[48]         EC28         SSTL         I/O           DDR4_DQ[49]         ED27         SSTL         I/O           DDR4_DQ[5]         CJ80         SSTL         I/O           DDR4_DQ[5]         EA24         SSTL         I/O           DDR4_DQ[51]         EA24         SSTL         I/O	DDR4_DQ[35]	DT39	SSTL	I/O
DDR4_DQ[38]         DN40         SSTL         I/O           DDR4_DQ[39]         DU40         SSTL         I/O           DDR4_DQ[4]         CK79         SSTL         I/O           DDR4_DQ[40]         EC34         SSTL         I/O           DDR4_DQ[41]         ED33         SSTL         I/O           DDR4_DQ[42]         EA30         SSTL         I/O           DDR4_DQ[43]         EC30         SSTL         I/O           DDR4_DQ[44]         DY33         SSTL         I/O           DDR4_DQ[45]         EA34         SSTL         I/O           DDR4_DQ[46]         DY31         SSTL         I/O           DDR4_DQ[47]         ED31         SSTL         I/O           DDR4_DQ[48]         EC28         SSTL         I/O           DDR4_DQ[49]         ED27         SSTL         I/O           DDR4_DQ[5]         CJ80         SSTL         I/O           DDR4_DQ[5]         CJ80         SSTL         I/O           DDR4_DQ[5]         EA24         SSTL         I/O           DDR4_DQ[51]         EC24         SSTL         I/O	DDR4_DQ[36]	DL42	SSTL	I/O
DDR4_DQ[39]         DU40         SSTL         I/O           DDR4_DQ[4]         CK79         SSTL         I/O           DDR4_DQ[40]         EC34         SSTL         I/O           DDR4_DQ[41]         ED33         SSTL         I/O           DDR4_DQ[42]         EA30         SSTL         I/O           DDR4_DQ[43]         EC30         SSTL         I/O           DDR4_DQ[44]         DY33         SSTL         I/O           DDR4_DQ[45]         EA34         SSTL         I/O           DDR4_DQ[46]         DY31         SSTL         I/O           DDR4_DQ[47]         ED31         SSTL         I/O           DDR4_DQ[48]         EC28         SSTL         I/O           DDR4_DQ[49]         ED27         SSTL         I/O           DDR4_DQ[5]         CJ80         SSTL         I/O           DDR4_DQ[5]         CJ80         SSTL         I/O           DDR4_DQ[5]         EA24         SSTL         I/O           DDR4_DQ[51]         EC24         SSTL         I/O	DDR4_DQ[37]	DN42	SSTL	I/O
DDR4_DQ[4]         CK79         SSTL         I/O           DDR4_DQ[40]         EC34         SSTL         I/O           DDR4_DQ[41]         ED33         SSTL         I/O           DDR4_DQ[42]         EA30         SSTL         I/O           DDR4_DQ[43]         EC30         SSTL         I/O           DDR4_DQ[44]         DY33         SSTL         I/O           DDR4_DQ[45]         EA34         SSTL         I/O           DDR4_DQ[46]         DY31         SSTL         I/O           DDR4_DQ[47]         ED31         SSTL         I/O           DDR4_DQ[48]         EC28         SSTL         I/O           DDR4_DQ[49]         ED27         SSTL         I/O           DDR4_DQ[5]         CJ80         SSTL         I/O           DDR4_DQ[5]         EA24         SSTL         I/O           DDR4_DQ[50]         EA24         SSTL         I/O	DDR4_DQ[38]	DN40	SSTL	I/O
DDR4_DQ[40]         EC34         SSTL         I/O           DDR4_DQ[41]         ED33         SSTL         I/O           DDR4_DQ[42]         EA30         SSTL         I/O           DDR4_DQ[43]         EC30         SSTL         I/O           DDR4_DQ[44]         DY33         SSTL         I/O           DDR4_DQ[45]         EA34         SSTL         I/O           DDR4_DQ[46]         DY31         SSTL         I/O           DDR4_DQ[47]         ED31         SSTL         I/O           DDR4_DQ[48]         EC28         SSTL         I/O           DDR4_DQ[49]         ED27         SSTL         I/O           DDR4_DQ[5]         CJ80         SSTL         I/O           DDR4_DQ[5]         EA24         SSTL         I/O           DDR4_DQ[51]         EC24         SSTL         I/O	DDR4_DQ[39]	DU40	SSTL	I/O
DDR4_DQ[41]         ED33         SSTL         I/O           DDR4_DQ[42]         EA30         SSTL         I/O           DDR4_DQ[43]         EC30         SSTL         I/O           DDR4_DQ[44]         DY33         SSTL         I/O           DDR4_DQ[45]         EA34         SSTL         I/O           DDR4_DQ[46]         DY31         SSTL         I/O           DDR4_DQ[47]         ED31         SSTL         I/O           DDR4_DQ[48]         EC28         SSTL         I/O           DDR4_DQ[49]         ED27         SSTL         I/O           DDR4_DQ[5]         CJ80         SSTL         I/O           DDR4_DQ[50]         EA24         SSTL         I/O           DDR4_DQ[51]         EC24         SSTL         I/O	DDR4_DQ[4]	CK79	SSTL	I/O
DDR4_DQ[42]         EA30         SSTL         I/O           DDR4_DQ[43]         EC30         SSTL         I/O           DDR4_DQ[44]         DY33         SSTL         I/O           DDR4_DQ[45]         EA34         SSTL         I/O           DDR4_DQ[46]         DY31         SSTL         I/O           DDR4_DQ[47]         ED31         SSTL         I/O           DDR4_DQ[48]         EC28         SSTL         I/O           DDR4_DQ[49]         ED27         SSTL         I/O           DDR4_DQ[5]         CJ80         SSTL         I/O           DDR4_DQ[50]         EA24         SSTL         I/O           DDR4_DQ[51]         EC24         SSTL         I/O	DDR4_DQ[40]	EC34	SSTL	I/O
DDR4_DQ[43]         EC30         SSTL         I/O           DDR4_DQ[44]         DY33         SSTL         I/O           DDR4_DQ[45]         EA34         SSTL         I/O           DDR4_DQ[46]         DY31         SSTL         I/O           DDR4_DQ[47]         ED31         SSTL         I/O           DDR4_DQ[48]         EC28         SSTL         I/O           DDR4_DQ[49]         ED27         SSTL         I/O           DDR4_DQ[5]         CJ80         SSTL         I/O           DDR4_DQ[50]         EA24         SSTL         I/O           DDR4_DQ[51]         EC24         SSTL         I/O	DDR4_DQ[41]	ED33	SSTL	I/O
DDR4_DQ[44]         DY33         SSTL         I/O           DDR4_DQ[45]         EA34         SSTL         I/O           DDR4_DQ[46]         DY31         SSTL         I/O           DDR4_DQ[47]         ED31         SSTL         I/O           DDR4_DQ[48]         EC28         SSTL         I/O           DDR4_DQ[49]         ED27         SSTL         I/O           DDR4_DQ[5]         CJ80         SSTL         I/O           DDR4_DQ[50]         EA24         SSTL         I/O           DDR4_DQ[51]         EC24         SSTL         I/O	DDR4_DQ[42]	EA30	SSTL	I/O
DDR4_DQ[45]         EA34         SSTL         I/O           DDR4_DQ[46]         DY31         SSTL         I/O           DDR4_DQ[47]         ED31         SSTL         I/O           DDR4_DQ[48]         EC28         SSTL         I/O           DDR4_DQ[49]         ED27         SSTL         I/O           DDR4_DQ[5]         CJ80         SSTL         I/O           DDR4_DQ[50]         EA24         SSTL         I/O           DDR4_DQ[51]         EC24         SSTL         I/O	DDR4_DQ[43]	EC30	SSTL	I/O
DDR4_DQ[46]         DY31         SSTL         I/O           DDR4_DQ[47]         ED31         SSTL         I/O           DDR4_DQ[48]         EC28         SSTL         I/O           DDR4_DQ[49]         ED27         SSTL         I/O           DDR4_DQ[5]         CJ80         SSTL         I/O           DDR4_DQ[50]         EA24         SSTL         I/O           DDR4_DQ[51]         EC24         SSTL         I/O	DDR4_DQ[44]	DY33	SSTL	I/O
DDR4_DQ[47]         ED31         SSTL         I/O           DDR4_DQ[48]         EC28         SSTL         I/O           DDR4_DQ[49]         ED27         SSTL         I/O           DDR4_DQ[5]         CJ80         SSTL         I/O           DDR4_DQ[50]         EA24         SSTL         I/O           DDR4_DQ[51]         EC24         SSTL         I/O	DDR4_DQ[45]	EA34	SSTL	I/O
DDR4_DQ[48]         EC28         SSTL         I/O           DDR4_DQ[49]         ED27         SSTL         I/O           DDR4_DQ[5]         CJ80         SSTL         I/O           DDR4_DQ[50]         EA24         SSTL         I/O           DDR4_DQ[51]         EC24         SSTL         I/O	DDR4_DQ[46]	DY31	SSTL	I/O
DDR4_DQ[49]         ED27         SSTL         I/O           DDR4_DQ[5]         CJ80         SSTL         I/O           DDR4_DQ[50]         EA24         SSTL         I/O           DDR4_DQ[51]         EC24         SSTL         I/O	DDR4_DQ[47]	ED31	SSTL	I/O
DDR4_DQ[5]         CJ80         SSTL         I/O           DDR4_DQ[50]         EA24         SSTL         I/O           DDR4_DQ[51]         EC24         SSTL         I/O	DDR4_DQ[48]	EC28	SSTL	I/O
DDR4_DQ[5]         CJ80         SSTL         I/O           DDR4_DQ[50]         EA24         SSTL         I/O           DDR4_DQ[51]         EC24         SSTL         I/O	DDR4_DQ[49]	ED27	SSTL	I/O
DDR4_DQ[51]	DDR4_DQ[5]	CJ80	SSTL	I/O
DDR4_DQ[51]	DDR4_DQ[50]	EA24	SSTL	I/O
DDR4_DQ[52] DY27 SSTL I/O		EC24		I/O
<u></u>	DDR4_DQ[52]	DY27	SSTL	I/O
DDR4_DQ[53] EA28 SSTL I/O		EA28	SSTL	I/O



Table A-1. Pin List By Name (Sheet 21 of 90)

Locati **Pin Name** Type I/O on DDR4\_DQ[54] DY25 SSTL I/O DDR4\_DQ[55] ED25 SSTL I/O DDR4 DQ[56] DF27 SSTL I/O DDR4\_DQ[57] DK27 SSTL I/O I/O DDR4\_DQ[58] DD25 SSTL DDR4 DQ[59] DJ24 SSTL I/O DDR4\_DQ[6] CR80 SSTL I/O DDR4\_DQ[60] DG28 SSTL I/O DDR4\_DQ[61] DJ28 SSTL I/O DDR4\_DQ[62] DF25 SSTL I/O DDR4\_DQ[63] DK25 SSTL I/O DDR4\_DQ[7] CN82 **SSTL** I/O DDR4\_DQ[8] DB79 SSTL I/O CY81 SSTL I/O DDR4\_DQ[9] DDR4\_DQS\_DN[0] CL82 SSTL I/O DDR4\_DQS\_DN[1] DA82 SSTL I/O DDR4\_DQS\_DN[10] DC80 SSTL I/O DDR4\_DQS\_DN[11] DY79 SSTL I/O DDR4\_DQS\_DN[12] **EB73** SSTL I/O DDR4\_DQS\_DN[13] DP41 SSTL I/O SSTL DDR4\_DQS\_DN[14] EA32 I/O DDR4\_DQS\_DN[15] EA26 SSTL I/O DDR4\_DQS\_DN[16] DG26 SSTL I/O DV67 SSTL DDR4\_DQS\_DN[17] I/O DDR4\_DQS\_DN[2] ED79 SSTL I/O DDR4\_DQS\_DN[3] EF73 SSTL I/O SSTL DDR4\_DQS\_DN[4] DV41 I/O DDR4\_DQS\_DN[5] EE32 SSTL I/O DDR4\_DQS\_DN[6] EE26 SSTL I/O DDR4\_DQS\_DN[7] DL26 SSTL I/O I/O DDR4\_DQS\_DN[8] EB67 SSTL DDR4\_DQS\_DN[9] **CN80** SSTL I/O DDR4\_DQS\_DP[0] CM81 SSTL I/O SSTL I/O DDR4\_DQS\_DP[1] **DB81** DDR4\_DQS\_DP[10] DD79 SSTL I/O DDR4\_DQS\_DP[11] DV79 SSTL I/O DDR4\_DQS\_DP[12] DY73 SSTL I/O DDR4\_DQS\_DP[13] DM41 SSTL I/O DDR4\_DQS\_DP[14] DW32 SSTL I/O DDR4\_DQS\_DP[15] DW26 SSTL I/O

Table A-1. Pin List By Name (Sheet 22 of 90)

Pin Name	Locati on	Туре	I/O
DDR4_DQS_DP[17]	DT67	SSTL	I/O
DDR4_DQS_DP[2]	EB79	SSTL	I/O
DDR4_DQS_DP[3]	ED73	SSTL	I/O
DDR4_DQS_DP[4]	DT41	SSTL	I/O
DDR4_DQS_DP[5]	EC32	SSTL	I/O
DDR4_DQS_DP[6]	EC26	SSTL	I/O
DDR4_DQS_DP[7]	DJ26	SSTL	I/O
DDR4_DQS_DP[8]	DY67	SSTL	I/O
DDR4_DQS_DP[9]	CP79	SSTL	I/O
DDR4_ECC[0]	DY69	SSTL	I/O
DDR4_ECC[1]	EA68	SSTL	I/O
DDR4_ECC[2]	DV65	SSTL	I/O
DDR4_ECC[3]	DY65	SSTL	I/O
DDR4_ECC[4]	DU68	SSTL	I/O
DDR4_ECC[5]	DV69	SSTL	I/O
DDR4_ECC[6]	DU66	SSTL	I/O
DDR4_ECC[7]	EA66	SSTL	I/O
DDR4_MA[0]	DW52	SSTL	0
DDR4_MA[1]	DW58	SSTL	0
DDR4_MA[10]	DT55	SSTL	0
DDR4_MA[11]	DR60	SSTL	0
DDR4_MA[12]	DN60	SSTL	0
DDR4_MA[13]	DT51	SSTL	0
DDR4_MA[14]	DM51	SSTL	0
DDR4_MA[15]	DR52	SSTL	0
DDR4_MA[16]	DN52	SSTL	0
DDR4_MA[17]	DR48	SSTL	0
DDR4_MA[2]	DV57	SSTL	0
DDR4_MA[3]	DR58	SSTL	0
DDR4_MA[4]	DT59	SSTL	0
DDR4_MA[5]	DN58	SSTL	0
DDR4_MA[6]	DM59	SSTL	0
DDR4_MA[7]	DK61	SSTL	0
DDR4_MA[8]	DJ60	SSTL	0
DDR4_MA[9]	DV59	SSTL	0
DDR4_ODT[0]	DR50	SSTL	0
DDR4_ODT[1]	DN48	SSTL	0
DDR4_ODT[2]	DT49	SSTL	0
DDR4_ODT[3]	DM47	SSTL	0
DDR4_PAR	DV53	SSTL	0
DDR5_ACT_N	DC62	SSTL	0

DE26

**SSTL** 

I/O

DDR4\_DQS\_DP[16]



Table A-1. Pin List By Name (Sheet 23 of 90)

Locati **Pin Name** Type I/O on SSTL DDR5\_ALERT\_N **DD61** Τ DDR5\_BA[0] DJ52 SSTL 0 DDR5\_BA[1] DC56 SSTL 0 0 DDR5\_BG[0] DA62 SSTL DDR5\_BG[1] DF61 SSTL 0 DDR5 CAVREF CV61 SSTL 0 DDR5\_CID[2] DF45 SSTL 0 DDR5\_CKE[0] DG62 SSTL 0 DDR5\_CKE[1] DD63 SSTL 0 0 DDR5\_CKE[2] **DK63** SSTL DDR5\_CKE[3] DF63 SSTL 0 DDR5\_CLK\_DN[0] **DK55** SSTL 0 DDR5\_CLK\_DN[1] DF55 0 SSTL 0 DDR5\_CLK\_DN[2] DK57 SSTL DDR5\_CLK\_DN[3] DF57 SSTL 0 DDR5\_CLK\_DP[0] DJ54 SSTL 0 DDR5\_CLK\_DP[1] 0 SSTL DG54 DDR5\_CLK\_DP[2] DJ56 SSTL 0 DDR5\_CLK\_DP[3] DG56 SSTL 0 DDR5\_CS\_N[0] DK51 SSTL 0 0 DDR5\_CS\_N[1] **DF49** SSTL DDR5\_CS\_N[2] DJ46 SSTL 0 0 DDR5\_CS\_N[3] DG46 SSTL 0 DDR5\_CS\_N[4] DF51 SSTL DDR5\_CS\_N[5] DJ48 SSTL 0 DDR5\_CS\_N[6] DM45 SSTL 0 DDR5\_CS\_N[7] DK45 SSTL 0 DDR5\_DQ[0] SSTL I/O CR74 DDR5\_DQ[1] CN76 SSTL I/O DDR5\_DQ[10] DH75 SSTL I/O DDR5\_DQ[11] DJ76 I/O SSTL DDR5\_DQ[12] DC74 SSTL I/O DDR5\_DQ[13] DB75 SSTL I/O I/O DDR5\_DQ[14] DF77 SSTL DDR5\_DQ[15] DH77 SSTL I/O DDR5\_DQ[16] DG70 SSTL I/O DDR5\_DQ[17] DJ72 SSTL I/O DDR5\_DQ[18] DM69 SSTL I/O DDR5\_DQ[19] DN70 SSTL I/O DDR5\_DQ[2] CW76 SSTL I/O DDR5\_DQ[20] I/O DF71 SSTL

Table A-1. Pin List By Name (Sheet 24 of 90)

Pin Name	Locati on	Туре	I/O
DDR5_DQ[21]	DG72	SSTL	I/O
DDR5_DQ[22]	DK69	SSTL	I/O
DDR5_DQ[23]	DM71	SSTL	I/O
DDR5_DQ[24]	CN66	SSTL	I/O
DDR5_DQ[25]	CU66	SSTL	I/O
DDR5_DQ[26]	CP63	SSTL	I/O
DDR5_DQ[27]	CT63	SSTL	I/O
DDR5_DQ[28]	CP67	SSTL	I/O
DDR5_DQ[29]	CT67	SSTL	I/O
DDR5_DQ[3]	CV77	SSTL	I/O
DDR5_DQ[30]	CN64	SSTL	I/O
DDR5_DQ[31]	CU64	SSTL	I/O
DDR5_DQ[32]	DD41	SSTL	I/O
DDR5_DQ[33]	DG42	SSTL	I/O
DDR5_DQ[34]	DE38	SSTL	I/O
DDR5_DQ[35]	DG38	SSTL	I/O
DDR5_DQ[36]	DA42	SSTL	I/O
DDR5_DQ[37]	DE42	SSTL	I/O
DDR5_DQ[38]	DD39	SSTL	I/O
DDR5_DQ[39]	DH39	SSTL	I/O
DDR5_DQ[4]	CN74	SSTL	I/O
DDR5_DQ[40]	DF33	SSTL	I/O
DDR5_DQ[41]	DK33	SSTL	I/O
DDR5_DQ[42]	DG30	SSTL	I/O
DDR5_DQ[43]	DJ30	SSTL	I/O
DDR5_DQ[44]	DG34	SSTL	I/O
DDR5_DQ[45]	DJ34	SSTL	I/O
DDR5_DQ[46]	DF31	SSTL	I/O
DDR5_DQ[47]	DK31	SSTL	I/O
DDR5_DQ[48]	CW36	SSTL	I/O
DDR5_DQ[49]	DC36	SSTL	I/O
DDR5_DQ[5]	CM75	SSTL	I/O
DDR5_DQ[50]	CY33	SSTL	I/O
DDR5_DQ[51]	DB33	SSTL	I/O
DDR5_DQ[52]	CY37	SSTL	I/O
DDR5_DQ[53]	DB37	SSTL	I/O
DDR5_DQ[54]	CW34	SSTL	I/O
DDR5_DQ[55]	DC34	SSTL	I/O
DDR5_DQ[56]	CW30	SSTL	I/O
DDR5_DQ[57]	DC30	SSTL	I/O
DDR5_DQ[58]	CY27	SSTL	I/O



Table A-1. Pin List By Name (Sheet 25 of 90)

Locati **Pin Name** Type I/O on DDR5\_DQ[59] DB27 SSTL I/O DDR5\_DQ[6] CV75 SSTL I/O DDR5\_DQ[60] CY31 SSTL I/O DB31 SSTL I/O DDR5\_DQ[61] I/O DDR5\_DQ[62] CW28 SSTL DDR5 DQ[63] DC28 SSTL I/O DDR5\_DQ[7] CT77 SSTL I/O DDR5\_DQ[8] DE74 **SSTL** I/O DDR5\_DQ[9] DC76 SSTL I/O DDR5\_DQS\_DN[0] CP77 SSTL I/O DDR5\_DQS\_DN[1] DD77 SSTL I/O DDR5\_DQS\_DN[10] **DF75 SSTL** I/O DDR5\_DQS\_DN[11] DJ70 SSTL I/O DDR5\_DQS\_DN[12] CP65 SSTL I/O DDR5\_DQS\_DN[13] DE40 SSTL I/O DDR5\_DQS\_DN[14] DG32 SSTL I/O DDR5\_DQS\_DN[15] CY35 SSTL I/O DDR5\_DQS\_DN[16] CY29 SSTL I/O DDR5\_DQS\_DN[17] CJ70 SSTL I/O DDR5\_DQS\_DN[2] DL72 SSTL I/O SSTL CV65 DDR5\_DQS\_DN[3] I/O DDR5\_DQS\_DN[4] DG40 SSTL I/O DDR5\_DQS\_DN[5] DL32 SSTL I/O SSTL DDR5\_DQS\_DN[6] **DD35** I/O DDR5\_DQS\_DN[7] DD29 SSTL I/O DDR5\_DQS\_DN[8] CN70 SSTL I/O SSTL DDR5\_DQS\_DN[9] CT75 I/O DDR5\_DQS\_DP[0] **CR76** SSTL I/O DDR5\_DQS\_DP[1] DE76 SSTL I/O DDR5\_DQS\_DP[10] DG74 SSTL I/O I/O DDR5\_DQS\_DP[11] DH69 SSTL DDR5\_DQS\_DP[12] CM65 SSTL I/O DDR5\_DQS\_DP[13] DC40 SSTL I/O SSTL I/O DDR5\_DQS\_DP[14] DE32 DDR5\_DQS\_DP[15] CV35 SSTL I/O DDR5\_DQS\_DP[16] CV29 SSTL I/O DDR5\_DQS\_DP[17] CG70 SSTL I/O DDR5\_DQS\_DP[2] DK71 SSTL I/O DDR5\_DQS\_DP[3] CT65 SSTL I/O DDR5\_DQS\_DP[4] DJ40 SSTL I/O

Table A-1. Pin List By Name (Sheet 26 of 90)

Pin Name	Locati on	Туре	I/O
DDR5_DQS_DP[6]	DB35	SSTL	I/O
DDR5_DQS_DP[7]	DB29	SSTL	I/O
DDR5_DQS_DP[8]	CL70	SSTL	I/O
DDR5_DQS_DP[9]	CU74	SSTL	I/O
DDR5_ECC[0]	CH71	SSTL	I/O
DDR5_ECC[1]	CM71	SSTL	I/O
DDR5_ECC[2]	CJ68	SSTL	I/O
DDR5_ECC[3]	CL68	SSTL	I/O
DDR5_ECC[4]	CJ72	SSTL	I/O
DDR5_ECC[5]	CL72	SSTL	I/O
DDR5_ECC[6]	CH69	SSTL	I/O
DDR5_ECC[7]	CM69	SSTL	I/O
DDR5_MA[0]	DF53	SSTL	0
DDR5_MA[1]	DC58	SSTL	0
DDR5_MA[10]	DD55	SSTL	0
DDR5_MA[11]	DA60	SSTL	0
DDR5_MA[12]	DG60	SSTL	0
DDR5_MA[13]	DD53	SSTL	0
DDR5_MA[14]	DJ50	SSTL	0
DDR5_MA[15]	DC54	SSTL	0
DDR5_MA[16]	DG52	SSTL	0
DDR5_MA[17]	DE46	SSTL	0
DDR5_MA[2]	DD57	SSTL	0
DDR5_MA[3]	DG58	SSTL	0
DDR5_MA[4]	DJ58	SSTL	0
DDR5_MA[5]	DF59	SSTL	0
DDR5_MA[6]	DK59	SSTL	0
DDR5_MA[7]	DC60	SSTL	0
DDR5_MA[8]	DD59	SSTL	0
DDR5_MA[9]	DA58	SSTL	0
DDR5_ODT[0]	DG50	SSTL	0
DDR5_ODT[1]	DG48	SSTL	0
DDR5_ODT[2]	DK49	SSTL	0
DDR5_ODT[3]	DF47	SSTL	0
DDR5_PAR	DK53	SSTL	0
DEBUG_EN_N	AV21	CMOS	I/O
DMI_RX_DN[0]	CK9	PCIEX	I
DMI_RX_DN[1]	CM11	PCIEX	I
DMI_RX_DN[2]	CR12	PCIEX	I
DMI_RX_DN[3]	CT11	PCIEX	I
DMI_RX_DP[0]	CL10	PCIEX	I

DJ32

**SSTL** 

I/O

DDR5\_DQS\_DP[5]



Table A-1. Pin List By Name (Sheet 27 of 90)

Locati **Pin Name** Type I/O on PCIEX DMI\_RX\_DP[1] CN10 Ι DMI\_RX\_DP[2] CP11 **PCIEX** Ι DMI\_RX\_DP[3] CV11 **PCIEX** Ι CG4 0 DMI\_TX\_DN[0] **PCIEX** 0 DMI\_TX\_DN[1] CJ4 **PCIEX** DMI\_TX\_DN[2] CN4 **PCIEX** 0 DMI\_TX\_DN[3] CP5 **PCIEX** 0 DMI\_TX\_DP[0] CH5 **PCIEX** 0 DMI\_TX\_DP[1] CL4 **PCIEX** 0 0 DMI\_TX\_DP[2] CM3 **PCIEX** DMI\_TX\_DP[3] CR4 **PCIEX** 0 DMIMODE\_OVERRIDE AW12 **CMOS** I/O AJ14 CMOS Ι EAR\_N AJ12 0 ERROR\_N[0] OD ERROR\_N[1] AK11 OD 0 ERROR\_N[2] AL12 OD 0 FIVR\_FAULT 0 AU14 **CMOS FRMAGENT** AV17 CMOS Ι LEGACY\_SKT AE20 **CMOS** Ι MCP01\_RBIAS CT31 MCP01\_RBIAS CU32 MEM\_HOT\_C012\_N AH13 **ODCMOS** I/O MEM\_HOT\_C345\_N **ODCMOS** AF13 I/O MSMI\_N AN20 CMOS I/O NMI AP11 **CMOS** Ι PE\_HP\_SCL AM19 **ODCMOS** I/O PE\_HP\_SDA AL18 **ODCMOS** I/O PE012\_RBIAS **CL30** PE012\_RBIAS CN30 PE1\_RX\_DN[0] CW8 PCIEX3 Ι PCIEX3 PE1\_RX\_DN[1] DA8 Ι PE1\_RX\_DN[10] DT11 PCIEX3 Ι PE1\_RX\_DN[11] DT13 PCIEX3 Ι PCIEX3 PE1\_RX\_DN[12] DV13 Ι Ι PE1\_RX\_DN[13] DW14 PCIEX3 PE1\_RX\_DN[14] DY15 PCIEX3 Ι PE1\_RX\_DN[15] DU16 PCIEX3 Ι Ι PE1\_RX\_DN[2] DC8 PCIEX3 PE1\_RX\_DN[3] DC10 PCIEX3 Ι PE1\_RX\_DN[4] DE10 PCIEX3 Ι PE1\_RX\_DN[5] DH9 PCIEX3 Ι

Table A-1. Pin List By Name (Sheet 28 of 90)

90)			
Pin Name	Locati on	Туре	I/O
PE1_RX_DN[6]	DK9	PCIEX3	I
PE1_RX_DN[7]	DM9	PCIEX3	I
PE1_RX_DN[8]	DM11	PCIEX3	I
PE1_RX_DN[9]	DP11	PCIEX3	I
PE1_RX_DP[0]	CU8	PCIEX3	I
PE1_RX_DP[1]	CY7	PCIEX3	I
PE1_RX_DP[10]	DR12	PCIEX3	I
PE1_RX_DP[11]	DP13	PCIEX3	I
PE1_RX_DP[12]	DU12	PCIEX3	I
PE1_RX_DP[13]	DY13	PCIEX3	I
PE1_RX_DP[14]	DV15	PCIEX3	I
PE1_RX_DP[15]	DT15	PCIEX3	I
PE1_RX_DP[2]	DB9	PCIEX3	I
PE1_RX_DP[3]	DA10	PCIEX3	I
PE1_RX_DP[4]	DD9	PCIEX3	I
PE1_RX_DP[5]	DF9	PCIEX3	I
PE1_RX_DP[6]	DJ8	PCIEX3	I
PE1_RX_DP[7]	DL10	PCIEX3	I
PE1_RX_DP[8]	DK11	PCIEX3	I
PE1_RX_DP[9]	DN10	PCIEX3	I
PE1_TX_DN[0]	DA2	PCIEX3	0
PE1_TX_DN[1]	DC2	PCIEX3	0
PE1_TX_DN[10]	DW4	PCIEX3	0
PE1_TX_DN[11]	DU6	PCIEX3	0
PE1_TX_DN[12]	DV7	PCIEX3	0
PE1_TX_DN[13]	DY7	PCIEX3	0
PE1_TX_DN[14]	EA8	PCIEX3	0
PE1_TX_DN[15]	ED9	PCIEX3	0
PE1_TX_DN[2]	DE2	PCIEX3	0
PE1_TX_DN[3]	DE4	PCIEX3	0
PE1_TX_DN[4]	DG4	PCIEX3	0
PE1_TX_DN[5]	DK3	PCIEX3	0
PE1_TX_DN[6]	DM3	PCIEX3	0
PE1_TX_DN[7]	DN4	PCIEX3	0
PE1_TX_DN[8]	DT5	PCIEX3	0
PE1_TX_DN[9]	DV3	PCIEX3	0
PE1_TX_DP[0]	CW2	PCIEX3	0
PE1_TX_DP[1]	DB1	PCIEX3	0
PE1_TX_DP[10]	DU4	PCIEX3	0
PE1_TX_DP[11]	DV5	PCIEX3	0
PE1_TX_DP[12]	DT7	PCIEX3	0



Table A-1. Pin List By Name (Sheet 29 of 90)

Locati **Pin Name** Type I/O on PE1\_TX\_DP[13] DW6 PCIEX3 0 PE1\_TX\_DP[14] EB7 PCIEX3 0 PE1\_TX\_DP[15] EC8 PCIEX3 0 PE1\_TX\_DP[2] DD3 PCIEX3 0 PE1\_TX\_DP[3] DC4 PCIEX3 0 PE1\_TX\_DP[4] DF3 PCIEX3 0 PE1\_TX\_DP[5] DH3 PCIEX3 0 PE1\_TX\_DP[6] DL2 PCIEX3 0 PE1\_TX\_DP[7] DP3 PCIEX3 0 0 PE1\_TX\_DP[8] DR4 PCIEX3 PE1\_TX\_DP[9] DU2 PCIEX3 0 PE2\_RX\_DN[0] CT9 PCIEX3 PE2\_RX\_DN[1] CP9 PCIEX3 Ι PE2\_RX\_DN[10] BV7 PCIEX3 Ι PE2\_RX\_DN[11] BT7 PCIEX3 Ι PE2\_RX\_DN[12] BR8 PCIEX3 Ι PE2\_RX\_DN[13] BN8 PCIEX3 Ι PE2\_RX\_DN[14] BL8 PCIEX3 Ι PE2\_RX\_DN[15] BK9 PCIEX3 Ι PE2\_RX\_DN[2] CP7 PCIEX3 Ι CM7 PCIEX3 PE2\_RX\_DN[3] Ι PE2\_RX\_DN[4] CK7 PCIEX3 Ι PE2\_RX\_DN[5] CG8 PCIEX3 Ι CE6 PCIEX3 PE2\_RX\_DN[6] T PE2\_RX\_DN[7] CE8 PCIEX3 Ι PE2\_RX\_DN[8] BY9 PCIEX3 Ι PCIEX3 PE2\_RX\_DN[9] BY7 T PE2\_RX\_DP[0] CR8 PCIEX3 Ι PE2\_RX\_DP[1] CM9 PCIEX3 Ι PE2\_RX\_DP[10] BU6 PCIEX3 Ι PE2\_RX\_DP[11] BP7 PCIEX3 Ι PE2\_RX\_DP[12] BP9 PCIEX3 Ι PE2\_RX\_DP[13] ВМ7 PCIEX3 Ι PCIEX3 PE2\_RX\_DP[14] BJ8 T PE2\_RX\_DP[15] BJ10 PCIEX3 Ι PE2\_RX\_DP[2] CN8 PCIEX3 Ι PE2\_RX\_DP[3] CL6 PCIEX3 Ι PE2\_RX\_DP[4] CH7 PCIEX3 Ι PE2\_RX\_DP[5] CF7 PCIEX3 Ι PE2\_RX\_DP[6] CD7 PCIEX3 Ι

Table A-1. Pin List By Name (Sheet 30 of 90)

Pin Name	Locati on	Туре	I/O
PE2_RX_DP[8]	BV9	PCIEX3	I
PE2_RX_DP[9]	BW8	PCIEX3	I
PE2_TX_DN[0]	CY3	PCIEX3	0
PE2_TX_DN[1]	CV3	PCIEX3	0
PE2_TX_DN[10]	CA4	PCIEX3	0
PE2_TX_DN[11]	BW4	PCIEX3	0
PE2_TX_DN[12]	BU4	PCIEX3	0
PE2_TX_DN[13]	BP5	PCIEX3	0
PE2_TX_DN[14]	BL4	PCIEX3	0
PE2_TX_DN[15]	вм5	PCIEX3	0
PE2_TX_DN[2]	CT1	PCIEX3	0
PE2_TX_DN[3]	CT3	PCIEX3	0
PE2_TX_DN[4]	CM1	PCIEX3	0
PE2_TX_DN[5]	CL2	PCIEX3	0
PE2_TX_DN[6]	CG2	PCIEX3	0
PE2_TX_DN[7]	CF3	PCIEX3	0
PE2_TX_DN[8]	CC2	PCIEX3	0
PE2_TX_DN[9]	CB3	PCIEX3	0
PE2_TX_DP[0]	CW4	PCIEX3	0
PE2_TX_DP[1]	CU2	PCIEX3	0
PE2_TX_DP[10]	BY5	PCIEX3	0
PE2_TX_DP[11]	BV3	PCIEX3	0
PE2_TX_DP[12]	BR4	PCIEX3	0
PE2_TX_DP[13]	BN4	PCIEX3	0
PE2_TX_DP[14]	ВМ3	PCIEX3	0
PE2_TX_DP[15]	BK5	PCIEX3	0
PE2_TX_DP[2]	CR2	PCIEX3	0
PE2_TX_DP[3]	CP3	PCIEX3	0
PE2_TX_DP[4]	CK1	PCIEX3	0
PE2_TX_DP[5]	СКЗ	PCIEX3	0
PE2_TX_DP[6]	CE2	PCIEX3	0
PE2_TX_DP[7]	CE4	PCIEX3	0
PE2_TX_DP[8]	CD3	PCIEX3	0
PE2_TX_DP[9]	BY3	PCIEX3	0
PE3_RBIAS	CP29	PCIEX3	I
PE3_RBIAS	CR30	PCIEX3	I
PE3_RX_DN[0]	EA18	PCIEX3	I
PE3_RX_DN[1]	DW18	PCIEX3	I
PE3_RX_DN[10]	DG12	PCIEX3	I
PE3_RX_DN[11]	DG10	PCIEX3	I
PE3_RX_DN[12]	DD13	PCIEX3	I

CC8

PCIEX3

Ι

PE2\_RX\_DP[7]



Table A-1. Pin List By Name (Sheet 31 of 90)

Locati **Pin Name** Type I/O on PE3\_RX\_DN[13] **DB11** PCIEX3 Ι PE3\_RX\_DN[14] CY11 PCIEX3 PE3\_RX\_DN[15] CV9 PCIEX3 Ι PE3\_RX\_DN[2] DW16 Ι PCIEX3 PE3\_RX\_DN[3] DT19 PCIEX3 Ι PE3\_RX\_DN[4] DR16 PCIEX3 Ι PE3\_RX\_DN[5] DR14 PCIEX3 Ι PE3\_RX\_DN[6] **DN14** PCIEX3 Ι PE3\_RX\_DN[7] DL14 PCIEX3 Ι PE3\_RX\_DN[8] DL12 PCIEX3 PE3\_RX\_DN[9] DJ12 PCIEX3 Ι PE3\_RX\_DP[0] DY17 PCIEX3 PE3\_RX\_DP[1] DU18 Ι PCIEX3 PE3\_RX\_DP[10] DE12 PCIEX3 Ι PE3\_RX\_DP[11] DF11 PCIEX3 Ι PE3\_RX\_DP[12] DC12 PCIEX3 Ι PE3\_RX\_DP[13] PCIEX3 DA12 Ι PE3\_RX\_DP[14] CW10 PCIEX3 Ι PE3\_RX\_DP[15] **CU10** PCIEX3 Ι PE3\_RX\_DP[2] DV17 PCIEX3 Ι PE3\_RX\_DP[3] DR18 PCIEX3 Ι PE3\_RX\_DP[4] DN16 PCIEX3 Ι PE3\_RX\_DP[5] DP15 PCIEX3 Ι PCIEX3 PE3\_RX\_DP[6] DM13 Ι PE3\_RX\_DP[7] DJ14 PCIEX3 Ι PE3\_RX\_DP[8] DK13 PCIEX3 Ι PE3\_RX\_DP[9] DH11 PCIEX3 Т PE3\_TX\_DN[0] PCIEX3 0 **EE14** PE3\_TX\_DN[1] EE12 PCIEX3 0 PE3\_TX\_DN[10] DL6 PCIEX3 0 DJ4 PCIEX3 0 PE3\_TX\_DN[11] PE3\_TX\_DN[12] DJ6 PCIEX3 0 PE3\_TX\_DN[13] DD5 PCIEX3 0 PE3\_TX\_DN[14] DB5 PCIEX3 0 PE3\_TX\_DN[15] CY5 PCIEX3 0 PE3\_TX\_DN[2] EC12 PCIEX3 0 PE3\_TX\_DN[3] DY11 PCIEX3 0 PE3\_TX\_DN[4] EB9 PCIEX3 0 PCIEX3 0 PE3\_TX\_DN[5] DW10 PE3\_TX\_DN[6] DU8 PCIEX3 0 0 PE3\_TX\_DN[7] DR8 PCIEX3

Table A-1. Pin List By Name (Sheet 32 of 90)

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Pin Name	Locati on	Туре	I/O
PE3_TX_DN[8]	DM7	PCIEX3	0
PE3_TX_DN[9]	DP5	PCIEX3	0
PE3_TX_DP[0]	EC14	PCIEX3	0
PE3_TX_DP[1]	ED13	PCIEX3	0
PE3_TX_DP[10]	DK5	PCIEX3	0
PE3_TX_DP[11]	DH5	PCIEX3	0
PE3_TX_DP[12]	DG6	PCIEX3	0
PE3_TX_DP[13]	DC6	PCIEX3	0
PE3_TX_DP[14]	DA4	PCIEX3	0
PE3_TX_DP[15]	CV5	PCIEX3	0
PE3_TX_DP[2]	EB11	PCIEX3	0
PE3_TX_DP[3]	EA10	PCIEX3	0
PE3_TX_DP[4]	DY9	PCIEX3	0
PE3_TX_DP[5]	DV9	PCIEX3	0
PE3_TX_DP[6]	DT9	PCIEX3	0
PE3_TX_DP[7]	DP7	PCIEX3	0
PE3_TX_DP[8]	DN6	PCIEX3	0
PE3_TX_DP[9]	DM5	PCIEX3	0
PECI	AU12	PECI	I/O
PIROM_ADDR[0]	CU58		I/O
PIROM_ADDR[1]	CV57		I/O
PIROM_ADDR[2]	CW56		I/O
PKGID[0]	DC72		
PKGID[1]	CW72		
PKGID[2]	DA72		
PM_FAST_WAKE_N	AF15	ODCMOS	I/O
PMSYNC	AR14	CMOS	I
PMSYNC_CLK	AT19	CMOS	I
PRDY_N	AG16	OD	0
PREQ_N	AR12	GTL	I
PROC_ID[0]	CY71	N/A	0
PROC_ID[1]	DB71	N/A	0
PROCDIS_N	AB17	CMOS	I
PROCHOT_N	AC16	ODCMOS	I/O
PWR_DEBUG_N	AP17	CMOS	I
PWRGOOD	BC24	CMOS	I
RC_ENET_CLK_DN	AL26		
RC_ENET_CLK_DP	AK27		
RC_ERROR_N	Y23		
RC_GPIO[0]	AE48		I/O
RC_GPIO[1]	AG56		I/O
	1		<u> </u>



Table A-1. Pin List By Name (Sheet 33 of 90)

Locati **Pin Name** Type I/O on RC\_GPIO[10] AF53 I/O RC\_GPIO[11] I/O AE50 RC\_GPIO[12] AG48 I/O RC\_GPIO[13] AG54 I/O RC\_GPIO[14] I/O AD49 RC\_GPIO[15] AE52 I/O RC\_GPIO[2] AH55 RC\_GPIO[3] AG50 I/O RC\_GPIO[4] AD51 I/O I/O RC\_GPIO[5] AG52 RC\_GPIO[6] AK57 RC\_GPIO[7] AJ56 RC\_GPIO[8] AF51 I/O RC\_GPIO[9] AF49 I/O RC\_REFCLK[0]\_DN AP27 RC\_REFCLK[0]\_DP AM27 RC\_REFCLK[1]\_DN **BB25** RC\_REFCLK[1]\_DP BD25 RC\_VCC\_CORE AM21 **PWR** RC\_VCC\_CORE AM25 **PWR** RC\_VCC\_CORE AN18 **PWR** RC\_VCC\_CORE AN22 **PWR** RC\_VCC\_CORE **PWR** AN24 RC\_VCC\_CORE AN26 PWR RC\_VCC\_CORE AP23 **PWR** RC\_VCC\_CORE AP25 PWR RC\_VCC\_CORE AR20 **PWR** RC\_VCC\_CORE AR22 **PWR** RC\_VCC\_CORE AR26 **PWR** RC\_VCC\_CORE AT23 **PWR** RC\_VCC\_CORE PWR AT25 RC\_VCC\_CORE BH19 **PWR** RC\_VCC\_CORE BJ16 PWR RC\_VCC\_CORE BJ18 **PWR** RC\_VCC\_CORE BJ20 **PWR** RC\_VCC\_CORE BK17 **PWR** RC\_VCC\_CORE BL20 PWR RC\_VCC\_CORE BM19 **PWR** RC\_VCC\_CORE BP21 **PWR** RC\_VCC\_CORE BR22 **PWR** RC\_VCC\_CORE BR24 **PWR** 

Table A-1. Pin List By Name (Sheet 34 of 90)

Pin Name	Locati on	Туре	I/O
RC_VCC_CORE	BU20	PWR	
RC_VCC_CORE	BU22	PWR	
RC_VCC_CORE	BV19	PWR	
RC_VCC_CORE	BV21	PWR	
RC_VCC_CORE	BW20	PWR	
RC_VCC_CORE	BY19	PWR	
RC_VCC_CORE	CA22	PWR	
RC_VCC_CORE	CB19	PWR	
RC_VCC_CORE	CB21	PWR	
RC_VCC_CORE	CC20	PWR	
RC_VCC_CORE	CD19	PWR	
RC_VCC_CORE	CD21	PWR	
RC_VCC_CORE	CE22	PWR	
RC_VCC_CORE	CF19	PWR	
RC_VCC_CORE	CF21	PWR	
RC_VCC_CORE	CF23	PWR	
RC_VCC_CORE	CG20	PWR	
RC_VCC_CORE	CG26	PWR	
RC_VCC_CORE	CH21	PWR	
RC_VCC_CORE	CH23	PWR	
RC_VCC_CORE	CJ20	PWR	
RC_VCC_CORE	CJ22	PWR	
RC_VCC_CORE	CJ24	PWR	
RC_VCC_CORE	CJ26	PWR	
RC_VCC_CORE	CK23	PWR	
RC_VCC_CORE	CK25	PWR	
RC_VCC_CORE	CL24	PWR	
RC_VCC_CORE	CL26	PWR	
RC_VCC_CORE	CM23	PWR	
RC_VCC_CORE	CM25	PWR	
RC_VCC_CORE	CN24	PWR	
RC_VCC_CORE	CP23	PWR	
RC_VCC_CORE	CT23	PWR	
RC_VCC_CORE	CU24	PWR	
RC_VCC_CORE	CV23	PWR	
RC_VCC_CORE	CW24	PWR	
RC_VCC_CORE	CY25	PWR	
RC_VCC_CORE	DA24	PWR	
RC_VCCALG_R	BL18	PWR	
RC_VCCALG_R	BM17	PWR	
RC_VCCALG_R	BN18	PWR	



Table A-1. Pin List By Name (Sheet 35 of 90)

Locati **Pin Name** Type I/O on RC\_VCCALG\_R BP17 **PWR** RC\_VCCALG\_R BU18 **PWR** RC\_VCCH A14 **PWR** A16 RC\_VCCH PWR RC\_VCCH B13 **PWR** RC\_VCCH B15 **PWR** RC\_VCCH B17 **PWR** RC\_VCCH\_SENSE\_DP AK21 RC\_VSS\_VCCH\_SENSE\_DN AL20 RESET\_N AP21 Ι **CMOS** RFID\_VCC PWR Α8 **RSVD** A24 RSVD Α6 RSVD AD47 **RSVD** AE46 RSVD AE72 RSVD AF19 RSVD AF47 **RSVD** AF71 RSVD AG20 RSVD AG72 RSVD AH15 RSVD AH19 RSVD AH57 **RSVD** AH71 RSVD AH73 **RSVD** AJ20 RSVD AJ58 RSVD AJ60 **RSVD** AJ62 RSVD AJ70 RSVD AK59 RSVD AK61 RSVD AK69 RSVD AL22 **RSVD** AL58 RSVD AL60 RSVD AL62 **RSVD** AM23 RSVD AM59 RSVD AM61

Table A-1. Pin List By Name (Sheet 36 of 90)

90)			
Pin Name	Locati on	Туре	I/O
RSVD	AN60		
RSVD	AN62		
RSVD	AP61		
RSVD	AR62		
RSVD	AT13		
RSVD	AV77		
RSVD	AW64		
RSVD	AW76		
RSVD	AY65		
RSVD	AY67		
RSVD	AY75		
RSVD	AY77		
RSVD	AY83		
RSVD	В7		
RSVD	B77		
RSVD	B81		
RSVD	BA14		1
RSVD	BA16		1
RSVD	BA18		1
RSVD	BA22		
RSVD	BA64		
RSVD	BA66		
RSVD	BA76		1
RSVD	BA78		
RSVD	BA82		
RSVD	BB13		
RSVD	BB15		
RSVD	BB17		
RSVD	BB21		
RSVD	BB65		
RSVD	BB67		
RSVD	BC14		
RSVD	BC18		
RSVD	BC20		1
RSVD	BC22		
RSVD	BC64		
RSVD	BC66		1
RSVD	BC68		
RSVD	BD17		
RSVD	BD19		
RSVD	BD65		



Table A-1. Pin List By Name (Sheet 37 of 90)

Locati **Pin Name** Туре I/O on RSVD BD67 RSVD BD69 **RSVD** BE18 RSVD BE20 RSVD BE22 **RSVD** BF21 RSVD BG18 RSVD BG20 RSVD BV23 RSVD BW10 RSVD BW22 RSVD BY25 RSVD C18 RSVD C24 RSVD C6 RSVD C82 RSVD CA24 RSVD CB25 RSVD CB5 RSVD CC6 RSVD CD25 RSVD **CE78** RSVD CE80 RSVD CF79 RSVD CF81 RSVD CG10 RSVD **RSVD** CG24 RSVD CG78 RSVD CG82 RSVD CH25 RSVD CH77 RSVD CK19 RSVD CK77 RSVD CN22 RSVD CN28 **RSVD** CP31 RSVD CR60 RSVD CT5 **RSVD** CT69 RSVD CU6

Table A-1. Pin List By Name (Sheet 38 of 90)

Pin Name	Locati on	Туре	I/O
RSVD	CV69		
RSVD	CW22		
RSVD	CW60		
RSVD	CW62		
RSVD	CY23		
RSVD	CY39		
RSVD	CY53		
RSVD	CY57		
RSVD	CY63		
RSVD	CY73		
RSVD	D17		
RSVD	D5		
RSVD	D65		
RSVD	D83		
RSVD	DA40		
RSVD	DA52		
RSVD	DA54		
RSVD	DA56		
RSVD	DC46		
RSVD	DC52		
RSVD	DD51		
RSVD	DG36		
RSVD	DG64		
RSVD	DH65		
RSVD	DJ36		
RSVD	DJ66		
RSVD	DK15		
RSVD	DK37		
RSVD	DK65		
RSVD	DK67		
RSVD	DL38		
RSVD	DL66		
RSVD	DM67		
RSVD	DN62		
RSVD	DN66		
RSVD	DP17		
RSVD	DP65		
RSVD	DR44		
RSVD	DT71		
RSVD	DU44		
RSVD	DV61		

CU60

RSVD



Table A-1. Pin List By Name (Sheet 39 of 90)

Locati I/O **Pin Name** Type on RSVD DV71 RSVD DW44 **RSVD** DW46 RSVD DY3 RSVD E2 **RSVD** E24 RSVD E4 **RSVD** E84 **RSVD** EA4 RSVD EA44 RSVD EB3 **RSVD** EB5 RSVD EB85 RSVD EC16 **RSVD** EC4 RSVD EC44 RSVD EC84 RSVD ED45 **RSVD** ED5 RSVD ED83 RSVD EE16 RSVD EE46 RSVD EE6 RSVD EE82 RSVD EE84 RSVD EF47 **RSVD** EF77 RSVD **EF81** RSVD EF83 F23 **RSVD** RSVD F3 RSVD F65 RSVD F83 RSVD G2 RSVD G64 **RSVD** G84 RSVD Н1 RSVD H83 **RSVD** H85 RSVD J46 RSVD J62

Table A-1. Pin List By Name (Sheet 40 of 90)

90)			
Pin Name	Locati on	Туре	I/O
RSVD	K61		
RSVD	M63		
RSVD	P65		
RSVD	R62		
RSVD	R66		
RSVD	T67		
RSVD	U66		
RSVD	V65		
RSVD	V67		
RSVD	W66		
RSVD	Y65		
SAFE_MODE_BOOT	AR18	CMOS	I
SKTOCC_N	AB13	NA	0
SM_WP	CV59	PIROM	I
SMBCLK	CT59	PIROM	I/O
SMBDAT	CW58	PIROM	I/O
SOCKET_ID[0]	AU22	CMOS	I
SOCKET_ID[1]	AU16	CMOS	I
SOCKET_ID2	AU20	CMOS	I
SVIDALERT_N[0]	DE44	CMOS	I
SVIDALERT_N[1]	DL44	CMOS	I
SVIDCLK[0]	DC44	OD	0
SVIDCLK[1]	DG44	OD	0
SVIDDATA[0]	DB45	ODCMOS	I/O
SVIDDATA[1]	DJ44	ODCMOS	I/O
TCK	AA14	CMOS	I
TDI	AC14	GTL	I
TDO	AE14	OD	0
TEST_1	AF45		
TEST_10	AW22		
TEST_11	AY13		
TEST_12	AY19		
TEST_13	DB51		
TEST_14	DC50		
TEST_15	AW14		
TEST_16	В3		
TEST_17	A4		
TEST_2	AG46		
TEST_3	AM13		
TEST_4	AN12		
TEST_5	AN14		



Table A-1. Pin List By Name (Sheet 41 of 90)

Locati **Pin Name** Type I/O on TEST\_6 AR16 TEST\_7 **AU18** TEST 8 AW16 TEST\_9 AW20 THERMTRIP\_N AB15 OD 0 TMS W14 GTL TRST\_N Y13 GTL Ι TSC\_SYNC AM11 **ODCMOS** I/O TXT\_AGENT AW18 **CMOS** AV15 CMOS Ι TXT\_PLTEN UPI UPIO\_RX\_DN[0] AC10 Ι UPI UPIO\_RX\_DN[1] AA8 UPIO\_RX\_DN[10] AP7 UPI Ι UPIO\_RX\_DN[11] AR8 UPI Ι UPI UPIO\_RX\_DN[12] AU10 Ι UPIO\_RX\_DN[13] BA8 UPI Ι UPIO\_RX\_DN[14] BC6 UPI Ι UPIO\_RX\_DN[15] BD7 UPI Ι UPI UPIO\_RX\_DN[16] AW8 Ι UPIO\_RX\_DN[17] UPI AY9 Ι UPI UPIO\_RX\_DN[18] BD9 Ι UPIO\_RX\_DN[19] BB11 UPI Ι UPIO\_RX\_DN[2] AB7 UPI Ι UPI UPIO\_RX\_DN[3] AD5 Ι UPIO\_RX\_DN[4] AE6 UPI Ι UPIO\_RX\_DN[5] AG8 UPI Ι UPIO\_RX\_DN[6] AJ6 UPI Ι UPI UPIO\_RX\_DN[7] AL6 Ι UPIO\_RX\_DN[8] AK7 UPI Ι UPI UPI0\_RX\_DN[9] AM9 Ι UPI UPIO\_RX\_DP[0] AB9 Ι UPI UPIO\_RX\_DP[1] AC8 Ι UPIO\_RX\_DP[10] AN8 UPI Ι UPIO\_RX\_DP[11] AU8 UPI Ι UPI UPIO\_RX\_DP[12] AT9 Ι UPIO\_RX\_DP[13] AY7 UPI Ι UPI UPIO\_RX\_DP[14] BB7 Ι UPI UPIO\_RX\_DP[15] BF7 Ι UPIO\_RX\_DP[16] AV9 UPI Ι UPIO\_RX\_DP[17] BB9 UPI Ι

Table A-1. Pin List By Name (Sheet 42 of 90)

Pin Name	Locati on	Туре	I/O
UPIO_RX_DP[19]	BA10	UPI	I
UPI0_RX_DP[2]	AA6	UPI	I
UPIO_RX_DP[3]	AC6	UPI	I
UPI0_RX_DP[4]	AG6	UPI	I
UPI0_RX_DP[5]	AF7	UPI	I
UPI0_RX_DP[6]	AH7	UPI	I
UPI0_RX_DP[7]	AK5	UPI	I
UPIO_RX_DP[8]	AM7	UPI	I
UPI0_RX_DP[9]	AL8	UPI	I
UPI0_TX_DN[0]	N2	UPI	I
UPIO_TX_DN[1]	P1	UPI	I
UPIO_TX_DN[10]	AM3	UPI	I
UPIO_TX_DN[11]	AN4	UPI	I
UPI0_TX_DN[12]	AT1	UPI	I
UPIO_TX_DN[13]	AT3	UPI	I
UPI0_TX_DN[14]	AU4	UPI	I
UPI0_TX_DN[15]	AV5	UPI	I
UPIO_TX_DN[16]	BA4	UPI	I
UPI0_TX_DN[17]	BB3	UPI	I
UPI0_TX_DN[18]	BF3	UPI	I
UPI0_TX_DN[19]	BG4	UPI	I
UPI0_TX_DN[2]	V3	UPI	I
UPI0_TX_DN[3]	Y1	UPI	I
UPI0_TX_DN[4]	AB3	UPI	I
UPI0_TX_DN[5]	AC2	UPI	I
UPIO_TX_DN[6]	AG4	UPI	I
UPI0_TX_DN[7]	AE2	UPI	I
UPI0_TX_DN[8]	AH3	UPI	I
UPI0_TX_DN[9]	AL2	UPI	I
UPI0_TX_DP[0]	M1	UPI	I
UPI0_TX_DP[1]	T1	UPI	I
UPIO_TX_DP[10]	AK3	UPI	I
UPIO_TX_DP[11]	AP3	UPI	I
UPI0_TX_DP[12]	AP1	UPI	I
UPI0_TX_DP[13]	AR2	UPI	I
UPIO_TX_DP[14]	AR4	UPI	I
UPIO_TX_DP[15]	AW4	UPI	I
UPIO_TX_DP[16]	AY3	UPI	I
UPI0_TX_DP[17]	BC2	UPI	I
UPIO_TX_DP[18]	BD3	UPI	I
UPIO_TX_DP[19]	ВН3	UPI	I

BC10

UPI

Ι

UPIO\_RX\_DP[18]



Table A-1. Pin List By Name (Sheet 43 of 90)

Locati **Pin Name** Type I/O on UPI0\_TX\_DP[2] Υ3 UPI Ι UPI0\_TX\_DP[3] W2 UPI UPI0\_TX\_DP[4] AA2 UPI Ι UPI0\_TX\_DP[5] AD1 UPI Ι UPI UPI0\_TX\_DP[6] AF3 Ι UPI0\_TX\_DP[7] AG2 UPI Ι UPI0\_TX\_DP[8] AJ2 UPI Ι UPI0\_TX\_DP[9] AK1 UPI Ι UPI01\_RBIAS AP29 UPI AT29 Ι UPI01\_RBIAS UPI UPI1\_RX\_DN[0] T5 UPI Ι UPI1\_RX\_DN[1] Р7 UPI UPI1\_RX\_DN[10] R16 UPI Ι UPI1\_RX\_DN[11] P17 UPI Ι UPI1\_RX\_DN[12] U16 UPI Ι UPI1\_RX\_DN[13] W18 UPI Ι UPI1\_RX\_DN[14] R20 UPI Ι UPI1\_RX\_DN[15] U18 UPI Ι UPI1\_RX\_DN[16] P21 UPI Ι UPI1\_RX\_DN[17] V19 UPI Ι UPI UPI1\_RX\_DN[18] Y21 Ι UPI1\_RX\_DN[19] AB19 UPI Ι V7 UPI UPI1\_RX\_DN[2] Ι UPI UPI1\_RX\_DN[3] Т9 Ι UPI1\_RX\_DN[4] Р9 UPI Ι UPI1\_RX\_DN[5] R10 UPI Ι UPI1\_RX\_DN[6] U12 UPI Ι UPI UPI1\_RX\_DN[7] L12 Ι UPI1\_RX\_DN[8] N14 UPI Ι \_\_\_\_ UPI1\_RX\_DN[9] R12 UPI Ι UPI UPI1\_RX\_DP[0] R6 Ι UPI1\_RX\_DP[1] T7 UPI Ι UPI1\_RX\_DP[10] T15 UPI Ι N16 UPI UPI1\_RX\_DP[11] Ι UPI1\_RX\_DP[12] W16 UPI Ι UPI1\_RX\_DP[13] V17 UPI Ι UPI1\_RX\_DP[14] P19 UPI Ι UPI UPI1\_RX\_DP[15] T19 Ι UPI1\_RX\_DP[16] T21 UPI Ι UPI1\_RX\_DP[17] Y19 UPI Ι UPI1\_RX\_DP[18] W20 UPI Ι

Table A-1. Pin List By Name (Sheet 44 of 90)

	Locati	_	
Pin Name	on	Туре	I/O
UPI1_RX_DP[19]	AA20	UPI	I
UPI1_RX_DP[2]	U8	UPI	I
UPI1_RX_DP[3]	R8	UPI	I
UPI1_RX_DP[4]	N10	UPI	I
UPI1_RX_DP[5]	U10	UPI	I
UPI1_RX_DP[6]	T11	UPI	I
UPI1_RX_DP[7]	N12	UPI	I
UPI1_RX_DP[8]	M13	UPI	I
UPI1_RX_DP[9]	P13	UPI	I
UPI1_TX_DN[0]	М3	UPI	0
UPI1_TX_DN[1]	L4	UPI	0
UPI1_TX_DN[10]	E12	UPI	0
UPI1_TX_DN[11]	G14	UPI	0
UPI1_TX_DN[12]	D15	UPI	0
UPI1_TX_DN[13]	F15	UPI	0
UPI1_TX_DN[14]	H17	UPI	0
UPI1_TX_DN[15]	K19	UPI	0
UPI1_TX_DN[16]	G18	UPI	0
UPI1_TX_DN[17]	J20	UPI	0
UPI1_TX_DN[18]	F21	UPI	0
UPI1_TX_DN[19]	H21	UPI	0
UPI1_TX_DN[2]	K5	UPI	0
UPI1_TX_DN[3]	J6	UPI	0
UPI1_TX_DN[4]	G6	UPI	0
UPI1_TX_DN[5]	H7	UPI	0
UPI1_TX_DN[6]	K9	UPI	0
UPI1_TX_DN[7]	D9	UPI	0
UPI1_TX_DN[8]	F11	UPI	0
UPI1_TX_DN[9]	G10	UPI	0
UPI1_TX_DP[0]	Р3	UPI	0
UPI1_TX_DP[1]	K3	UPI	0
UPI1_TX_DP[10]	G12	UPI	0
UPI1_TX_DP[11]	F13	UPI	0
UPI1_TX_DP[12]	E14	UPI	0
UPI1_TX_DP[13]	H15	UPI	0
UPI1_TX_DP[14]	G16	UPI	0
UPI1_TX_DP[15]	L18	UPI	0
UPI1_TX_DP[16]	J18	UPI	0
UPI1_TX_DP[17]	H19	UPI	0
UPI1_TX_DP[18]	G20	UPI	0
UPI1_TX_DP[19]	K21	UPI	0
	•	•	



Table A-1. Pin List By Name (Sheet 45 of 90)

Locati **Pin Name** Type I/O on UPI1\_TX\_DP[2] М5 UPI 0 UPI UPI1\_TX\_DP[3] Н5 0 UPI1\_TX\_DP[4] F7 UPI 0 UPI 0 UPI1\_TX\_DP[5] Κ7 UPI 0 UPI1\_TX\_DP[6] J8 UPI1\_TX\_DP[7] F9 UPI 0 UPI1\_TX\_DP[8] E10 UPI 0 UPI 0 UPI1\_TX\_DP[9] Н9 UPI2\_RBIAS CK29 UPI2\_RBIAS CL28 UPI2\_RX\_DN[0] DF23 UPI Ι UPI UPI2\_RX\_DN[1] DE22 UPI2\_RX\_DN[10] CN20 UPI Ι UPI2\_RX\_DN[11] CP21 UPI Ι UPI2\_RX\_DN[12] CL16 UPI Ι UPI2\_RX\_DN[13] CJ18 UPI Ι UPI2\_RX\_DN[14] CH17 UPI T UPI2\_RX\_DN[15] CE16 UPI Ι UPI2\_RX\_DN[16] CD15 UPI Ι UPI2\_RX\_DN[17] UPI CF17 Ι UPI UPI2\_RX\_DN[18] **CB15** Ι UPI2\_RX\_DN[19] BY17 UPI Ι UPI2\_RX\_DN[2] UPI DC22 Ι UPI2\_RX\_DN[3] DB21 UPI Ι UPI2\_RX\_DN[4] DD19 UPI Ι UPI2\_RX\_DN[5] DA20 UPI Ι UPI2\_RX\_DN[6] CW20 UPI Ι UPI2\_RX\_DN[7] UPI CV19 Ι UPI2\_RX\_DN[8] CT21 UPI Ι UPI UPI2\_RX\_DN[9] **CR18** Ι UPI UPI2\_RX\_DP[0] DG22 Ι UPI2\_RX\_DP[1] DD21 UPI Ι UPI2\_RX\_DP[10] CP19 UPI Ι UPI2\_RX\_DP[11] CM21 UPI Ι CJ16 UPI UPI2\_RX\_DP[12] Ι UPI2\_RX\_DP[13] CK17 UPI Ι UPI2\_RX\_DP[14] CG16 UPI Ι UPI UPI2\_RX\_DP[15] CF15 Ι UPI2\_RX\_DP[16] CC14 UPI Ι UPI2\_RX\_DP[17] CD17 UPI Ι

Table A-1. Pin List By Name (Sheet 46 of 90)

Pin Name	Locati on	Туре	I/O
UPI2_RX_DP[19]	CA16	UPI	I
UPI2_RX_DP[2]	DA22	UPI	I
UPI2_RX_DP[3]	DC20	UPI	I
UPI2_RX_DP[4]	DB19	UPI	I
UPI2_RX_DP[5]	CY19	UPI	I
UPI2_RX_DP[6]	CU20	UPI	I
UPI2_RX_DP[7]	CW18	UPI	I
UPI2_RX_DP[8]	CR20	UPI	I
UPI2_RX_DP[9]	CN18	UPI	I
UPI2_TX_DN[0]	DT21	UPI	0
UPI2_TX_DN[1]	DM21	UPI	0
UPI2_TX_DN[10]	DA16	UPI	0
UPI2_TX_DN[11]	CW14	UPI	0
UPI2_TX_DN[12]	CU14	UPI	0
UPI2_TX_DN[13]	CM13	UPI	0
UPI2_TX_DN[14]	CJ14	UPI	0
UPI2_TX_DN[15]	CF13	UPI	0
UPI2_TX_DN[16]	CH11	UPI	0
UPI2_TX_DN[17]	CE12	UPI	0
UPI2_TX_DN[18]	CC10	UPI	0
UPI2_TX_DN[19]	CC12	UPI	0
UPI2_TX_DN[2]	DL20	UPI	0
UPI2_TX_DN[3]	DG20	UPI	0
UPI2_TX_DN[4]	DH19	UPI	0
UPI2_TX_DN[5]	DK17	UPI	0
UPI2_TX_DN[6]	DG18	UPI	0
UPI2_TX_DN[7]	DD17	UPI	0
UPI2_TX_DN[8]	DF15	UPI	0
UPI2_TX_DN[9]	DC16	UPI	0
UPI2_TX_DP[0]	DP21	UPI	0
UPI2_TX_DP[1]	DN20	UPI	0
UPI2_TX_DP[10]	CW16	UPI	0
UPI2_TX_DP[11]	CV13	UPI	0
UPI2_TX_DP[12]	CR14	UPI	0
UPI2_TX_DP[13]	CK13	UPI	0
UPI2_TX_DP[14]	CH13	UPI	0
UPI2_TX_DP[15]	CG12	UPI	0
UPI2_TX_DP[16]	CF11	UPI	0
UPI2_TX_DP[17]	CD11	UPI	0
UPI2_TX_DP[18]	CB11	UPI	0
UPI2_TX_DP[19]	CA12	UPI	0

BY15

UPI

Ι

UPI2\_RX\_DP[18]



Table A-1. Pin List By Name (Sheet 47 of 90)

Locati **Pin Name** Type I/O on UPI2\_TX\_DP[2] DK19 UPI 0 UPI2\_TX\_DP[3] DJ20 UPI 0 UPI2\_TX\_DP[4] DJ18 UPI 0 0 UPI2\_TX\_DP[5] DH17 UPI UPI UPI2\_TX\_DP[6] DF17 0 UPI2\_TX\_DP[7] DE16 UPI 0 UPI2\_TX\_DP[8] DD15 UPI 0 UPI2\_TX\_DP[9] DB15 UPI 0 VCC33 CY55 **PWR** VCCD012 AD45 **PWR** VCCD012 AF55 PWR VCCD012 AF57 **PWR** VCCD012 AF59 PWR VCCD012 AF61 PWR VCCD012 AF63 **PWR** VCCD012 B47 PWR VCCD012 B49 **PWR** VCCD012 B53 PWR VCCD012 B59 **PWR** VCCD012 C46 PWR VCCD012 D45 **PWR** VCCD012 E46 **PWR** VCCD012 E48 **PWR** VCCD012 E50 **PWR** VCCD012 E52 **PWR** VCCD012 E54 PWR VCCD012 E56 **PWR** VCCD012 E58 **PWR** VCCD012 E60 PWR VCCD012 E62 **PWR** VCCD012 E64 PWR VCCD012 L46 **PWR** VCCD012 L48 **PWR** VCCD012 L50 **PWR** VCCD012 L52 **PWR** VCCD012 L54 **PWR** VCCD012 L56 PWR VCCD012 L58 **PWR** VCCD012 L60 **PWR** VCCD012 L62 **PWR** VCCD012 **PWR** N64

Table A-1. Pin List By Name (Sheet 48 of 90)

90)			
Pin Name	Locati on	Туре	I/O
VCCD012	U46	PWR	
VCCD012	U48	PWR	
VCCD012	U50	PWR	
VCCD012	U52	PWR	
VCCD012	U54	PWR	
VCCD012	U56	PWR	
VCCD012	U58	PWR	
VCCD012	U60	PWR	
VCCD012	U62	PWR	
VCCD012	W64	PWR	
VCCD012	Y45	PWR	
VCCD012	Y47	PWR	
VCCD012	Y49	PWR	
VCCD012	Y51	PWR	
VCCD012	Y53	PWR	
VCCD012	Y55	PWR	
VCCD012	Y57	PWR	
VCCD012	Y59	PWR	
VCCD012	Y61	PWR	
VCCD012	Y63	PWR	
VCCD345	DB53	PWR	
VCCD345	DB55	PWR	
VCCD345	DB57	PWR	
VCCD345	DB59	PWR	
VCCD345	DB61	PWR	
VCCD345	DB63	PWR	
VCCD345	DD45	PWR	
VCCD345	DH45	PWR	
VCCD345	DH47	PWR	
VCCD345	DH49	PWR	
VCCD345	DH51	PWR	
VCCD345	DH53	PWR	
VCCD345	DH55	PWR	
VCCD345	DH57	PWR	
VCCD345	DH59	PWR	
VCCD345	DH61	PWR	
VCCD345	DH63	PWR	
VCCD345	DJ64	PWR	
VCCD345	DL46	PWR	
VCCD345	DL48	PWR	
VCCD345	DL50	PWR	



Table A-1. Pin List By Name (Sheet 49 of 90)

Locati **Pin Name** Type I/O on VCCD345 DL52 **PWR** VCCD345 **DL54 PWR** VCCD345 **DL56 PWR** DL58 VCCD345 **PWR** VCCD345 **PWR DL60** VCCD345 DL62 **PWR** DU46 VCCD345 **PWR** VCCD345 **DU48 PWR** VCCD345 DU50 **PWR** VCCD345 DU52 **PWR** VCCD345 DU54 PWR VCCD345 DU56 **PWR** VCCD345 DU58 **PWR** VCCD345 DU60 PWR VCCD345 DU62 **PWR** VCCD345 DU64 **PWR** VCCD345 EC46 PWR VCCD345 EC48 **PWR** VCCD345 EC50 **PWR** VCCD345 EC52 **PWR** VCCD345 PWR EC54 VCCD345 EC56 **PWR** VCCD345 EC58 **PWR** VCCD345 EC60 PWR EC62 VCCD345 **PWR** VCCD345 EE44 **PWR** VCCD345 EF45 **PWR** VCCD345 EF49 **PWR** VCCD345 EF53 **PWR** VCCD345 EF59 **PWR** VCCIN AF43 PWR VCCIN AG38 **PWR** VCCIN AG40 PWR VCCIN AG42 **PWR** VCCIN **AH37 PWR VCCIN AH39 PWR** VCCIN AH41 PWR VCCIN AJ36 **PWR VCCIN** AK35 **PWR** VCCIN AK45 **PWR** 

Table A-1. Pin List By Name (Sheet 50 of 90)

VCCIN	AK49 AK51 AK53 AL34	PWR PWR	
VCCIN	AK53		
VCCIN	AL34	PWR	
ACCTIA		PWR	
VCCIN	AL46	PWR	
VCCIN	AL48	PWR	
VCCIN	AL50	PWR	
VCCIN	AL52	PWR	
VCCIN	AL54	PWR	
VCCIN	AM33	PWR	
VCCIN	AM53	PWR	
VCCIN	AM55	PWR	
VCCIN	AN32	PWR	
VCCIN	AN54	PWR	
VCCIN	AN56	PWR	
VCCIN	AP55	PWR	
VCCIN	AP57	PWR	
VCCIN	AR56	PWR	
VCCIN	AR58	PWR	
VCCIN	AT57	PWR	
VCCIN	AT59	PWR	
VCCIN	AU58	PWR	
VCCIN	AU60	PWR	
VCCIN	AV59	PWR	
VCCIN	AV61	PWR	
VCCIN	AW60	PWR	
VCCIN	AY61	PWR	
VCCIN	BA60	PWR	
VCCIN	BB61	PWR	
VCCIN	BB85	PWR	
VCCIN	BC60	PWR	
VCCIN	BC62	PWR	
VCCIN	BC84	PWR	
VCCIN	BD61	PWR	
VCCIN	BD73	PWR	
VCCIN	BD75	PWR	
VCCIN	BD77	PWR	
VCCIN	BD79	PWR	
VCCIN	BD81	PWR	
VCCIN	BD83	PWR	
VCCIN	BD85	PWR	

AK47

**PWR** 

**VCCIN** 



Table A-1. Pin List By Name (Sheet 51 of 90)

Locati **Pin Name** Type I/O on VCCIN BE60 **PWR** VCCIN BE62 **PWR VCCIN** BE72 **PWR** VCCIN BE74 PWR VCCIN BE76 **PWR VCCIN** BE78 **PWR** VCCIN BE80 PWR **VCCIN** BE82 **PWR VCCIN** BE84 **PWR** VCCIN BF61 **PWR** VCCIN BF73  $\mathsf{PWR}$ **VCCIN** BF75 **PWR** VCCIN BF77 PWR VCCIN BF79 **PWR** VCCIN BF81 **PWR** VCCIN BF83 PWR VCCIN **PWR** BF85 VCCIN BG60 **PWR VCCIN** BG62 **PWR** VCCIN BG64 **PWR** VCCIN BG66 **PWR** VCCIN BG68 **PWR** VCCIN BG70 **PWR** VCCIN PWR BG84 **VCCIN** BH61 **PWR** VCCIN BH63 PWR PWR **VCCIN BH65** VCCIN **BH67 PWR** VCCIN BH69 PWR **VCCIN** BH71 **PWR** VCCIN BH73 PWR **VCCIN** BH75 **PWR** VCCIN BH77 **PWR** VCCIN BH79 **PWR** VCCIN BH81 **PWR** VCCIN **BH83 PWR** VCCIN BJ60 PWR VCCIN BJ62 **PWR** VCCIN BJ64 **PWR** VCCIN BJ66 **PWR VCCIN** BJ68 **PWR** 

Table A-1. Pin List By Name (Sheet 52 of 90)

90)			
Pin Name	Locati on	Туре	I/O
VCCIN	BJ70	PWR	
VCCIN	BJ72	PWR	
VCCIN	BJ74	PWR	
VCCIN	BJ76	PWR	
VCCIN	BJ78	PWR	
VCCIN	BJ80	PWR	
VCCIN	BJ82	PWR	
VCCIN	BJ84	PWR	
VCCIN	BK61	PWR	
VCCIN	BK63	PWR	
VCCIN	BK65	PWR	
VCCIN	BK67	PWR	
VCCIN	BK69	PWR	
VCCIN	BK71	PWR	
VCCIN	BK73	PWR	
VCCIN	BK75	PWR	
VCCIN	BK77	PWR	
VCCIN	BK79	PWR	
VCCIN	BK81	PWR	
VCCIN	BK83	PWR	
VCCIN	BL60	PWR	
VCCIN	BL62	PWR	
VCCIN	BL84	PWR	
VCCIN	BM61	PWR	
VCCIN	BM63	PWR	
VCCIN	BM65	PWR	
VCCIN	BM67	PWR	
VCCIN	BM69	PWR	
VCCIN	BM71	PWR	
VCCIN	BM73	PWR	
VCCIN	BM75	PWR	
VCCIN	BM77	PWR	
VCCIN	BM79	PWR	
VCCIN	BM81	PWR	
VCCIN	BM83	PWR	
VCCIN	BN60	PWR	
VCCIN	BN62	PWR	
VCCIN	BN64	PWR	
VCCIN	BN66	PWR	
VCCIN	BN68	PWR	
VCCIN	BN70	PWR	



Pin List By Name (Sheet 53 of 90) Table A-1.

Locati **Pin Name** Type I/O on VCCIN BN72 **PWR** VCCIN BN74 **PWR VCCIN** BN76 **PWR** VCCIN BN78 **PWR** VCCIN BN80 PWR VCCIN **BN82 PWR** VCCIN **BN84 PWR** VCCIN BP61 **PWR** VCCIN BP63 **PWR** VCCIN BP65 **PWR** VCCIN PWR BP67 VCCIN BP69 **PWR** VCCIN BP71 **PWR** VCCIN BP73 PWR VCCIN BP75 **PWR** VCCIN BP77 **PWR** VCCIN BP79 PWR VCCIN BP81 PWR VCCIN BP83 **PWR** VCCIN BR60 PWR PWR VCCIN BR62 VCCIN **BR84** PWR VCCIN BT61 **PWR** VCCIN BT63 PWR BT65 **VCCIN PWR** VCCIN BT67 **PWR VCCIN** BT69 **PWR** VCCIN BT71 **PWR** VCCIN BT73 **PWR VCCIN** BT75 **PWR** VCCIN BT77 PWR VCCIN BT79 **PWR** VCCIN BT81 PWR VCCIN BT83 **PWR** VCCIN BU60 PWR **VCCIN** BU62 **PWR** VCCIN BU64 PWR VCCIN BU66 **PWR VCCIN BU68 PWR** VCCIN BU70 **PWR** 

Pin List By Name (Sheet 54 of 90) Table A-1.

Pin Name	Locati on	Туре	I/O
VCCIN	BU74	PWR	
VCCIN	BU76	PWR	
VCCIN	BU78	PWR	
VCCIN	BU80	PWR	
VCCIN	BU82	PWR	
VCCIN	BU84	PWR	
VCCIN	BV61	PWR	
VCCIN	BV63	PWR	
VCCIN	BV65	PWR	
VCCIN	BV67	PWR	
VCCIN	BV69	PWR	
VCCIN	BV71	PWR	
VCCIN	BV73	PWR	
VCCIN	BV75	PWR	
VCCIN	BV77	PWR	
VCCIN	BV79	PWR	
VCCIN	BV81	PWR	
VCCIN	BV83	PWR	
VCCIN	BW60	PWR	
VCCIN	BW62	PWR	
VCCIN	BW64	PWR	
VCCIN	BW66	PWR	
VCCIN	BW68	PWR	
VCCIN	BW70	PWR	
VCCIN	BW84	PWR	
VCCIN	BY61	PWR	
VCCIN	BY73	PWR	
VCCIN	BY75	PWR	
VCCIN	BY77	PWR	
VCCIN	BY79	PWR	
VCCIN	BY81	PWR	
VCCIN	BY83	PWR	
VCCIN	CA60	PWR	
VCCIN	CA62	PWR	
VCCIN	CA72	PWR	
VCCIN	CA74	PWR	
VCCIN	CA76	PWR	
VCCIN	CA78	PWR	
VCCIN	CA80	PWR	
VCCIN	CA82	PWR	
VCCIN	CA84	PWR	

BU72

**PWR** 

VCCIN



Table A-1. Pin List By Name (Sheet 55 of 90)

Locati **Pin Name** Type I/O on CB61 VCCIN **PWR** VCCIN CB73 **PWR** VCCIN **CB75 PWR** VCCIN CB77 PWR VCCIN **CB79 PWR** VCCIN CB81 **PWR** VCCIN **CB83** PWR **VCCIN** CC60 **PWR VCCIN** CC62 **PWR** VCCIN CC84 **PWR** VCCIN CD61 PWR **VCCIN** CD83 **PWR** VCCIN CD85 PWR VCCIN CE60 **PWR VCCIN** CE84 **PWR** VCCIN CF61 PWR VCCIN **PWR** CF85 **VCCIN** CG60 **PWR VCCIN** CG84 **PWR** VCCIN CH61 **PWR VCCIN** CH85 **PWR** VCCIN CJ60 **PWR** VCCIN CK59 **PWR** VCCIN CK61 PWR **VCCIN** CL58 **PWR** VCCIN CL60 PWR PWR **VCCIN** CM57 VCCIN CM59 **PWR** VCCIN CN56 PWR **VCCIN** CN58 **PWR** VCCIN CP33 PWR **VCCIN** CP55 **PWR** CP57 VCCIN **PWR** VCCIN CR34 **PWR** VCCIN CR54 **PWR VCCIN CR56 PWR** VCCIN CT37 **PWR** VCCIN CT39 **PWR VCCIN** CT41 **PWR** VCCIN CT53 **PWR VCCIN** CT55 **PWR** 

Table A-1. Pin List By Name (Sheet 56 of 90)

90)			
Pin Name	Locati on	Туре	I/O
VCCIN	CU38	PWR	
VCCIN	CU40	PWR	
VCCIN	CU42	PWR	
VCCIN	CU52	PWR	
VCCIN	CU54	PWR	
VCCIN	CV51	PWR	
VCCIN	CW46	PWR	
VCCIN	CW48	PWR	
VCCIN	CW50	PWR	
VCCIN	CY47	PWR	
VCCIN	CY49	PWR	
VCCIN_SENSE	BA86	PWR	
VCCINPMAX	AV85	PWR	
VCCINPMAX	AW86	PWR	
VCCIO	AA10	PWR	
VCCIO	AC20	PWR	
VCCIO	AC36	PWR	
VCCIO	AC4	PWR	
VCCIO	AD35	PWR	
VCCIO	AD37	PWR	
VCCIO	AE10	PWR	
VCCIO	AE34	PWR	
VCCIO	AE36	PWR	
VCCIO	AF35	PWR	
VCCIO	AF5	PWR	
VCCIO	AG34	PWR	
VCCIO	AH9	PWR	
VCCIO	AL28	PWR	
VCCIO	AM29	PWR	
VCCIO	AM5	PWR	
VCCIO	AN10	PWR	
VCCIO	AR28	PWR	
VCCIO	AT11	PWR	
VCCIO	AT5	PWR	
VCCIO	AT7	PWR	
VCCIO	AV27	PWR	
VCCIO	AW26	PWR	
VCCIO	AW6	PWR	
VCCIO	AY11	PWR	
VCCIO	AY27	PWR	
VCCIO	BA24	PWR	



Table A-1. Pin List By Name (Sheet 57 of 90)

Locati **Pin Name** Type I/O on VCCIO **BA26 PWR** VCCIO BB27 **PWR** VCCIO BB5 **PWR** VCCIO BC26 PWR VCCIO BE24 PWR VCCIO BF23 **PWR** VCCIO BF27 **PWR** VCCIO BG26 **PWR** VCCIO BH25 **PWR** VCCIO BH27 **PWR** VCCIO PWR BJ24 VCCIO BJ26 **PWR** VCCIO BK25 **PWR** VCCIO BK27 PWR VCCIO BL26 **PWR** VCCIO BM27 **PWR** VCCIO BP25 PWR VCCIO CB13 PWR VCCIO **CB17 PWR** VCCIO CC26 PWR VCCIO CD27 **PWR** VCCIO CD9 PWR VCCIO CE18 **PWR** VCCIO CF27 PWR VCCIO CF5 **PWR** VCCIO CG14 PWR VCCIO CH27 **PWR** VCCIO CH9 PWR VCCIO CJ28 **PWR** VCCIO CK5 **PWR** VCCIO CL12 PWR VCCIO CL20 **PWR** VCCIO CM15 PWR VCCIO CN6 **PWR** VCCIO CP13 PWR VCCIO CU12 **PWR** VCCIO **CU18** PWR VCCIO CV21 **PWR** VCCIO CV7 **PWR** VCCIO CY17 **PWR** 

Table A-1. Pin List By Name (Sheet 58 of 90)

Pin Name	Locati on	Туре	I/O
VCCIO	DA14	PWR	
VCCIO	DC18	PWR	
VCCIO	DD7	PWR	
VCCIO	DE14	PWR	
VCCIO	DF13	PWR	
VCCIO	DF21	PWR	
VCCIO	DG8	PWR	
VCCIO	DH7	PWR	
VCCIO	DJ16	PWR	
VCCIO	DK21	PWR	
VCCIO	DM17	PWR	
VCCIO	DN8	PWR	
VCCIO	DP19	PWR	
VCCIO	DR10	PWR	
VCCIO	DR2	PWR	
VCCIO	DU20	PWR	
VCCIO	DV11	PWR	
VCCIO	EA12	PWR	
VCCIO	EB15	PWR	
VCCIO	EE10	PWR	
VCCIO	H13	PWR	
VCCIO	J10	PWR	
VCCIO	J2	PWR	
VCCIO	K15	PWR	
VCCIO	L14	PWR	
VCCIO	L16	PWR	
VCCIO	M11	PWR	
VCCIO	M21	PWR	
VCCIO	M7	PWR	
VCCIO	M9	PWR	
VCCIO	N18	PWR	
VCCIO	P5	PWR	
VCCIO	Т3	PWR	
VCCIO	U14	PWR	
VCCIO	W10	PWR	
VCCIO	W4	PWR	
VCCIO	W6	PWR	
VCCIO_SENSE	BH5	PWR	
VCCSA	CB65	PWR	
VCCSA	CB67	PWR	
VCCSA	CB69	PWR	

D7

**PWR** 

VCCIO



Table A-1. Pin List By Name (Sheet 59 of 90)

Locati **Pin Name** Type I/O on VCCSA CC66 PWR VCCSA CC68 **PWR VCCSA** CC70 **PWR** VCCSA CD65 **PWR** VCCSA CD67 **PWR VCCSA** CD69 **PWR** VCCSA CD71 **PWR** VCCSA CE64 **PWR VCCSA** CE66 **PWR** VCCSA CE68 **PWR** VCCSA CE72 PWR **VCCSA CE74 PWR** VCCSA CF65 PWR VCCSA CF67 **PWR VCCSA** CF73 **PWR** VCCSA CF75 PWR VCCSA **PWR** CG64 **VCCSA** CG66 **PWR VCCSA** CG74 **PWR** VCCSA CH65 **PWR VCCSA** CH75 **PWR** VCCSA CJ64 **PWR** CJ66 VCCSA **PWR** PWR VCCSA\_SENSE CE76 **VSENSEPMAX** AD41 A26 PWR VSS A30 **PWR** VSS A32 **PWR** VSS A36 PWR VSS A38 **PWR** VSS A42 PWR VSS **AA16 PWR** VSS **AA18 PWR** VSS AA22 **PWR** VSS AA24 **PWR** VSS AA30 **PWR** VSS AA36 **PWR** VSS AA4 **PWR** VSS AA42 **PWR** VSS AA64 PWR VSS **AA66 PWR** 

Table A-1. Pin List By Name (Sheet 60 of 90)

90)			
Pin Name	Locati on	Туре	I/O
VSS	AA68	PWR	
VSS	AA76	PWR	
VSS	AA78	PWR	
VSS	AA80	PWR	
VSS	AA82	PWR	
VSS	AB1	PWR	
VSS	AB11	PWR	
VSS	AB21	PWR	
VSS	AB23	PWR	
VSS	AB25	PWR	
VSS	AB29	PWR	
VSS	AB31	PWR	
VSS	AB35	PWR	
VSS	AB37	PWR	
VSS	AB41	PWR	
VSS	AB5	PWR	
VSS	AB65	PWR	
VSS	AB69	PWR	
VSS	AB73	PWR	
VSS	AB79	PWR	
VSS	AB83	PWR	
VSS	AB85	PWR	
VSS	AC18	PWR	
VSS	AC22	PWR	
VSS	AC26	PWR	
VSS	AC28	PWR	
VSS	AC32	PWR	
VSS	AC34	PWR	
VSS	AC38	PWR	
VSS	AC40	PWR	
VSS	AC48	PWR	
VSS	AC50	PWR	
VSS	AC52	PWR	
VSS	AC54	PWR	
VSS	AC56	PWR	
VSS	AC58	PWR	
VSS	AC60	PWR	
VSS	AC62	PWR	
VSS	AC64	PWR	
VSS	AC70	PWR	
VSS	AC72	PWR	



Table A-1. Pin List By Name (Sheet 61 of 90)

Locati I/O **Pin Name** Type on VSS AC78 **PWR** VSS PWR AC84 VSS AC86 **PWR** VSS AD11 PWR VSS AD13 **PWR** VSS AD15 **PWR** VSS AD19 **PWR** VSS AD21 **PWR** VSS AD27 **PWR** VSS AD3 **PWR** VSS PWR AD33 VSS AD39 **PWR** VSS AD43 PWR VSS AD7 PWR VSS AD71 **PWR** VSS AD73 PWR VSS AD75 **PWR** VSS AD81 PWR VSS AD83 **PWR** VSS AD85 PWR VSS AD9 **PWR** VSS AE16 PWR VSS AE38 **PWR** PWR VSS AE4 VSS AE40 **PWR** VSS AE42 PWR VSS AE64 **PWR** VSS PWR AE66 VSS AE68 PWR PWR AE70 VSS VSS AE78 PWR VSS AE8 **PWR** VSS AF1 PWR VSS AF21 **PWR** VSS AF23 PWR VSS AF25 **PWR** VSS AF27 PWR VSS AF29 PWR VSS AF31 **PWR** VSS AF33 **PWR** 

Table A-1. Pin List By Name (Sheet 62 of 90)

Pin Name	Locati on	Туре	I/O
VSS	AF39	PWR	
VSS	AF41	PWR	
VSS	AF73	PWR	
VSS	AF77	PWR	
VSS	AF83	PWR	
VSS	AF85	PWR	
VSS	AF9	PWR	
VSS	AG12	PWR	
VSS	AG14	PWR	
VSS	AG18	PWR	
VSS	AG36	PWR	
VSS	AG64	PWR	
VSS	AG70	PWR	
VSS	AG74	PWR	
VSS	AG76	PWR	
VSS	AG78	PWR	
VSS	AG80	PWR	
VSS	AH1	PWR	
VSS	AH21	PWR	
VSS	AH27	PWR	
VSS	AH33	PWR	
VSS	AH35	PWR	
VSS	AH45	PWR	
VSS	AH47	PWR	
VSS	AH49	PWR	
VSS	AH5	PWR	
VSS	AH51	PWR	
VSS	AH53	PWR	
VSS	AH59	PWR	
VSS	AH61	PWR	
VSS	AH65	PWR	
VSS	AH69	PWR	
VSS	AH75	PWR	
VSS	AH77	PWR	
VSS	AH83	PWR	
VSS	AJ22	PWR	
VSS	AJ26	PWR	
VSS	AJ28	PWR	
VSS	AJ32	PWR	
VSS	AJ34	PWR	
VSS	AJ4	PWR	

AF37

**PWR** 



Table A-1. Pin List By Name (Sheet 63 of 90)

Locati **Pin Name** Type I/O on VSS AJ46 **PWR** VSS AJ48 **PWR** VSS AJ50 **PWR** VSS AJ52 **PWR** VSS AJ54 **PWR** VSS AJ66 **PWR** VSS AJ68 **PWR** VSS AJ74 **PWR** VSS AJ78 **PWR** VSS AJ8 **PWR** VSS AJ82 PWR VSS AJ86 **PWR** VSS AK13 PWR VSS AK19 **PWR** VSS AK23 PWR VSS AK25 PWR VSS AK29 **PWR** VSS AK31 **PWR** VSS AK33 **PWR** AK55 VSS **PWR** AK65 PWR VSS VSS AK67 PWR AK73 VSS PWR VSS AK79 PWR VSS AK81 **PWR** VSS **AK83 PWR** AK85 VSS **PWR** VSS AK9 **PWR** VSS AL10 PWR VSS AL24 **PWR** VSS AL30 PWR VSS AL32 **PWR** VSS AL4 PWR VSS AL56 **PWR** VSS AL64 **PWR** VSS AL68 **PWR** VSS AL76 **PWR** VSS AL78 **PWR** VSS AL80 **PWR** VSS AL82 **PWR** VSS AL86 **PWR** 

Table A-1. Pin List By Name (Sheet 64 of 90)

90)			
Pin Name	Locati on	Туре	I/O
VSS	AM1	PWR	
VSS	AM31	PWR	
VSS	AM57	PWR	
VSS	AM63	PWR	
VSS	AM69	PWR	
VSS	AM73	PWR	
VSS	AM79	PWR	
VSS	AM83	PWR	
VSS	AN2	PWR	
VSS	AN28	PWR	
VSS	AN58	PWR	
VSS	AN6	PWR	
VSS	AN78	PWR	
VSS	AP13	PWR	
VSS	AP19	PWR	
VSS	AP31	PWR	
VSS	AP5	PWR	
VSS	AP59	PWR	
VSS	AP63	PWR	
VSS	AP65	PWR	
VSS	AP67	PWR	
VSS	AP69	PWR	
VSS	AP73	PWR	
VSS	AP75	PWR	
VSS	AP81	PWR	
VSS	AP83	PWR	
VSS	AP85	PWR	
VSS	AP9	PWR	
VSS	AR10	PWR	
VSS	AR24	PWR	
VSS	AR30	PWR	
VSS	AR6	PWR	
VSS	AR60	PWR	
VSS	AR72	PWR	
VSS	AR78	PWR	
VSS	AT15	PWR	
VSS	AT17	PWR	
VSS	AT21	PWR	
VSS	AT27	PWR	
VSS	AT61	PWR	
VSS	AT63	PWR	



Table A-1. Pin List By Name (Sheet 65 of 90)

Locati **Pin Name** Type I/O on VSS AT69 **PWR** VSS PWR AT73 VSS AT77 **PWR** VSS AT83 PWR VSS **PWR** AT85 VSS AU2 **PWR** AU26 VSS **PWR** VSS AU28 **PWR** VSS AU6 **PWR** VSS AU62 **PWR** VSS AU64 PWR VSS AU68 **PWR** VSS AU74 PWR VSS AU76 **PWR** VSS AU78 **PWR** VSS AU80 PWR VSS AU84 **PWR** VSS AU86 PWR VSS AV1 **PWR** VSS AV11 PWR VSS AV13 **PWR** VSS AV19 PWR VSS AV23 **PWR** PWR VSS AV25 VSS AV3 **PWR** VSS AV63 PWR VSS AV65 **PWR** VSS PWR AV67 VSS AV7 PWR AV75 VSS **PWR** VSS AV83 PWR VSS AW10 **PWR** VSS AW2 PWR VSS AW62 **PWR** VSS AW66 PWR VSS AW68 **PWR** VSS AW70 PWR VSS AW72 **PWR** VSS AW74 **PWR** VSS AW78 **PWR** 

Table A-1. Pin List By Name (Sheet 66 of 90)

Pin Name	Locati on	Туре	I/O
VSS	AW84	PWR	
VSS	AY15	PWR	
VSS	AY17	PWR	
VSS	AY21	PWR	
VSS	AY23	PWR	
VSS	AY25	PWR	
VSS	AY5	PWR	
VSS	AY63	PWR	
VSS	AY79	PWR	
VSS	AY81	PWR	
VSS	B25	PWR	
VSS	B31	PWR	
VSS	B37	PWR	
VSS	B43	PWR	
VSS	B5	PWR	
VSS	B71	PWR	
VSS	B75	PWR	
VSS	B79	PWR	
VSS	B9	POWER	
VSS	BA12	PWR	
VSS	BA2	PWR	
VSS	BA6	PWR	
VSS	BA62	PWR	
VSS	BA68	PWR	
VSS	BA74	PWR	
VSS	BA80	PWR	
VSS	BA84	PWR	
VSS	BB19	PWR	
VSS	BB23	PWR	
VSS	BB63	PWR	
VSS	BB69	PWR	
VSS	BB73	PWR	
VSS	BB75	PWR	
VSS	BB77	PWR	
VSS	BB79	PWR	
VSS	BB81	PWR	
VSS	BB83	PWR	
VSS	BC12	PWR	
VSS	BC16	PWR	
VSS	BC4	PWR	
VSS	BC70	PWR	

AW82

**PWR** 



Table A-1. Pin List By Name (Sheet 67 of 90)

Locati **Pin Name** Type I/O on VSS BC72 **PWR** VSS BC74 **PWR** VSS BC76 **PWR** VSS BC78 **PWR** VSS **PWR** BC8 VSS BC80 **PWR** VSS BC82 **PWR** VSS BD11 **PWR** VSS BD15 **PWR** VSS BD21 **PWR** VSS BD27 PWR VSS BD5 **PWR** VSS BD63 PWR VSS BD71 **PWR** VSS BE10 **PWR** VSS BE26 PWR VSS BE4 **PWR** VSS BE6 **PWR** VSS BE64 **PWR** VSS BE66 **PWR** VSS BE68 **PWR** VSS BE70 **PWR** VSS BE8 **PWR** VSS PWR BF15 BF17 VSS **PWR** VSS BF19 PWR VSS BF25 **PWR** VSS BF63 **PWR** VSS BF65 PWR VSS BF67 **PWR** VSS BF69 PWR VSS BF71 **PWR** VSS BF9 PWR VSS BG10 **PWR** VSS BG22 **PWR** VSS BG24 **PWR** VSS BG6 **PWR** VSS BG72 **PWR** VSS BG74 **PWR** VSS BG76 **PWR** VSS BG78 **PWR** 

Table A-1. Pin List By Name (Sheet 68 of 90)

90)			
Pin Name	Locati on	Туре	I/O
VSS	BG8	PWR	
VSS	BG80	PWR	
VSS	BG82	PWR	
VSS	BH11	PWR	
VSS	BH15	PWR	
VSS	BH17	PWR	
VSS	BH21	PWR	
VSS	BH7	PWR	
VSS	ВН9	PWR	
VSS	ВЈ4	PWR	
VSS	ВЈ6	PWR	
VSS	BK11	PWR	
VSS	BK19	PWR	
VSS	BK3	PWR	
VSS	BK7	PWR	
VSS	BL10	PWR	
VSS	BL12	PWR	
VSS	BL22	PWR	
VSS	BL24	PWR	
VSS	BL6	PWR	
VSS	BL64	PWR	
VSS	BL66	PWR	
VSS	BL68	PWR	
VSS	BL70	PWR	
VSS	BL72	PWR	
VSS	BL74	PWR	
VSS	BL76	PWR	
VSS	BL78	PWR	
VSS	BL80	PWR	
VSS	BL82	PWR	
VSS	BM13	PWR	
VSS	BM15	PWR	
VSS	BM25	PWR	
VSS	ВМ9	PWR	
VSS	BN10	PWR	
VSS	BN20	PWR	
VSS	BN26	PWR	
VSS	BN6	PWR	
VSS	BP27	PWR	
VSS	BP3	PWR	
VSS	BR10	PWR	



Table A-1. Pin List By Name (Sheet 69 of 90)

Locati **Pin Name** Type I/O on VSS BR16 **PWR** VSS PWR **BR18** VSS BR26 **PWR** VSS BR6 PWR VSS BR64 **PWR** VSS **BR66 PWR** VSS BR68 **PWR** VSS BR70 **PWR** VSS BR72 **PWR** VSS BR74 **PWR** VSS PWR BR76 VSS **BR78 PWR** VSS **BR80** PWR VSS **BR82** PWR PWR VSS BT21 VSS BT23 PWR VSS BT25 **PWR** VSS ВТ3 **PWR** VSS BT5 **PWR** VSS BT9 PWR VSS **BU10 PWR** VSS BU8 PWR VSS BV17 **PWR** PWR VSS BV25 VSS BV5 **PWR** VSS BW12 PWR VSS BW14 **PWR** VSS BW16 **PWR** VSS BW18 **PWR** BW26 VSS **PWR** VSS BW6 PWR VSS BW72 **PWR** VSS BW74 PWR VSS BW76 **PWR** VSS BW78 PWR VSS BW80 **PWR** VSS BW82 PWR VSS BY11 **PWR** VSS BY13 **PWR** VSS BY23 **PWR** 

Table A-1. Pin List By Name (Sheet 70 of 90)

Pin Name	Locati on	Туре	I/O
VSS	BY65	PWR	
VSS	BY67	PWR	
VSS	BY69	PWR	
VSS	BY71	PWR	
VSS	C10	PWR	
VSS	C12	PWR	
VSS	C14	PWR	
VSS	C16	PWR	
VSS	C4	PWR	
VSS	C76	PWR	
VSS	C78	PWR	
VSS	C8	PWR	
VSS	C80	PWR	
VSS	CA10	PWR	
VSS	CA14	PWR	
VSS	CA18	PWR	
VSS	CA2	PWR	
VSS	CA20	PWR	
VSS	CA26	PWR	
VSS	CA6	PWR	
VSS	CA64	PWR	
VSS	CA66	PWR	
VSS	CA68	PWR	
VSS	CA70	PWR	
VSS	CA8	PWR	
VSS	CB27	PWR	
VSS	CB63	PWR	
VSS	CB7	PWR	
VSS	CB71	PWR	
VSS	CB9	PWR	
VSS	CC16	PWR	
VSS	CC18	PWR	
VSS	CC24	PWR	
VSS	CC4	PWR	
VSS	CC64	PWR	
VSS	CC72	PWR	
VSS	CC74	PWR	
VSS	CC76	PWR	
VSS	CC78	PWR	
VSS	CC80	PWR	
VSS	CC82	PWR	

**BY63** 

**PWR** 



Table A-1. Pin List By Name (Sheet 71 of 90)

Locati **Pin Name** Type I/O on VSS CD13 **PWR** VSS CD5 **PWR** VSS CD63 **PWR** VSS CD73 **PWR** VSS CD75 **PWR** VSS CD77 **PWR** VSS CD79 **PWR** VSS CD81 **PWR** VSS CE10 **PWR** VSS CE14 **PWR** VSS CE20 PWR VSS CE26 **PWR** VSS CE62 PWR VSS CE70 **PWR** VSS CE82 **PWR** VSS CF63 PWR VSS CF69 **PWR** VSS CF71 **PWR** VSS CF77 **PWR** VSS CF83 **PWR** PWR VSS CF9 VSS CG18 **PWR** CG22 VSS **PWR** CG6 VSS PWR VSS CG62 **PWR** VSS CG68 PWR PWR VSS CG72 VSS CG80 **PWR** VSS CH1 PWR VSS CH15 **PWR** VSS CH19 PWR VSS CH3 **PWR** VSS CH63 PWR VSS CH67 **PWR** VSS CH73 **PWR** VSS CH79 **PWR** VSS CH81 **PWR** VSS CH83 **PWR** VSS CJ10 **PWR** VSS CJ12 PWR VSS CJ2 **PWR** 

Table A-1. Pin List By Name (Sheet 72 of 90)

90)			
Pin Name	Locati on	Туре	I/O
VSS	CJ6	PWR	
VSS	CJ62	PWR	
VSS	CJ74	PWR	
VSS	CJ76	PWR	
VSS	CJ78	PWR	
VSS	CJ8	PWR	
VSS	CJ82	PWR	
VSS	CJ84	PWR	
VSS	CJ86	PWR	
VSS	CK11	PWR	
VSS	CK15	PWR	
VSS	CK21	PWR	
VSS	CK27	PWR	
VSS	CK63	PWR	
VSS	CK65	PWR	
VSS	CK67	PWR	
VSS	CK69	PWR	
VSS	CK71	PWR	
VSS	CK73	PWR	
VSS	CK75	PWR	
VSS	CK83	PWR	
VSS	CK85	PWR	
VSS	CL14	PWR	
VSS	CL18	PWR	
VSS	CL22	PWR	
VSS	CL62	PWR	
VSS	CL64	PWR	
VSS	CL66	PWR	
VSS	CL74	PWR	
VSS	CL76	PWR	
VSS	CL78	PWR	
VSS	CL8	PWR	
VSS	CL80	PWR	
VSS	CM19	PWR	
VSS	CM27	PWR	
VSS	CM29	PWR	
VSS	CM31	PWR	
VSS	CM5	PWR	
VSS	CM61	PWR	
VSS	CM63	PWR	
VSS	CM67	PWR	



Table A-1. Pin List By Name (Sheet 73 of 90)

Locati I/O **Pin Name** Туре on CM73 VSS PWR VSS CM77 PWR VSS CM83 **PWR** VSS CM85 PWR VSS CN12 **PWR** VSS CN14 **PWR** VSS CN2 **PWR** VSS CN26 **PWR** CN32 VSS **PWR** VSS CN60 **PWR** VSS PWR CN62 VSS CN68 **PWR** VSS CN78 PWR VSS CP1 PWR VSS CP25 **PWR** VSS CP59 PWR VSS CP69 PWR VSS CP73 PWR VSS CP75 **PWR** VSS CP81 PWR CP83 VSS **PWR** VSS CR10 PWR VSS CR22 **PWR** PWR VSS CR24 VSS CR32 **PWR** VSS CR58 PWR VSS CR6 **PWR** VSS PWR CR62 VSS CR64 PWR CR66 PWR VSS VSS CR68 PWR VSS **CR78 PWR** VSS CR86 PWR VSS CT13 **PWR** VSS CT19 PWR VSS CT27 **PWR** VSS CT29 PWR VSS CT33 PWR VSS CT35 **PWR** VSS CT57 PWR

Table A-1. Pin List By Name (Sheet 74 of 90)

Pin Name	Locati on	Туре	I/O
VSS	CT73	PWR	
VSS	CT79	PWR	
VSS	CT83	PWR	
VSS	CT85	PWR	
VSS	CU22	PWR	
VSS	CU28	PWR	
VSS	CU30	PWR	
VSS	CU34	PWR	
VSS	CU36	PWR	
VSS	CU4	PWR	
VSS	CU56	PWR	
VSS	CU62	PWR	
VSS	CU68	PWR	
VSS	CU76	PWR	
VSS	CU78	PWR	
VSS	CU80	PWR	
VSS	CU82	PWR	
VSS	CU86	PWR	
VSS	CV1	PWR	
VSS	CV17	PWR	
VSS	CV25	PWR	
VSS	CV27	PWR	
VSS	CV31	PWR	
VSS	CV33	PWR	
VSS	CV37	PWR	
VSS	CV39	PWR	
VSS	CV41	PWR	
VSS	CV53	PWR	
VSS	CV55	PWR	
VSS	CV63	PWR	
VSS	CV67	PWR	
VSS	CV73	PWR	
VSS	CV79	PWR	
VSS	CV81	PWR	
VSS	CV83	PWR	
VSS	CW12	PWR	
VSS	CW26	PWR	
VSS	CW32	PWR	
VSS	CW38	PWR	
VSS	CW40	PWR	
VSS	CW42	PWR	

CT7

**PWR** 



Table A-1. Pin List By Name (Sheet 75 of 90)

Locati **Pin Name** Type I/O on VSS CW52 **PWR** CW54 VSS **PWR** VSS CW6 **PWR** VSS CW64 **PWR** VSS CW66 **PWR** VSS CW68 **PWR** VSS CW74 **PWR** VSS CW78 **PWR** VSS CW82 **PWR** VSS CY1 **PWR** VSS CY13 PWR VSS CY15 **PWR** VSS CY21 PWR VSS CY41 **PWR** VSS CY45 **PWR** VSS CY51 PWR VSS **PWR** CY59 VSS CY61 **PWR** VSS CY65 **PWR** VSS CY69 **PWR** VSS CY75 **PWR** VSS CY77 **PWR** VSS CY83 **PWR** VSS CY85 PWR VSS CY9 **PWR** VSS D11 PWR VSS D13 **PWR** VSS D25 **PWR** VSS D27 PWR VSS D29 **PWR** VSS D3 PWR VSS D31 **PWR** VSS D33 PWR VSS D35 **PWR** VSS D37 **PWR** VSS D39 **PWR** VSS D41 **PWR** VSS D43 **PWR** VSS D77 **PWR** VSS D81 **PWR** 

DA18

**PWR** 

Table A-1. Pin List By Name (Sheet 76 of 90)

90)			
Pin Name	Locati on	Туре	I/O
VSS	DA26	PWR	
VSS	DA28	PWR	
VSS	DA30	PWR	
VSS	DA32	PWR	
VSS	DA34	PWR	
VSS	DA36	PWR	
VSS	DA38	PWR	
VSS	DA44	PWR	
VSS	DA46	PWR	
VSS	DA48	PWR	
VSS	DA50	PWR	
VSS	DA6	PWR	
VSS	DA64	PWR	
VSS	DA70	PWR	
VSS	DA74	PWR	
VSS	DA76	PWR	
VSS	DA78	PWR	
VSS	DA80	PWR	
VSS	DB13	PWR	
VSS	DB17	PWR	
VSS	DB23	PWR	
VSS	DB25	PWR	
VSS	DB3	PWR	
VSS	DB39	PWR	
VSS	DB41	PWR	
VSS	DB47	PWR	
VSS	DB49	PWR	
VSS	DB7	PWR	
VSS	DB73	PWR	
VSS	DB77	PWR	
VSS	DB83	PWR	
VSS	DB85	PWR	
VSS	DC14	PWR	
VSS	DC24	PWR	
VSS	DC26	PWR	
VSS	DC32	PWR	
VSS	DC38	PWR	
VSS	DC42	PWR	
VSS	DC64	PWR	
VSS	DC66	PWR	
VSS	DC68	PWR	



Table A-1. Pin List By Name (Sheet 77 of 90)

Locati **Pin Name** Type I/O on VSS DC70 **PWR** VSS DC78 PWR VSS DC84 **PWR** VSS DC86 PWR VSS DD11 **PWR** VSS DD23 **PWR** VSS DD27 PWR VSS DD31 **PWR** VSS DD33 **PWR** VSS DD37 **PWR** VSS DD71 PWR VSS DD73 **PWR** VSS DD75 PWR VSS DD81 **PWR** VSS DD83 **PWR** VSS **DE18** PWR VSS DE20 **PWR** VSS DE24 PWR VSS DE28 **PWR** VSS DE30 PWR VSS DE34 **PWR** VSS DE36 PWR VSS DE48 **PWR** PWR VSS DE50 VSS DE52 **PWR** VSS DE54 PWR VSS DE56 **PWR** VSS DE58 PWR VSS DE6 PWR VSS DE60 **PWR** VSS DE62 PWR VSS DE64 **PWR** VSS DE70 PWR VSS DE72 **PWR** VSS PWR **DE78** VSS DE8 **PWR** VSS DF19 PWR VSS DF29 PWR VSS DF35 **PWR** VSS DF37 **PWR** 

Table A-1. Pin List By Name (Sheet 78 of 90)

Pin Name	Locati on	Туре	I/O
VSS	DF41	PWR	
VSS	DF5	PWR	
VSS	DF65	PWR	
VSS	DF69	PWR	
VSS	DF7	PWR	
VSS	DF73	PWR	
VSS	DF79	PWR	
VSS	DF83	PWR	
VSS	DF85	PWR	
VSS	DG14	PWR	
VSS	DG16	PWR	
VSS	DG2	PWR	
VSS	DG24	PWR	
VSS	DG66	PWR	
VSS	DG68	PWR	
VSS	DG76	PWR	
VSS	DG78	PWR	
VSS	DG80	PWR	
VSS	DG82	PWR	
VSS	DH13	PWR	
VSS	DH15	PWR	
VSS	DH21	PWR	
VSS	DH23	PWR	
VSS	DH25	PWR	
VSS	DH27	PWR	
VSS	DH29	PWR	
VSS	DH31	PWR	
VSS	DH33	PWR	
VSS	DH35	PWR	
VSS	DH37	PWR	
VSS	DH41	PWR	
VSS	DH67	PWR	
VSS	DH71	PWR	
VSS	DH73	PWR	
VSS	DH79	PWR	
VSS	DH81	PWR	
VSS	DH83	PWR	
VSS	DJ10	PWR	
VSS	DJ2	PWR	
VSS	DJ22	PWR	
VSS	DJ38	PWR	

DF39

**PWR** 



Table A-1. Pin List By Name (Sheet 79 of 90)

Locati **Pin Name** Type I/O on VSS DJ42 PWR VSS DJ68 **PWR** VSS DJ74 **PWR** VSS DJ78 **PWR** VSS DJ82 **PWR** VSS DJ84 **PWR** VSS DK23 **PWR** VSS DK29 **PWR** VSS **DK35 PWR** VSS DK39 **PWR** VSS DK41 PWR VSS DK7 **PWR** VSS DK73 PWR VSS DK75 **PWR** VSS DK77 **PWR** VSS **DK83** PWR VSS **PWR** DK85 VSS DL16 **PWR** VSS **DL18 PWR** VSS DL22 **PWR** PWR VSS DL24 VSS DL28 **PWR** VSS DL30 PWR VSS DL34 PWR VSS DL36 **PWR** VSS DL4 PWR VSS DL40 **PWR** VSS DL68 **PWR** VSS DL70 PWR VSS DL74 **PWR** VSS DL76 PWR VSS **DL78 PWR** VSS DL8 PWR VSS DL80 **PWR** VSS DM15 **PWR** VSS DM19 **PWR** VSS DM25 **PWR** VSS DM27 **PWR** VSS DM31 **PWR** VSS DM33 **PWR** VSS DM37 **PWR** 

Table A-1. Pin List By Name (Sheet 80 of 90)

90)			
Pin Name	Locati on	Туре	I/O
VSS	DM39	PWR	
VSS	DM65	PWR	
VSS	DM73	PWR	
VSS	DM77	PWR	
VSS	DM83	PWR	
VSS	DN12	PWR	
VSS	DN18	PWR	
VSS	DN2	PWR	
VSS	DN22	PWR	
VSS	DN26	PWR	
VSS	DN32	PWR	
VSS	DN38	PWR	
VSS	DN44	PWR	
VSS	DN68	PWR	
VSS	DN72	PWR	
VSS	DN78	PWR	
VSS	DP45	PWR	
VSS	DP47	PWR	
VSS	DP49	PWR	
VSS	DP51	PWR	
VSS	DP53	PWR	
VSS	DP55	PWR	
VSS	DP57	PWR	
VSS	DP59	PWR	
VSS	DP61	PWR	
VSS	DP63	PWR	
VSS	DP67	PWR	
VSS	DP69	PWR	
VSS	DP71	PWR	
VSS	DP81	PWR	
VSS	DP83	PWR	
VSS	DP9	PWR	
VSS	DR20	PWR	
VSS	DR22	PWR	
VSS	DR24	PWR	
VSS	DR26	PWR	
VSS	DR28	PWR	
VSS	DR30	PWR	
VSS	DR32	PWR	
VSS	DR34	PWR	
VSS	DR36	PWR	



Table A-1. Pin List By Name (Sheet 81 of 90)

Locati **Pin Name** Type I/O on VSS DR38 **PWR** VSS DR40 PWR VSS DR42 **PWR** VSS DR6 PWR VSS DR66 **PWR** VSS DR68 **PWR** VSS DR70 **PWR** VSS DR72 **PWR** VSS DR74 **PWR** VSS **DR76 PWR** VSS DR78 PWR VSS DT17 **PWR** VSS DT3 PWR VSS DT65 **PWR** VSS DT69 **PWR** VSS DT79 PWR VSS DT83 **PWR** VSS DT85 PWR VSS **DU10 PWR** VSS DU14 PWR DU22 VSS **PWR** VSS DU26 PWR VSS DU32 **PWR** VSS DU38 PWR VSS DU70 **PWR** VSS DU72 PWR VSS DU78 **PWR** VSS DU80 **PWR** VSS DU82 **PWR** DU84 VSS **PWR** VSS DV19 PWR VSS DV21 **PWR** VSS DV25 PWR VSS DV27 **PWR** VSS DV31 PWR VSS DV33 **PWR** VSS DV37 PWR VSS DV39 **PWR** VSS DV73 **PWR** VSS DV77 **PWR** 

Table A-1. Pin List By Name (Sheet 82 of 90)

Pin Name	Locati on	Туре	I/O
VSS	DW12	PWR	
VSS	DW2	PWR	
VSS	DW20	PWR	
VSS	DW24	PWR	
VSS	DW28	PWR	
VSS	DW30	PWR	
VSS	DW34	PWR	
VSS	DW36	PWR	
VSS	DW40	PWR	
VSS	DW64	PWR	
VSS	DW66	PWR	
VSS	DW68	PWR	
VSS	DW70	PWR	
VSS	DW72	PWR	
VSS	DW74	PWR	
VSS	DW76	PWR	
VSS	DW8	PWR	
VSS	DW82	PWR	
VSS	DW84	PWR	
VSS	DY19	PWR	
VSS	DY23	PWR	
VSS	DY29	PWR	
VSS	DY35	PWR	
VSS	DY41	PWR	
VSS	DY45	PWR	
VSS	DY47	PWR	
VSS	DY49	PWR	
VSS	DY5	PWR	
VSS	DY51	PWR	
VSS	DY53	PWR	
VSS	DY55	PWR	
VSS	DY57	PWR	
VSS	DY59	PWR	
VSS	DY61	PWR	
VSS	DY63	PWR	
VSS	DY71	PWR	
VSS	DY75	PWR	
VSS	DY85	PWR	
VSS	E16	PWR	
VSS	E18	PWR	
VSS	E20	PWR	

DV81

**PWR** 



Table A-1. Pin List By Name (Sheet 83 of 90)

Locati **Pin Name** Type I/O on VSS E22 PWR VSS E6 **PWR** VSS E66 **PWR** VSS E72 **PWR** VSS E74 **PWR** VSS E76 **PWR** VSS E8 **PWR** VSS E82 **PWR** VSS EA14 **PWR** VSS EA16 **PWR** VSS EA20 PWR VSS EA22 **PWR** VSS EA42 PWR VSS EA6 **PWR** VSS EA64 **PWR** VSS EA70 PWR VSS **PWR** EA76 VSS EA78 **PWR** VSS EA80 **PWR** VSS EA82 **PWR** VSS EA84 **PWR** VSS EB13 PWR VSS EB23 **PWR** PWR VSS EB25 VSS EB27 **PWR** VSS EB29 PWR VSS EB31 **PWR** VSS EB33 **PWR** VSS EB35 PWR VSS EB37 **PWR** VSS EB39 PWR VSS **EB41 PWR** VSS EB65 PWR VSS EB69 PWR VSS EB83 **PWR** VSS EC10 **PWR** VSS EC42 **PWR** VSS EC6 **PWR** VSS EC70 **PWR** VSS EC72 **PWR** 

EC74

**PWR** 

Table A-1. Pin List By Name (Sheet 84 of 90)

90)			
Pin Name	Locati on	Туре	I/O
VSS	EC76	PWR	
VSS	EC82	PWR	
VSS	ED11	PWR	
VSS	ED15	PWR	
VSS	ED23	PWR	
VSS	ED29	PWR	
VSS	ED35	PWR	
VSS	ED41	PWR	
VSS	ED69	PWR	
VSS	ED7	PWR	
VSS	ED77	PWR	
VSS	ED81	PWR	
VSS	EE24	PWR	
VSS	EE28	PWR	
VSS	EE30	PWR	
VSS	EE34	PWR	
VSS	EE36	PWR	
VSS	EE40	PWR	
VSS	EE70	PWR	
VSS	EE76	PWR	
VSS	EE78	PWR	
VSS	EE8	PWR	
VSS	EE80	PWR	
VSS	EF71	PWR	
VSS	EF75	PWR	
VSS	EF79	PWR	
VSS	F17	PWR	
VSS	F19	PWR	
VSS	F25	PWR	
VSS	F31	PWR	
VSS	F37	PWR	
VSS	F43	PWR	
VSS	F5	PWR	
VSS	F67	PWR	
VSS	F69	PWR	
VSS	G22	PWR	
VSS	G24	PWR	
VSS	G26	PWR	
VSS	G30	PWR	
VSS	G32	PWR	
VSS	G36	PWR	



Table A-1. Pin List By Name (Sheet 85 of 90)

Locati **Pin Name** Туре I/O on VSS G38 PWR VSS PWR G4 VSS G42 **PWR** VSS G66 PWR VSS G70 PWR VSS G76 **PWR** VSS G78 PWR VSS G8 **PWR** VSS G80 **PWR** VSS G82 **PWR** VSS PWR H11 VSS H25 **PWR** VSS H27 PWR VSS H29 PWR VSS Н3 **PWR** VSS H31 PWR VSS H33 **PWR** VSS H35 **PWR** H37 VSS **PWR** VSS H39 PWR H41 VSS **PWR** VSS H45 PWR VSS H47 **PWR** PWR VSS H49 VSS H51 **PWR** VSS H53 PWR VSS H55 **PWR** VSS H57 **PWR** VSS H59 PWR VSS H61 **PWR** VSS H63 PWR VSS H65 **PWR** VSS H71 PWR VSS H75 PWR VSS J12 PWR VSS J14 **PWR** VSS J16 PWR VSS J22 PWR VSS J26 **PWR** VSS J28 PWR

Table A-1. Pin List By Name (Sheet 86 of 90)

Pin Name	Locati on	Туре	I/O
VSS	J34	PWR	
VSS	J38	PWR	
VSS	J4	PWR	
VSS	J40	PWR	
VSS	J72	PWR	
VSS	J74	PWR	
VSS	J76	PWR	
VSS	J82	PWR	
VSS	J84	PWR	
VSS	J86	PWR	
VSS	K1	PWR	
VSS	K11	PWR	
VSS	K13	PWR	
VSS	K17	PWR	
VSS	K27	PWR	
VSS	K33	PWR	
VSS	K39	PWR	
VSS	K65	PWR	
VSS	K67	PWR	
VSS	K69	PWR	
VSS	K71	PWR	
VSS	K73	PWR	
VSS	K77	PWR	
VSS	K81	PWR	
VSS	K83	PWR	
VSS	K85	PWR	
VSS	L10	PWR	
VSS	L2	PWR	
VSS	L20	PWR	
VSS	L22	PWR	
VSS	L6	PWR	
VSS	L72	PWR	
VSS	L78	PWR	
VSS	L8	PWR	
VSS	L80	PWR	
VSS	L82	PWR	
VSS	M15	PWR	
VSS	M17	PWR	
VSS	M19	PWR	
VSS	M23	PWR	
VSS	M25	PWR	

J32

**PWR** 



Table A-1. Pin List By Name (Sheet 87 of 90)

Locati **Pin Name** Type I/O on VSS M27 **PWR** VSS M29 **PWR** VSS M31 **PWR** VSS M33 **PWR** VSS M35 PWR VSS M37 **PWR** VSS M39 **PWR** VSS M41 **PWR** VSS M43 **PWR** VSS M65 PWR VSS M71 PWR M79 VSS **PWR** VSS M83 PWR VSS M85 **PWR** VSS N20 **PWR** VSS N22 PWR VSS Ν4 **PWR** VSS Ν6 **PWR** VSS N66 **PWR** N70 VSS **PWR** PWR VSS N72 VSS N74 **PWR** VSS N76 PWR PWR VSS N78 VSS Ν8 PWR VSS P11 PWR VSS P15 **PWR** VSS P27 **PWR** VSS P33 PWR P39 VSS **PWR** VSS P45 PWR VSS P47 **PWR** VSS P49 PWR P51 VSS **PWR** VSS P53 **PWR** VSS P55 **PWR** P57 VSS **PWR** VSS P59 **PWR** VSS P61 **PWR** VSS P63 PWR VSS P67 **PWR** 

Table A-1. Pin List By Name (Sheet 88 of 90)

90)			
Pin Name	Locati on	Туре	I/O
VSS	P69	PWR	
VSS	P71	PWR	
VSS	P81	PWR	
VSS	P83	PWR	
VSS	R14	PWR	
VSS	R18	PWR	
VSS	R2	PWR	
VSS	R22	PWR	
VSS	R26	PWR	
VSS	R28	PWR	
VSS	R32	PWR	
VSS	R34	PWR	
VSS	R38	PWR	
VSS	R4	PWR	
VSS	R40	PWR	
VSS	R68	PWR	
VSS	R72	PWR	
VSS	R78	PWR	
VSS	R86	PWR	
VSS	T13	PWR	
VSS	T17	PWR	
VSS	T25	PWR	
VSS	T29	PWR	
VSS	T31	PWR	
VSS	T35	PWR	
VSS	T37	PWR	
VSS	T41	PWR	
VSS	T65	PWR	
VSS	T73	PWR	
VSS	T77	PWR	
VSS	T83	PWR	
VSS	T85	PWR	
VSS	U2	PWR	
VSS	U20	PWR	
VSS	U22	PWR	
VSS	U24	PWR	
VSS	U30	PWR	
VSS	U36	PWR	
VSS	U4	PWR	
VSS	U42	PWR	
VSS	U6	PWR	



Table A-1. Pin List By Name (Sheet 89 of 90)

Locati I/O **Pin Name** Туре on VSS U68 PWR VSS U70 PWR VSS U74 **PWR** U76 VSS PWR VSS U78 **PWR** VSS U80 **PWR** VSS U86 **PWR** VSS V1 **PWR** VSS V11 **PWR** VSS V13 **PWR** VSS V15 PWR VSS V21 **PWR** VSS V23 PWR VSS V43 **PWR** VSS V5 **PWR** VSS V73 PWR VSS V75 **PWR** VSS V77 PWR V83 VSS **PWR** VSS V9 PWR W12 VSS **PWR** VSS W22 PWR VSS W24 **PWR** PWR VSS W26 VSS W28 **PWR** VSS W30 PWR VSS W32 **PWR** VSS W34 **PWR** VSS W36 PWR VSS W38 **PWR** VSS W40 PWR VSS W42 **PWR** VSS W68 PWR VSS W74 **PWR** VSS W78 PWR VSS W8 **PWR** VSS W82 **PWR** VSS Y15 PWR VSS Y17 **PWR** VSS Y5 **PWR** VSS Y67 **PWR** 

Table A-1. Pin List By Name (Sheet 90 of 90)

Pin Name	Locati on	Туре	I/O
VSS	Y7	PWR	
VSS	Y71	PWR	
VSS	Y73	PWR	
VSS	Y79	PWR	
VSS	Y81	PWR	
VSS	Y83	PWR	
VSS	Y85	PWR	
VSS	Y9	PWR	
VSS_VCCIN_SENSE	AY85	PWR	
VSS_VCCIO_SENSE	BF5	PWR	
VSS_VCCSA_SENSE	CG76	PWR	



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